Mukesh Patel School of Technology Management and Engineering Program: B. Tech. (Mechatronics Engineering) Semester: III							
	``		TN/ A 02007				
Cours	,	athematics -III Module Code: BTM aching Scheme Evaluation Scheme					I WIA03007
Lectu				Internal			
(Hou		Tutorial		Continuou	IC I		tions (TEE)
per	``	(Hours per	Credit	Assessment (I			ks- 100
weel	-	week)		(Marks - 50		``	ion Paper)
3	0	1	4	Marks Scaled	,		caled to 50
	quisite: Mathem	-	_				culcu to bo
Objec	±				102000	/	
1. To provide an understanding of Laplace transform and its applications, Fourier							
	eries, Fourier T		· ·		C 1 0	upplication	illo, i o'uiilei
	To provide stude			entals necessary	v to for	mulate, solv	ve and
	inalyses complex			j		,	
Outco		001					
After o	completion of th	e course, stude	ents would be al	ole to:			
1. 5	Solve problems	s using Lapl	ace transform	, Fourier serie	es, Fo	urier Tran	sform, Z -
t	ransform.						
2. A	Analyze the co	ncept of Lap	place transform	n, Fourier seri	es, Fo	urier Tran	sform, Z -
t	ransform.						
3. A	Apply the techr	niques of Lap	lace transform	, Fourier series	, Four	ier Transfo	orm and Z -
t	ransform to en	gineering pro	oblems.				
Detail	ed Syllabus: (pe	er session plar	1)				
Unit	Description						Duration
1	Laplace transfo	ormation:					
	Definition of La	place transfor	m, Laplace trans	sform of 1, e^{at} , s	sin at,	$\cos at$,	
	sinh at, cosh at	t^{n} , Propertie	s of Laplace trar	nsform: Linearity	y prope	erty, First	
		-	-				
	and second shifting theorems of Laplace transform, Change of scale property, $L\{t^n f(t)\}, L\{\frac{f(t)}{t}\}, L\{f^n(t)\}, L\{\int_0^t f(u)du\}$, Evaluation of Inverse 13						
	Laplace transform by partial fraction, Convolution theorem, Laplace transforms of Periodic functions, Unit step functions, Dirac delta functions. Applications: to solve initial and boundary value problems involving ordinary differential equations.						
2	Dirichlet's cond a_0, a_n, b_n is not	litions, Euler's expected), Fou	formulae (Deriv urier Series of Fu	function, Trigon vative of Fourier unctions for the i ng points of disco	coeffi nterva	cients 1	10



		alf range sine and cosine expansions, Parseval's identities. urier series, Fourier integral theorem, Fourier sine and	
3	Properties of Fourier Shifting property), Ir Inverse Fourier Cosi	ourier Sine Transform, Fourier Cosine Transform, Transform (Linearity property, Change of scale property, overse Fourier Transform, Inverse Fourier Sine Transform, ne Transform, Finite Fourier Transform. transform to solve differential equations.	09
4	Sequences, Z-transfo Properties, Inverse Z Multiplication by K, Convolution, Convol important sequences	aces, Representation of sequences, Basic operators on rms, Properties of Z-Transforms, Change of scale, Shifting -transform, Solution of Difference equations, Division by <i>K</i> , Initial value, Final value, Partial sum, lution Property of Casual Sequence, Transform of , Inverse of Z-transform by division, binomial expansion Inverse by residue Method, Solution of Difference	13
	Total		45
Refer 1. (2.] 3.] Any (Erwin Kreyszig (2017 Edition. B. S. Grewal (2017), H Edition. other information:	"Calculus", <i>Pearson, 13th Edition.</i> 7), "Advanced Engineering Mathematics", <i>Wiley India,</i> Higher Engineering Mathematics, <i>Khanna Publishers, 44</i> Continuous Assessment (ICA): 50 Marks	
	ibution of ICA Mar		
	cription of ICA	Marks	
	Marks Work Marks	20 30	
Tota	l Marks :	50	
Detai	Is of Term work: work should consists		



Signature (Prepared by Concerned Faculty/HOD)

Program: B. Tech. (Mechatronics Engineering) Semester : III						0		
Course/	Module: Presen	tation and C	ommunicatio	n	Modu	le Code : BTMA	403008	
	Techni	ques						
	Teaching	, Scheme		E	valuati	on Scheme		
Lectu	re Practical	Tutorial		Internal Continu	uous	Term End Ex	aminations	
(Hours	per (Hours	(Hours per	Creadit	Assessment (IC	CA)	(TEE) (Ma	arks –	
week) per week)	week)	Credit	(Marks - 50))	in Questio	on Paper)	
2	0	0	2	Marks Scaled to	o 50		-	
Pre-req	uisite: Nil							
Objecti	ves:							
1. Tc	impart an und	erstanding c	of basic tenet	s of business com	munica	tion that helps	students to	
eff	fectively engage i	n organizatio	onal commun	ication.		-		
	*		0	of interpersonal co			ges and the	
			0	es in an organizatio				
	*	*	ilding and de	ecision making skill	ls which	n could be later	applied in a	
professional set up.								
	4. To impart technical writing skills towards designing and structuring persuasive technical communication.							
	5. To build and strengthen presentation skills towards making impressive and persuasive							
	esentations.	enguien pi	esentation s.	KIIIS towards IIId.	King n	inpressive and	persuasive	
-		ts for partici	pating in gro	up discussions, but	ilding F	Resume and fac	ing personal	
	terviews.		r 9 8					
Outcom	nes:							
After co	mpletion of the c	ourse, stude	nts would be	able to:				
1. U1	nderstand and ap	ply the post	ulates of tech	nical writing in a fo	rmal se	t up		
-			·	dence to create we		tured Resumes,	, application	
		0		ness related docum				
			dynamics and	d apply leadership	skills fo	or effective team	n building in	
-	ofessional set up			tion to -	1	for offertions i		
	mmunication in j			communication tec	nniques	s for effective if	nterpersonal	
	d Syllabus: (per							
· · · · · ·	Description	session plun)				Duration	
	-	a foundation	no of Proise	ss Communication	. Ductor	cional		
	0				• FTOIES	5101121	05	
	Communication i	8		tion and Business I	Hanne	· · ·	00	
		-		conducting product	-		05	
	0	•	0	skills and non-verb		0 0	00	
	ousiness etiquette		ing insterting					
	<u> </u>		al and Group	Communication S	kille			
	-	-	-	shop format) to pro		peaningful		
				shop tormay to pre	JIIOLE II	icarinigiai,		

	Mukesh Patel School of Technology Management and Engineering	ng
	active and reflective thinking processes as well as enhancing communication skills	04
	development.	
	Group Communication	
	Forms of Group Communication; Use of body language in Group	
	communication	
	Group Discussion etiquette: Introducing oneself and others;	
	Expressing Opinions and Ideas; expressing disagreement etc.	
	Group Discussion Strategies: Speaking, taking turns, Creating a Cordial and	
	cooperative atmosphere etc.	
4	Building Problem-solving teams	04
	Orientation to Personality Values – Importance of Values	
	• Understanding of Teams- Types of Teams, stages of Team	
	development; Team building leadership skills and leaderless	
	scenarios	
	Decision Making-Group and Individual Decision Making Techniques	
	 Stress Management-Sources of Stress; consequences; Managing 	
	Stress	
5	Employment Communication	04
U	 Personal Interviews-Objectives, Types, Stages of Interview 	01
	 Interview Preparation-types of Interview Questions ; Interview 	
	Follow ups	
	1	
	 Resume- Types and Format; Cover letters Mock Interviews (simulation) 	
6	Organizational networks and communication Structures	02
U	C C	02
	Process and Functions of Communication ;Formal Networks in	
	Organizational Communication	
	Informal networks of organizational communications ;choice of	
7	communication channels Meetings	02
1	5	02
	Meetings- Purposes ,Importance and Meeting Procedures including Chairmanana's and martiainants' rales	
	Chairperson's and participants' roles	
	Meeting Documentation (Minutes of resolution; Minutes of Narration; Meeting Nation and Assault)	
0	Meeting Notice and Agenda)	00
8	Technical Report Writing	02
	Importance , objectives and Characteristic of Reports ; Types of	
	Reports	
	Report formats and Structure -Memo Reports; Letter Reports; Office	
	Orders and Manuscript Reports	
9	Presentation Skills	02
	Planning and structuring Presentations; Visual Aids in Presentations	



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 Applications of MS Power Point 	
 Audience analyses; Nuances of Delivery; Modes of delivery; 	
Controlling Nervousness and stage fright	
Total	30
Text Books:	
1. Bovee, C., Thill, J., & Roshan Lal Raina (2013), "Business Communication Toda	w", Pearson.
14th edition.	<i>J i</i>
2. Meenakshi Raman and Sangeeta Sharma (2015), "Technical Communication", Oxford	University
Press, 3 rd Edition.	5
Reference Books:	
1. Fred Luthans (2013), 'Organizational Behavior', McGraw Hill, 12th Edition.	
Any other information:	
1. Links to websites:	
• <u>https://www.mindtools.com/</u>	
 <u>https://www.pearsonmylabandmastering.com/northamerica/mybcommlab/</u> 	
2. Pedagogy:	
1. Classroom teaching	
2. classroom exercises and discussion	
3. case studies	
4. written assignments	
5. presentations and role play	
5. presentations and role play	
Total Marks of Internal Continuous Assessment (ICA): 50 Marks	

Distribution of ICA Marks:

Description of ICA	Marks
Test Marks	20
Term Work Marks	30
Total Marks :	50

Details of Term work:

Term work should consists of the following:

- 1. Group/Individual presentations
- 2. Report writing-Memo Reports and letter reports
- 3. Drafting meeting Agenda and Minutes of Meeting
- 4. Resume and Cover letter writing
- 5. Group Discussion
- 6. Mock Interviews



Progra	am: B. Tech. (Mecl			mology Mana	Semester	0	6
Cours	Course/ Module: Digital Electronics Teaching Scheme				Module C	code: BTMAC	3009
	Teaching	g Scheme			Evaluatio	n Scheme	
Lectu (Hou per we	rs (Hours per	Tutorial (Hours per week)	Credit	Internal Con Assessmen (Marks -	t (ICA)	Term Examinati (Mark in Questio	ons (TEE) s- 100
3	2	0	4	Marks Scale	aled to 50		
Pre-re	quisite: Nil						
2. Outco After o 1. 2. 3.	To provide know technical field. To provide know and necessary te mes: completion of the Apply the know Design Combina Implement Sequ	wledge of de echniques wh course, studer ledge of func ational Logic	signing the nich is requ nts would be damental r Circuits.	e digital logic o aired in compu- be able to: number system which can be a	circuit usir ter hardw is and the	ng basic build are design. various code	ling blocks s.
	for complex dig		-	S.			
	ed Syllabus: (per	session plan)				
Unit	Description						Duration
1	Introduction to Comparison of hexadecimal, BC Arithmetic inclu- Binary and Hexa Weighted, refle Hamming codes converting binar	Analog and CD and others uding 1's an adecimal Num active, sequer s, alphanume	Digital Sys s. Conversion d Two Co obers. otial, gray, ric, Morse,	stems, Number on from one sys omplement Arit error detectin teletypewriter	stem to and hmetic, Im g codes,	other, Binary portance of even parity,	06
2	Logic Gates and Boolean Algebra: AND, OR, NOT, XOR, XNOR, operation NAND, NOR use of universal gates for					04	
3	Combinational Canonical Logic Implementing a simplifying Bool functions.	c Form, min logic functio	term, max n using un	iversal gates. K	-maps and	their use in	16



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		Patel School of Technology Management and Engineering	ıg						
	Design of Code cor	werter circuits-Binary to Gray, BCD to 7 segments, priority							
	encoder, Binary com	encoder, Binary comparator, binary arithmetic circuits – adders, subtractors (half							
	and full), BCD adder, subtractor, ALU, Parity generator. Multiplexers (ULM),								
	De-multiplexers, De	De-multiplexers, Decoders, Encoders, Tree structures. Hazards in combinational							
	circuits.								
	Sequential Logic Ci	rcuits:							
	Comparison of com	binational and sequential circuits, flip-flops, SR, T, D, JK,							
	-	nverting one flip-flop to another, use of debounce switch.							
		synchronous Counters, modulus of a counter, up / down	12						
4	5	lesigning by drawing state transition diagram and state							
		ng all kinds of Flip –Flops. Ring counter, Johnson counter,							
		er, Finite and Mixed state Machines- Mealy and Moore							
	Design, Logic state of	5							
	Registers & Memor	· ·							
	U	output; serial input-parallel output; Parallel In -Parallel Out,							
5	1	Bi Directional Shift Registers, Universal Shift Registers.	05						
U		RAM, ROM, basic bipolar cell, CMOS, dynamic RAM cell. Magnetic core							
		emory, CCD, PAL, PLA, FPGA.							
	Introduction to VHDL								
	Total		02 45						
Toxt I	Books:								
		"Digital Design", PHI, 4 th edition.							
		008), "Digital Computer Electronics", Tata McGraw Hill, F	Ponrint 3rd						
	Edition.	000), Digital Computer Electronics , Tutu McOruw Thu, F	ceptini 5						
	ence Books:								
		ital Electronics and Microprocessors", Tata McGraw-Hill, 2	25th ronrint						
), "Principles of Digital Systems Design", Cengage Learning	,						
		, Thiciples of Digital Systems Design , Cenguge Learning	ς, διλιπ						
	Indian Reprint.								
Any	other information:								
Total	Marks of Internal	Continuous Assessment (ICA): 50 Marks							
Distr	ibution of ICA Mar	ks:							
Des	cription of ICA	Marks							
	Test Marks 20								
Term Work Marks 30									
Tota	l Marks :	50							
l									
l.									

Details of Term work:

Term work should consists of the following:

- 1. Minimum two assignments.
- 2. Minimum ten laboratory Experiments covering the whole syllabus, duly recorded and graded.
- 3. Quiz/ Viva/ Presentation.



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B. TECH./MECHATRONICS/SEM III/ 2020-21/PAGE | 8

- 0 -	: B. Tech. (Me	chatronics E	nics Engineering) Semester: III				
Course/	Course/ Module: Engineering Mechanics						
	Teaching	Scheme		Evaluation Scheme			
Lecture (Hours per week)	Practical (Hours per week)	Tutorial (Hours per week)	Credit	Asses	Internal Continuous Assessment (ICA) (Marks - 50)		End ons (TEE) s- 100 on Paper)
3	2	0	4	Marks	Scaled to 50	Marks Sca	- /
Pre-requ	isite: Physics	(BTMA0100)3)				
Mee four 2. A v diag to c und com Outcom After co 1. Det 2. Det 3. Det par	objective of chanics to a ndation for ta vorking know grams provid letermine th lerstanding <u>ditions.</u> mpletion of ermine resul ermine centr ermine the c ticle and rigi	all the stu aking up ac wledge of des an undo em in a wi of the m the course, tant forces oid and mo lisplacemend d body.	dents of dvanced o statics wi erstandin ide range echanical students and equil oment of i nt, velocit	engineerir courses in the ith emphas g of the kir e of simple, behaviou would be a librium of v inertia of pl ty, accelera	various force syste	to prepar sequent sen brium and deformatior ral problem under var ems.	e a good nesters free body n and how ns, and an ious load
	d Syllabus: (-		I	0	J	
Unit	Description						Duration
1. 2.	System of For Resultant of concurrent an Equilibrium: Equilibrium of space, Free bo Application of	coplanar co d non-concu of system of ody diagram of Coplanar	arrent forc concurrer s. Forces an	res in space nt and non-co d Equilibriu	ncurrent forces, R oncurrent forces in u m: ethod of sections at	plane and	08
				0	ium and principle uilibrium	of virtual	08



	Mukesh P	atel School of Technology Management and Engineering	5
		Limiting friction, Laws of Friction, Static and Dynamic	
	Friction; wedge frie	ction, screw jack	
4.	Centroid and Cent	•	
		le figures from first principle, centroid of composite	
	sections; Centre of	f Gravity and its implications; Area moment of inertia-	06
	Definition, Momen	nt of inertia of plane sections from first principles, Moment	00
	of inertia of standa	ard sections and composite sections; Mass moment inertia	
	of circular plate, C		
5.	Kinematics of Part	ticles:	
		r; Plane curvilinear motion (rectangular, path and polar	
	coordinates), veloc	ity-time graph and their usage, relative motion; Newton's	
	2nd law (rectangul	ar, path, and polar coordinates).	10
	Kinematics of Rigio		
	-	rotation and plane motion of rigid bodies, ICR, link	
	mechanisms		
6.		es and Rigid Bodies:	
		motion, D'Alembert's principle, equation of dynamic	
	equilibrium, Work	energy principle and its application in plane motion of	08
	connected bodies;	Kinetics of rigid body in translation, rotation and plane	00
	motion.		
	Total		45
Text I	Books:		
1. Ir	ving H. Shames (20	008), "Engineering Mechanics", Prentice Hall, 4 th Edition.	
2. R	. C. Hibbler (2017)	, "Engineering Mechanics: Principles of Statics and D	ynamics",
P	earson Press.		
Refer	ence Books:		
1. F.	P. Beer and E. R. Jo	ohnston (2017), "Vector Mechanics for Engineers", Vol I	& II, Tata
N	1cGraw Hill, 9th Editi	ion.	
2. SI	hanes and Rao (200	6), "Engineering Mechanics", Pearson Education.	
		010), "Engineering Mechanics (Statics, Dynamics)", Pears	son
E	ducation		
4. T	ayal A.K. (2010), "E	ngineering Mechanics", Umesh Publications	
	ther information:		
Total	Marks of Internal Co	ontinuous Assessment (ICA): 50 Marks	
	bution of ICA Marks		
	ription of ICA	Marks	
	Marks	20	
	Work Marks	30	
Total	Marks :	50	

Details of Term work:

Term work should consist of the following:

- 1. Minimum ten Experiments covering the whole syllabus, duly recorded and graded.
- 2. Minimum five assignments covering the syllabus



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B. TECH./MECHATRONICS/SEM III/ 2020-21/PAGE | 11

Program	B. Tech. (Mech			chnology Mana	Semester	U		
U	Module: Manı	C	0,		Module	Code: BTMA	03011	
	Teaching	<u> </u>		I 	Evaluatio	n Scheme		
Lecture (Hours per week)	Practical (Hours per week)	Tutorial (Hours per week)	Credit	Assessment	Internal Continuous Assessment (ICA) (Marks - 50)		n End tions (TEE) ks- 100 tion Paper)	
3	0	0	3	Marks Scale	d to 50	Marks Sc		
Pre-requ	isite: Worksho	p Practice (B]	TAB02006)					
etc	introduce diff impart knowle		0 1	rocesses like ca equipment used			0 0	
1. Ur 2. Ex 3. Ur 4. Kn	plain the differ	lifferentiate t ent types of e perations of l e machining	he differer quipment athe, millin processes	be able to: at types of metal used in casting, ng and drilling r	and metal	01		
Unit	Description	session plun	9				Duration	
1	practices Moulding sau boxes, core n system – runn Moulding pro die casting, co defects in cast	ng: Types on nds: types, pr making, type her and risers, ocesses: shell entrifugal cas- ings.	roperties, j es of core ; moulding sting and o	, allowances, co preparation and s and their ma g, CO ₂ moulding continuous casti	testing of anufacturi g, investm	sand. Core ing; Gating ent casting,	09	
2	defects in roll: Forging: Class of forging, hea Extrusion: He force, defects Drawing: Me deep drawing	ciple and mee ing. sification of f at treatment of ot and cold i in extruded p etal Stampin f, roll forming Different typ	chanism, t orging pro of forged p Extrusion, parts; wire g and For g, shear for e of press	ypes of rolling a ocesses, basic cat arts. Equipment, Est and tube. rming, blanking ming and flow I ses and their w	tegories an timation c g, piercing Forming.	nd methods of extrusion g, bending,	12	



	Mukesh	Patel School of Technolog	y Management and Enginee	ering				
	Abrasive Machir	ing Processes:						
	Mechanics of gr	ons of grinding machines,						
3	Centerless grind	Centerless grinding, Grinding wheel specifications and its selection,						
5	Truing and dress	ing of wheels, super finishir	ng processes such as lapping	06				
	and honing. Ab	rasive jet machining (AJN	1) and Abrasive water jet					
	machining (AWJI	м).						
	Machining Oper	ations:						
	Lathe: Construct	ion and working and oper	cations performed on lathe,					
	attachments and	accessories, types of cuttir	ng tools, cutting parameters					
	such as spindle s	peed, feed and depth of cut	, Capstan and Turret lather,					
	automatic lathes a	and their construction.						
	Milling Machine	es: Types of milling machine	es, tools and their geometry,					
4	various operation	ns on milling machine, diffe	erent attachments (including	10				
4	dividing heads) a	nd work holding devices.		18				
	Drilling Machir	ies: Types of machines, c	lrilling operations such as					
	drilling, boring,	reaming, spot facing, co	unter boring and sinking,					
	tapping, drill spe		8					
	Boring and Broa	Boring and Broaching Machine: Classification – horizontal and vertical						
	boring machine, types of broaching machines, advantages, limitations and							
	applications of br	51 0	U I					
	Total	0		45				
Text Bo	oks:		1					
1. l	P. N. Rao (2008), "M	lanufacturing Technology-Vo	ol I", Tata McGraw Hill.					
2. 5	5. Kalpakjian and S.	R. Schmid (2002), "Manufact	turing Engineering and Techno	ology", 4 th				
	Edition, Pearson.							
	ce Books:							
			ng Processes", Alfa Science Inter					
	· • • •	, 1	gy- Vol I, II, III″, ELBS Publishe	rs.				
		Welding Metallurgy", Wiley I	inter science.					
-	er information: o website:							
		(a a una da (11 0 10714E (
	http://nptel.ac.in/ http://nptel.ac.in/c	/courses/112107145/						
	1 · · · 1 · ·							
		ntinuous Assessment (ICA)	: 50 Marks					
	ution of ICA Marks	1	l l					
Test M	ption of ICA	Marks						
	larks Work Marks	20 30						
	VUIK IVIAIKS	50						
Total N	Marks :	50						
1 - Jour I								
Deteile	of Term work:							



Term work should consists of the following:

- 1. Minimum four assignments based on the above syllabus.
- 2. Visit to any nearby foundry/ fabrication unit.
- 3. Viva voce, quizzes, Presentations based on syllabus.



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B. TECH./MECHATRONICS/SEM III/ 2020-21/PAGE | 14

Prog	Program: B. Tech. (Mechatronics Engineering) Semester: III						
Cou	Course/ Module: Analog Devices and Circuits Module Code: BTMA03012						
Teaching Scheme					Evaluation	Evaluation Scheme	
Lect (Ho pe wee	r (Hours r per week)	Tutorial (Hours per week)	Credit	Assessm	Assessment (ICA) (Marks - 50)		End ons (TEE) - 100 n Paper)
3	2	0	4	Marks So	caled to 50	Marks Sca	led to 50
Pre-	r equisite: Basic E	Electrical Engin	neering (BT	MA01002), P	hysics (BTMA	.01003)	
1. 2. 3. 4. 5. Out Afte 1 2 3	3. To provide knowledge of the circuit building block of Op-Amp, its dc and ac equivalent circuit and its applications.						
Un it	Description	1	,				Duration
1	Semiconductor Construction, M equation and t Photodiode. Diode Applicat circuits and wor Clipper and C Clamper Circuit	Working and emperature e tions: Half w king. Capaciti Clamper Circ	Character ffects. Type ave, Full V ive Filter – t	istics of PN es of diodes Vave (Center heory and lin	- Zener, LE r-tap and Bri mitations.	D, Schottky, dge) rectifier	08
2	Bipolar Junction Construction, w Modes of opera CB, CE and CC.	vorking, and tion – cutoff,					06



	BJT Biasing: Working, limitations and advantages of Fixed Bias, Collector	ering					
	Feedback, Voltage Divider Bias.						
	BJT Applications: BJT as an AC amplifier. BJT as a switch.						
	Field Effect Transistor: Construction and working of p-channel JFET. Construction, Working and input						
	– output characteristics of n-channel JFET.						
3	JFET Biasing: Working, limitations and advantages of Fixed Bias, Self Bias,	04					
	Voltage Divider Bias.						
	JFET Applications: JFET as an AC amplifier						
	BJT and FET Small Signal Amplifier:						
	Working of DC – RC Transformer BJT amplifier (CB, CE, CC). Working of DC –						
4	RC JFET amplifier (CS, CD). Positive and Negative Feedback circuits – advantages and limitations.	09					
	Feedback Applications: Negative Feedback –Current and Power Amplifiers						
	(Class A, B and AB). Positive Feedback – Barkhausen Criteria.						
	Operational Amplifiers:						
	Parameters, working (open loop) and characteristics of IC 741C.						
5	Applications of Closed loop with negative feedback (Ideal): Inverting, Non-	05					
	inverting, Buffer, Adder, Scalar, Subtractor, Differentiator, Integrator, V to I, I to V converters, Instrumentation Amplifiers with 3 Op-amp						
	Non-linear Op-Amps:						
6	Comparator, Schmitt Trigger, Precision HW Rectifier, Peak Detector, Sample	04					
	and Hold Circuit, Basic Log Amplifier.						
	Oscillators and Timer Circuits:						
	Working of RC and Wien Bridge Oscillator using op-amp.						
-	IC555 Timer Circuits: Working of Astable and Monostable multivibrator	05					
7	circuits. VCO Circuits: IC 566 block diagram and working.	05					
	PLL circuits: Working of IC 4046 CMOS PLL.						
	Series Regulator and 3 Terminal Regulators: IC 337 and IC 723.						
	Filter Circuits:	_					
8	First Order Filters - Low Pass, High Pass, Band Pass and Band Reject filters.	04					
	Notch Filter. All Pass filter.						
	Total	45					

Text Books:

- 1. Donald A. Neamen (2006), Electronic Circuit Analysis and Design, *McGraw Hill International*, 3rd *Edition*.
- 2. David A. Bell (2008), Electronic Devices & Circuits, Prentice Hall India Pvt. Ltd, 5th Edition.
- 3. R. A. Gayakwad (2009), Op-Amps and Linear Integrated Circuits, *Prentice Hall of India Pvt. Ltd, 4th edition.*
- 4. Sergio Franco(2002), Design with operational amplifiers and analog circuits, *McGraw Hill, 3rd edition.*

Reference Books:

- 1. Adel S. Sedra, Kenneth Carlers Smith (2004), Microelectronic Circuits, Volume 1, Oxford University Press.
- 2. Robert Boylestad & Louis Nashelsky (2007), Electronic Devices & Circuit Theory, *Pearson Education India*, 9th *Edition*.
- 3. Jacob Millman, Christos Halkias, Chetan Parikh (2009), Integrated Electronics, *McGraw hill Publication*, 2nd *Edition*.
- 4. Robert Coughlin and F. Driscoll(2009), Operational Amplifiers and Linear Integrated Circuits, *Prentice Hall of India Pvt. Ltd, 6th edition.*

Any other information:

Total Marks of Internal Continuous Assessment (ICA): 50 Marks

Distribution of ICA Marks:						
Description of ICA	Marks					
Test Marks	20					
Term Work Marks	30					
Total Marks :	50					

Details of Term work:

Term work should consists of the following:

- 1. Minimum two assignments.
- 2. Minimum ten laboratory Experiments covering the whole syllabus, duly recorded and graded.
- 3. Quiz/ Viva/ Presentation.



Program: B. Tech. (Mechatronics Engineering) Semester : IV							
Cours	Course/ Module : Mathematics - IV				Module Code : BTMA04008		
Teaching Scheme				Evaluation Scheme			
Lectu (Hou per week	rs (Hours per	Tutorial (Hours per week)	Credit	Assessm	Internal Continuous Assessment (ICA) (Marks - 50)		m End tions (TEE) ks- 100 tion Paper)
3	0	1	4	Marks So	caled to 50	Marks S	Scaled to 50
Pre-re	Pre-requisite: Mathematics-I (BTMA01001) & Mathematics-II (BTMA02008)						
Objec	ctives:						
aj ir	o develop kno pplication to p nventory, main ecision making	roblems in tenance, qı	day to d	ay life invol	lving areas o	of uncertai	nty such as
		.1	. 1 .		1.		
1. S n 2. h 3. h 4. h	problems.						
Detai	led Syllabus: (per session	plan)				
Unit	Description						Duration
1.	Errors in Nur Types of Erro Formula, Erro	rs, Analysi	s and Esti	imation of E			03
2.	Roots of Equations: Bisection method. False position method.						05
3.	Interpolation and Curve fitting:Forward, Backward and Central Differences, differences of a polynomial, Newton's Interpolation formulae, Stirling's Central Difference interpolation formula, Lagrange's formula for unequal intervals. Curve fitting: Least square method for straight line and parabola, Method of group averages.						



4	Numerical Integration:	04
4.	Trapezoidal rule, Simpson's 1/3 rule, Simpson's 3/8 rule.	04
_	Solution to Ordinary differential equations:	04
5.	Taylor series method, Euler's method, Runge-Kutta methods.	01
6.	Probability Distribution: Introduction to random variable, Discrete and continuous random variables, Probability density function, Cumulative distribution function, Expectation, Mean and Variance, Discrete Probability distributions-Binomial, Poisson, Continuous probability distributions-Exponential, Normal.	09
7.	Testing of hypothesis: Null and Alternate hypothesis, Test Statistic, Type I and Type II errors, One-tailed and two-tailed test, Critical value, Large sample statistical test for population mean, Large sample statistical test for proportion, t-test for small samples, Chi-square test for Goodness of fit, Kolmogorov-Smirnov test for goodness of fit.	09
	Total	45
Text	Books:	
	Steven C. Chapra, Raymond P. Canale (2010), "Numerical Methods for Engineers", <i>Tata Mc-Graw Hill</i> , 6 th Edition. S.P. Gupta(2007), "Statistical Methods", <i>Sultan Chand & Sons Publicate</i> Edition.	
Refe	rence Books:	
	S.S. Sastry (2013), "Introductory methods of numerical analysis", P Private Limited, 5 th Edition.	0
2.	T. Veerarajan(2017), "Probability, Statistics and Random Processes <i>Hill Education</i> , 3 rd <i>Edition</i> .	", McGraw-
3.	Irwin Miller, John E. Freund and R.A. Johnson(2000), "Probability for Engineer", <i>PHI</i> , 7 th Edition.	& Statistics



Any other information:							
Total Marks of Internal Continuous Assessment (ICA): 50 Marks							
Distribution of ICA Mark	s:						
Description of ICA	Marks						
Test Marks	Test Marks 20						
Term Work Marks 30							
Total Marks :	50						

Details of Term work:

Term work should consists of the following:

1. Tutorial Test/Presentation/viva/quiz



Signature (Prepared by Concerned Faculty/HOD)

B. TECH./MECHATRONICS/SEM IV/ 2020-21/PAGE | 3

Program: B	. Tech. (Mecl	natronics E	s) Semeste	Semester : IV		
Course/ M	odule: Princi Mana	ples of Eco gement	nomics and	Module Code: BTMA04009		
Teaching Scheme				Evaluation Scheme		
Lecture (Hours per week)	Practical (Hours per week)	Tutorial (Hours per week)	Credit	Internal Continuous Assessment (ICA) (Marks – 50)	Term End Examinations (TEE) (Marks- 100 in Question Paper)	
3	0	0	3	Marks Scaled to 50	Marks Scaled to 50	
Pro-roguis	ito. Nil				•	

Pre-requisite: Nil

Objectives:

This course provides basic orientation towards economic (micro and macroeconomic) principles and help them understand the functions of management

- 1. To combine elements of basic micro and macroeconomics
- 2. To understand issues dealing with small-scale economic phenomena and concepts such as prices and output of firms, industries and resource owners
- 3. To examine market impact of technological change
- 4. To understand broader aspects of the economy and its environment

Outcomes:

After completion of the course, students would be able to:

- 1. Analyze and evaluate the impact of Economic Policies and its implication on the Business Environment
- 2. Understand basic concepts of economics (demand, supply, elasticity, scarcity) and explain behaviour on individual, households and firm.
- 3. Handle economic data and write economic report
- 4. Orient students towards basic management principles and act as foundation for higher levels of learning
- 5. To be able to handle basic functions of management (planning, organising, coordination, and control)

Detailed Syllabus: (per session plan)

Unit	Description	Duration
1	Introduction: Definition of Economics, Types of economic systems, problem of scarcity of economic resources.	02
2	Demand and Supply: Demand Curve and Supply Curve, Equilibrium of Demand and Supply, Shift in Demand and Supply. Application of Demand and Supply: Price Elasticity of Demand, Price Elasticity of Supply, Factors which influence Elasticity, Elasticity and Revenue.	03

3	Market Structure / industry analysis types of Competition: monopoly, oligopoly, monopolistic competition, perfect and imperfect competition, government policies towards industries. Circular flow of Economy, Structures, Role of Government, Business Cycles.	03
4	Macroeconomics : National Income – Gross Domestic Product (GDP), Gross National Product (GNP), Inflation – Cost Push and Demand Pull Inflation, Unemployment, Philips Curve	03
5	Functions of Central Bank Money supply, RBI & Monetary Policy.(Current Credit Policy to be critiqued) Stabilization policy : Role of fiscal Policy Demand and Consumer Behavior: Utility and Marginal Utility, Types of Goods	03
6	New economic policy :Liberalization, privatization and globalization	03
7	Theory of Production : Law of Diminishing Returns, Returns to Scale, Productivity	03
8	Analysis of Costs: Types of Costs – Total Cost, Fixed Cost, Variable Cost, Marginal Cost, Impact of Marginal Cost on Average Cost.	03
9	Introduction to Management: Management & Organizations, Management History, Understanding Management thought ,contribution of F.W. Taylor, Henry Fawol, Elton –Mayo Contexts- Constraints & Challenges	05
10	Planning: Managers as Decision makers, Foundations of Planning, Strategic Management	04
11	Organizing: Line and staff relationships ,centralization and decentralization , role of delegation ,Managing Human Resources, Managing Teams	04
12	Leading and Motivation: Basic concepts and practices -Maslows Herzberg McClealand 's theory of Achievement	04
13	Controlling: Introduction to Controlling inventory, quality control.	03
14	Orientation towards Finance, Marketing Human resources and Operation departments	02
	Total	45
	Books: Samuelson and Nordhaus, (2010), "Economics", Tata McGraw Hill Publicati 19 th edition.	on,



- 2. Datt and Sundharam, (2009), "Indian Economy", S. Chand Publication, 67th edition.
- 3. Koontz. H. (2012), "Essentials of Management: International and Leadership Perspective", *McGraw Hill Education (India)*.
- 4. Collins, J. (2001), "Good to Great: Why Some Companies Makes the Leap and Other's Don't", *Random House Business Books*.

Reference Books:

- 1. Mankiw Gregory, (2008), "Principles of Economics", *Cengage Learning*
- 2. Rakesh Singh, (2007), "Analyzing Macro-Economics", Shroff Publishers .

Any other information:

Total Marks of Internal Continuous Assessment (ICA): 50 Marks

Distribution of ICA Marks:

Description of ICA	Marks
Test Marks	20
Term Work Marks	30
Total Marks :	50

Details of Term work:

Term work should consists of the following:

1. Assignment/Case Studies/Projects/ Presentations



Progra	Program: B. Tech. (Mechatronics Engineering) Semester: IV							
Course	Course/ Module: Control Systems Module Code					Code: BTMA0	4010	
Teaching Scheme				Evaluation Scheme				
Lectur (Hour per week	rs (Hours per	Tutorial (Hours per week)	Credit	Assessmer	Internal Continuous Assessment (ICA) (Marka 50)		End ons (TEE) s- 100 on Paper)	
3	2	0	4	Marks Scal	led to 50	Marks Sca	aled to 50	
Pre-re	Pre-requisite: Analog Devices and Circuits(BTMA03012), Engineering Mathematics III (BTMA03007)							
1. T 2. T								
1. Io 2. A 3. C 4. K	 After completion of the course, students would be able to: Identify the basic functioning and components of feedback control system. Analyse processes of different orders, their dynamic and steady state response in relation to stability. Compare different stability analysis criteria and conduct the test for controllability and observability. Know the working principle and tuning of PID controllers. 							
Unit	ed Syllabus: (p		pianj				Duration	
	Introduction to feedback control system:							
2.	Dynamic Models and Responses: Dynamic model of an RLC network, impulse response model, transfer							
3.	Control Syste: Basic units of diagrams, sig reduction usir servomotors, t	a feedbacl nal flow g ng Mason's	k control graphs, M gain rule	/lason's gain e, servo poter	rule, blo tiometer,	ck diagram DC and AC	08	

	a typical control system using simplified sub- system, transfer function						
	blocks.						
	Feedback Control System Characteristics:						
	Stability, sensitivity, disturbance rejection, steady state accuracy,	07					
4.	4. transient and steady state responses of a second order system. Effect of						
	additional zeros and pole locations and dominant poles, steady state						
	error constants, system type numbers and error compensation						
	System Stability analysis:						
5.	System stability bounds, relative stability and range of stability, root	08					
	locus concept, system characteristic equation, plotting root loci.						
	Stability Margins and State space analysis of control systems:						
	Gain and phase margins, bode plot of magnitude and phase and						
	determination of stability margins. State space analysis of control						
6.	systems-State space representation for electrical networks and nth	10					
	order differential equations, solution of time-invariant state equation,						
	transfer matrix, state transition matrix, controllability and observability,						
	Kalman's test for controllability and observability for a linear time						
	invariant continuous system.						
_	Feedback System Performance:	04					
7.	Performance specifications in frequency domain, correlation between	04					
	domain and time domain specifications. Introduction to PID controller.						
	Total	45					
Text E	Books:						
	M. Gopal (2012), "Control Systems- Principles and Design", Tata N	lcGraw Hill					
	Education, 4 th edition.						
2. Katsuhiko Ogata (2006), "Modern Control Engineering", Prentice Hall of India, 5th							
	dition.						
	ence Books:						
	. J. Nagrath and M. Gopal (2007), "Control Systems Engineering"	, New Age					
1	nternational Publishers, 5 th edition.						



Any other information:								
Total Marks of Internal C	Total Marks of Internal Continuous Assessment (ICA): 50 Marks							
Distribution of ICA Mar	ks:							
Description of ICA	Marks							
Test Marks	20							
Term Work Marks	Term Work Marks 30							
Total Marks :	50							

Details of Term work:

Term work should consists of the following:

- 1. Minimum two assignments.
- 2. Minimum ten lab experiments covering the whole syllabus, duly recorded and graded.
- 3. Viva voce, quizzes, Presentations based on syllabus.



	Program: B. Tech. (Mechatronics Engineering) Semester: IV						
Course/ M			or and Mici	cocontroller		le Code : BT	MA04011
	Teaching SchemeEvaluation Scheme					n Scheme	
Lecture (Hours per week)	Practical (Hours per week)	Tutorial (Hours per week)	Credit	Internal Continuous Assessment (ICA) (Marks - 50)		Examinati (Mark	n End ions (TEE) cs- 100 on Paper)
3	2	0	4	Marks Scaled	to 50	Marks Sc	caled to 50
Pre-requis	s ite: Digital	Electronics	6 (BTMA03	009)			
3. To un 4. To un interf Outcomes After com 1. Kno 2. Desi 3. Diffe	nderstand the derstand & facing with acing with facing with pletion of the pletion of the pletio	he concepts t program & different de he course, s tectural de ing with pe d compare	of Advand bit 8051 n evices. tudents wo sign of 808 eripheral d advances i	g aspects of 8086. ced Processors of nicrocontroller, P ould be able to: 6 along with its f evices and develo n microprocessor ure and its progra	IC contr eatures op prog	oller and its rams for 80 cture.	5
Detailed S	Syllabus: (p	er session p	olan)				
	scription						Duration
Hi An La Co 1. St In ge ve M	rchitecture/ inimum an atches 8282 ontroller. udy of 8086 inimum and terrupt-Typ enerated in ector Table	Introductio / Program d maximu /, clock ge instruction d maximum pes of inter terrupts, I e, Priorities. or family L	on to 8086, mming 1 m mode merator 82 n set. Assen n mode ope errupt, Ha Response of atches 8282	Features of 80 Model, Memor operation. Micro 284, Transceiver mbly language pr eration with timin ardware/softwar of 8086 to int 2, clock generator ler.	y org process 8286. rogramm ng diagr e and errupt,	ganization or family 8288 Bus ning, 8086 ram. program	09
•	ogramming ddressing N	-	sembler Di	rectives, Instruct	tion sets	s of 8086,	03

	Assembly language programming, Passing parameter to Procedure and Macro.	
3.	Peripheral Devices and Interfacing: 8259 Programmable Interrupt Controller, 8255 Programmable Peripheral Interface, Modes of operation of 8255, Interfacing I/O devices.	03
4.	80386 Microprocessor: 32 bit architecture of 80386, Segment Selector and Descriptor, Protected mode, Virtual 86 mode of operation, memory management, address translation, segmentation and segment descriptor tables (GDT and LDT). Cache Memories, Cache Architecture.	06
5.	Introduction to Pentium Processor: History of Evolution, Architecture of Pentium, Block Diagram, Superscalar Architecture, Branch Prediction Logic, Pipelining and Bus Operation.	04
6.	Study of 8051 Microcontrollers: Comparison of microprocessor and microcontroller, architecture. Applications , Pin Description, Block Diagram of 8051, Special Function registers, Internal memory organization, Program counter, Stack, Counters and Timers, Programming Timers and Counters, Serial Data Communication, Interrupts Types and Priorities, Input/output ports structure and operation.	09
7.	Programming 8051 Microcontrollers: Introduction to 8051 Assembly Language programming, Addressing modes and accessing memory using various addressing modes. Data Types and directives, 8051 flag bits and PSW register. Register banks and Stack. Jump loop and call instructions, I/O Port programming, Arithmetic instructions and programs, Logic instructions and programs.	03
8.	Interfacing devices with 8051: Interfacing with 8051 and Programming: LCD, Keyboard, ADC, DAC, PWM concept, Application-Speed Control of DC motors using PWM	04
9.	PIC 18 Microcontrollers and ARM: Programming model of PIC18, CPU Registers, Memory organization, Pipelining concept, PWM mode of PIC18 Introduction to embedded microcontroller core ARM family.	04
	Total	45



Textbooks:

- 1. Badri Ram (2011), "Advanced Microprocessors and Interfacing", *Tata McGraw Hill publication*.
- 2. Muhammad Ali Mazidi, Janice Gillispie Mazidi, Rolin D. McKinlay(2012), "The 8051 Microcontroller & Embedded system", *Pearson Prentice Hall, Second Edition.*
- 3. Han Way Huang(2009), "PIC Microcontroller", Cengage learning.

Reference Books:

- 1. Muhammad Ali Mazidi, Janice Gillespie Mazidi (2000), "The 80x86 IBM PC & compatible computers. Volumes I & II, Assembly language, design, and interfacing ", *Prentice Hall International, 2nd Edition.*
- 2. Kenneth Ayala (2012), "The 8051 Microcontroller", CENGAGE Learning, 3rd Edition.
- 3. A. Nagoor Kani (2012), "Microprocessor and Microcontroller", Tata McGraw Hill publication, 2nd Edition.
- 4. Douglas Hall (2006), "Microprocessors Interfacing and Programming", *Tata McGraw Hill publication*.

Any other information:

Total Marks of Internal Continuous Assessment (ICA): 50 Marks

Distribution of ICA Marks:

Description of ICA	Marks
Test Marks	20
Term Work Marks	30
Total Marks :	50

Details of Term work:

Term work should consists of the following:

- 1. At least ten laboratory experiments based on the entire syllabus duly recorded and graded.
- 2. Presentation/Application based experiment and Quiz/Practical exam/Viva/Any other mode of evaluation.



Program: B.	Tech. (Mechatı	Sem	Semester : IV					
Course/ Moo	dule: Principle:	Mod	ule Code : BTMA04012					
Engineering								
	Teaching So	Evalua	ition Scheme					
Lecture (Hours per week)	Practical (Hours per week)	Tutorial (Hours per week)	Credit	Internal Continuo Assessment (ICA (Marks - 50)	Evaminations (TEE)			
3	2	0	4	Marks Scaled to 5	0 Marks Scaled to 50			
Due ne resiet	teo requisite: Nil							

Pre-requisite: Nil

Objectives:

- 1. To understand concept of analog and digital modulation techniques.
- 2. To study different types of noise and their effect on modulation systems.
- 3. To understand concept of detection techniques.

Outcomes:

After completion of the course, students would be able to:

- 1. Analyze and compare different analog modulation schemes for their efficiency and bandwidth
- 2. Analyze the behaviour of a communication system in presence of noise
- 3. Investigate pulsed modulation system and analyze their system performance
- 4. Understand different digital modulation schemes and analyze different detection techniques.

Detailed Syllabus: (per session plan)

Unit	Description	Duration
1.	Analog Modulation Techniques:Concept of modulation, Comparison of Analog and digitalCommunication. Analog Communication -Principle of AmplitudeModulation Systems.Types of AM-DSB, SSB modulations, VSB modulation, AngleModulation, Comparison of AM, FM and PM, Methods to generateFM-Direct and Indirect, Direct-Basic Reactance Modulator, Indirectmethod-Armstrong Frequency modulator, Representation of PM	12
2.	Effects of Noise on Analog Communication Systems: Gaussian and white noise characteristics, Noise in amplitude modulation systems, Noise in Frequency modulation systems, Pre- emphasis and De-emphasis, Threshold effect in angle modulation.	06

	Waveform Coding Techniques:	
3.	Sampling process, Quantization, Pulse Amplitude Modulation, Pulse	05
	Code Modulation, Line codes, Differential pulse code modulation,	00
	Delta modulation, Time Division multiplexing	
	Digital Modulation Techniques:	
	Baseband Pulse Transmission- Inter symbol, Interference and Eye	
	pattern, Nyquist criterion, Equalization Techniques, Transversal	
	Equalizer, Adaptive Equalizer, Pass band Digital Modulation	
	schemes- Coherent and non-coherent communication, M-ary Phase	
4.	Shift Keying- BPSK, M-ary Phase Shift Keying-QPSK, M-ary	14
	Frequency Shift Keying-Coherent BFSK M-ary Frequency Shift	
	Keying-Non Coherent BFSK, Quadrature Amplitude Modulation,	
	Generation and Detection of Minimum shift keying, Waveforms and	
	phase continuity in MSK, Probability of Error for BPSK	
	Detection Techniques:	
	Baseband signal receiver, Probability of error, Optimum filter,	
-	Matched filter, Correlator, Concept of Maximum likelihood detection,	
5.	Maximum likelihood sequence detection derivation, Synchronization	08
	for Digital modulation, Carrier Recovery for Digital modulation.	
	Total	45
Textbo		
	laykin S.(2010), "Communications Systems", John Wiley and Sons.	
	roakis J.G.(2008), "Digital Communications", McGraw Hill, 5th Edition.	
	aub H. and Schilling D.L. (2006), "Principles of Communication Syste	ems", Tata
	AcGraw Hill.	
	eorge Kennedy, Bernard Davis,S R M Prasanna (2015), "Electronic Comm	nunication
S	ystems", McGraw Hill 5th Edition.	
Refere	nce Books:	
	Proakis J. G. and Salehi M.(2002), "Communication Systems Engineering", P	Pearson
	Education.	0000
	Bernard Sklar (2014), "Digital Communications Fundamentals and applicat	ions".
	Prentice Hall, 2nd Edition.	,
1	,	

- 3. K Sam Shanmugan (2006)," Digital and Analog communication Systems", *John Wiley* & Sons.
- 4. Haykin S. (2007), "Digital Communications ", John Wiley and Sons.



Any other information:

Total Marks of Internal Continuous Assessment (ICA): 50 Marks

Distribution of ICA Marks:

Description of ICA	Marks
Test Marks	20
Term Work Marks	30
Total Marks :	50

Details of Term work:

Term work should consists of the following:

- 1. At least ten laboratory experiments based on the entire syllabus duly recorded and graded.
- 2. Presentation/Application based experiment and Quiz/Practical exam/Viva/Any other mode of evaluation.



Program	B. Tech. (M	lechatronics	Enginee	ring)	Semester: IV				
Course/N	Iodule: Stre	ength of Ma	terials		Module Cod	e: BTMA04013			
Teaching Scheme					Evaluation Scheme				
Lecture (Hours per week)	Practical (Hours per week)	Tutorial (Hours per week)	Credit	Internal Continuous Assessment (ICA) (Marks-50)		Assessment (ICA)		Term End Exa (TEE (Marks in Questior) -100
3	2	0	4	Marks	Scaled to 50	Marks Scale	ed to 50		
Pre-requ	isite: Engine	eering Mech	nanics (BT	ME03009))				
2. To 3. To) impart kno) determine	the failure of the failure of the failure of the conce	riteria of	a body st	ubjected to var	o different types ious stresses fy the different			
Outcome	es:								
2. Ev 3. Au Detailed	nalyze press Syllabus: (J	leformation ure vessels per session p	s of vario and pow	us detern	ninate beams. ission systems	for stability.			
	Description						Duration		
	bulk modul	us, yield str	ess, ultim	nate stress	•	lus of rigidity, ty, shear stress, materials.	06		
2	Internal For 2.1 Shear F	ces & Stres orce and B	ses in Be ending I	ams Moment:	Axial force, s	hear force and			
	different typ 2.2 Simple simple prol modulus, m	bes of loadin Theory of blems invo oment of re tress in Be	ng. Bending lving ap sistance c eams: Dis	: Flexure plication of a section stribution	formula for s of flexure fo n. of shear stres	ate beams for straight beams, ormula, section as across plane	17		
	-	sses in pow				ts – solid and shafts in series	04		



members subjec	ent Combined with Axial Loads: Application to ted to eccentric loads, core of a section, problems on ing lateral loads.	05				
stress on an ob directional stres	Principal Stresses: General equations for transformation of stress, stress on an oblique plane of a member subjected to General two directional stress systems. Principal planes and principal stresses, maximum shear stress Mohr's circle concept.					
	eams: Deflection of cantilevers simply supported and ams using double integration and Macaulay's methods es of loading.	05				
	esses in thin cylindrical and spherical shells subjected ure. Efficiency of Riveted Joints.	03				
Total		45				
Text Books:						
 <i>Cengage Learning</i>. 2. Ferdinand P. Been Materials", 3rd Edit Reference Books: Andrew Pytel, Jaa <i>Learning</i>. William Nash, Me Edition", McGraw Any other information: 	Continuous Assessment (ICA): 50 Marks	echanics of on, Cengage				
Description of ICA	Marks					
Test Marks 20						
Term Work Marks	30					
Total Marks :	50					

Details of Term Work:

Term work should consists of the following:

- 1. At least ten laboratory experiments based on the entire syllabus duly recorded and graded.
- 2. Presentation/Application based experiment and Quiz/Practical exam/Viva/Any other mode of evaluation



Signature (Prepared by Concerned Faculty/HOD)

B. TECH./MECHATRONICS/SEM IV/ 2020-21/PAGE | 18

Progra	m: B. Tech. (N	/lechatronic	s Enginee	ering)	Semester:	IV	
	/ Module: En				Module C	ode: BTMA04	014
	Teaching Scheme				Evaluation Scheme		
Lectur	e Practical	Tutorial		Internal Term End Ex		xaminations	
(Hour	6 (Hours	(Hours	Credit	Cont	Continuous (T		EE)
per	per	per	cicuit		ient (ICA)	(Mar	
week	week)	week)		(Marks - 50)		in Question Paper)	
2	0	0	0		caled to 50		-
	uisite: Physics	s (BTMA010	003), Chen	nistry(BTM	(A02010)		
Object				. 1 D 11			
	roduce – Env						
2. Ac	quaint with S	ocial Issues	and met	hods to ma	anage them		
3. Im	proving Plan	ning of acti	vities				
Outcon	nes:						
After c	ompletion of	the course,	students	would be	able to:		
						esources and	its misuse,
	portance of E		-	•			
			0	-	on of recycle	e and reuse, g	eneration of
	s waste, avoic	•	•				
	- 0	Poster and	l plan act	tivities for	environme	ntal protection	n and social
	ues						
	ed Syllabus: (per session	plan)				
Unit	Description			1 1.			Duration
	Introduction				-		
	Resources ar						
	Role of Ecol	•••				Protection.	08
1	Major industi					Deducation	
	Environment	-	on- Type	es, Cause	es, Effects,	Reduction	
	methodology Introduction		onoration	Mothad	to Roduce	Rouse and	
	Introduction Recycle of Wa	-					
1 1	Solid wastes,	-					
1						n, Treatment	08
	Disposal.	5	ypes, su	010ge, 110			00
	C&D and E-w	vaste – Con	cent. met	hods for re	eduction m	anagement	
1	Campaigning		-				
	Concept of El				U	ort drafting	
	Environment		•		-	•	05

4	Environmental Protection, Social Issues, Disaster Management	
	Social Issues and Environment International Conventions, Summits	05
	and Protocols Generation of less waste and avoiding electricity	05
	waste. Environmental management for construction Projects	
5	Role of the Government in managing the environmental activities in	04
	all sectors. Organisational set up at the Central and state level to	
	manage the environment. Role of judiciary in managing the	
	environment. Role of Citizens, Role of NGOs/ Environmental	
	Activists.	
	Major Laws Air (P&C.P.) Act, Water (P & C.P) Act. Environment	
	Protection Act EPA 1986. Wild life Protection Act etc., PIL	
	Total	30
Text]	Books	

Lext Books:

- 1. Benny Joseph (2017), "Environmental Studies", The McGraw-Hill Companies
- 2. Gerard Kiely (2007), "Environmental Engineering", Tata McGraw-Hill Education

Reference Books:

- 1. P. Aarne Vesilind, Susan M. Morgan (2004), "Introduction to Environmental Engineering", Thomas/Brook/Cole.
- 2. Mackenzie Davis, David Cornwell (2017), "Introduction to Environmental Engineering", McGraw-Hill Companies.

Any other information:

Total Marks of Internal Continuous Assessment (ICA): 50 Marks

Distribution of ICA Marks:

Description of ICA	Marks
Test Marks	20
Term Work Marks	30
Total Marks :	50

Details of Term work:

Term work should consist of the following:

- 1. Minimum five assignments on the above syllabus
- 2. Report on social issues
- 3. Report on Environmental Management case study

Program:	B. Tech. (Mec	chatronics E	ngineering)	Semester	r : V	
Course/Mo	dule: Elemer	nts of Biolo	gy		Module	Code: BTMA	405007
	Teaching Scheme				Evaluation	n Scheme	
Lecture (Hours per week)	Lecture Practical (Hours (Hours Credit		(Marks – 50)		Term Examinati (Mark in Questic	ons (TEE) s- 100	
3	0	1	4	Marks Scale	d to 50	Marks Sc	· /
Pre-requis	ite: Fundame	ntal Knowle	dge of phy	sics, chemistry a			
-			0 1 9				
Objectives		a understand	ling of bio	logical mechanis	me of livi	na organisms	from the
-	pective of eng		ung of bio	logical incentains		ig ofganishis	nom me
-				:	~ h: 1 ~ ~	1	
		-	idents to th	ink about solvin	g biologica	a problems v	lin
0	ineering tools.	•					
Outcomes:			,	1 11 .			
1	letion of the c				1 1		
I. Con dive		orms of life l	have the sa	me building blo	cks and ye	t the manifest	tations are
		a genetic ma	aterial in th	e molecular basi	is of inform	nation transfe	r
	•	-		en different med			
		•		logical systems.	11411151115 0	i chizyine acti	.011.
	tify and class			logical systems.			
	vllabus: (per						
	cription	F	-)				Duration
	roduction						Duration
Cor Phy scie Bird inde how Exa refe The	vey that Biol sics and Ch nce and engin flying and a ependent scient biological of mples from rring to the	emistry Brineering by on aircraft. Me ntific discip bservations Brownian original ob will highligh	ing out the drawing a ntion the r bline. Why of 18th C motion an servation	a scientific disci- ne fundamental comparison betw most exciting as we need to st entury that lead d the origin of of Robert Brow amental importa	difference ween eye a pect of bio udy biolog to major f thermody	es between and camera, ology as an gy? Discuss discoveries. ynamics by lius Mayor.	03
	ssification						
Cor und higl thre (a) euc. lith	erlying criter alighted. Hier ad weaves th cellularity- U aryotes. (c) o otrophs (d) A	ion, such a archy of lif is hierarchy nicellular o energy and Ammonia e	s morphol e forms at Classific r multicell Carbon xcretion –	not what biolo ogical, biochem phenomenolog ation. Discuss c ular (b) ultrastru utilization -Auto aminotelic, ur Molecular tax	ical or ec ical level. lassificatio ucture- pro otrophs, h icotelic, u	A common on based on karyotes or eterotrophs, reotelic (e)	06



	kingdoms of life. A given organism can come under different category based on classification. Model organisms for the study of biology come from different groups. E.coli, S.cerevisiae, D.Melanogaster, C.elegance, A. Thaliana, M.musculus	
3.	Genetics Convey that "Genetics is to biology what Newton's laws are to Physical Sciences" Mendel's laws, Concept of segregation and independent assortment. Concept of allele. Gene mapping, Gene interaction, Epistasis. Meiosis and Mitosis be taught as a part of genetics. Emphasis to be give not to the mechanics of cell division nor the phases but how genetic material passes from parent to offspring. Concepts of recessiveness and dominance. Concept of mapping of phenotype to genes. Discuss about the single gene disorders in humans. Discuss the concept of complementation using human genetics.	06
4.	Biomolecules Convey that all forms of life have the same building blocks and yet the manifestations are as diverse as one can imagine Molecules of life. In this context discuss monomeric units and polymeric structures. Discuss about sugars, starch and cellulose. Amino acids and proteins. Nucleotides and DNA/RNA. Two carbon units and lipids.	05
5.	Enzymes Convey that without catalysis life would not have existed on earth Enzymology: How to monitor enzyme catalyzed reactions. How does an enzyme catalyze reactions? Enzyme classification. Mechanism of enzyme action. Discuss at least two examples. Enzyme kinetics and kinetic parameters. Why should we know these parameters to understand biology? RNA catalysis.	05
6.	Information Transfer The molecular basis of coding and decoding genetic information is universal Molecular basis of information transfer. DNA as a genetic material. Hierarchy of DNA structure- from single stranded to double helix to nucleosomes. Concept of genetic code. Universality and degeneracy of genetic code. Define gene in terms of complementation and recombination.	06
7.	Macromolecular analysis How to analyse biological processes at the reductionistic level Proteins- structure and function. Hierarch in protein structure. Primary secondary, tertiary and quaternary structure. Proteins as enzymes, transporters, receptors and structural elements.	05
8.	Metabolism The fundamental principles of energy transactions are the same in physical and biological world. Thermodynamics as applied to biological systems. Exothermic and endothermic versus endergonic and exergonic reactions. Concept of Keq and its relation to standard free energy. Spontaneity. ATP as an energy currency. This should include the breakdown of glucose to CO2 + H2O (Glycolysis and Krebs cycle) and synthesis of glucose from CO2 and H2O (Photosynthesis). Energy yielding and energy consuming reactions.	05



<u>.</u>	Concept of Energy	Charge.				
9.	Concept of single celled organisms. Concept of species and strains. Identification and classification of microorganisms. Microscopy. Ecological aspects of single celled organisms. Sterilization and media compositions. Growth kinetics.					
	Total			45		
Гext	Books:					
		ý či	neers'' CRC Press Taylor & Francis C.A. Klein 2008, 7th edition McGrav	0 1		
Refe	erence Books:					
1.	Biology: A global ap	proach: Campbell, N. A	.; Reece, J. B.; Urry, Lisa; Cain, M, L	<i></i> ;		
	Wasserman, S. A.; N	linorsky, P. V.; Jackson	, R. B. Pearson Education Ltd			
2.	Outlines of Biochem	istry, Conn, E.E; Stump	f, P.K; Bruening, G; Doi, R.H., John	Wiley and		
	Sons					
3.	Principles of Bioche	mistry (V Edition), By N	Nelson, D. L.; and Cox, M. M.W.H. Fi	reeman		
Any	other information:					
Tota	al Marks of Internal	Continuous Assessm	nent (ICA): 50 Marks			
	ribution of ICA Ma					
-	Description of ICA Marks					
	Test Marks 20					
Ter	rm Work Marks	30				
		50				

Details of Term work: As per institution norms.



Program:	B. Tech. (Mechatronic	s Engineer	ring)	Semester	r: V		
Course/M	odule : Theo	ry of Machi	nes		Module	Code: BTMA	405008	
	Teaching	Scheme			Evaluatio	on Scheme		
Lecture (Hours per week)	Practical (Hours per week)	Tutorial (Hours per week)	Credit	Assessment	rnal Continuous sessment (ICA) (Marks - 50)		rm End ations (TEE) arks- 100 stion Paper)	
3	2	0	4	Marks Scale	d to 50		caled to 50	
Pre-requ	isite: NIL			I				
 To clu To 4. To Outcome After com Un bra Ca me Co 	understand t provide know tch, brakes, f introduce dif impart know s: upletion of th derstand the kes, dynamo lculate the st chanisms gra nstruct variou	wledge of m lywheel and fferent types dedge of var e course, stu concept of meters and g tatic and dy uphically. us type of Ca	otion analy l gyroscope of cam an rious types udents wou f kinetics, gyroscopic namic fore am profile	Id follower syste of gear and gear Ild be able to: kinematics inv	ems and ma m. r-train. version of velocity a e standard	chains, frict and accelera motion of the	ion clutches, tion of given e follower.	
	Syllabus: (p	er session p	lan)				D	
	Description		1 .	1) (1' 5'	• 1 •	• , , ,	Duration	
1. 1 1. 0	body, Link), (bermitted succriterion and (nversion of Four bar chai	Classificatio h as revolut Grasshof's c chain: mecl n, Single sli	n Kinemat e, prismati criteria. hanisms, q der crank o	nd Machines, Rig tics pairs), Basec c, cam, helical C uick return mech chain, Double sli generating Mech	d on relativ Globular. G hanism, ap ider crank	re motion Grubler's plications.	08	
2.	Velocity ana velocity meth	alysis: inst hod, rubbing analysis: re	antaneous y velocities elative met	s: (Graphical a) center of rotat at joints, mecha hod including ki	tion metho anical adva	ntage.	08	
3.	Centrifugal c Brakes and ransmission Flywheel: Tu	lutch, Torqu I Dynamo dynamomete urning mom	e transmitt meters: 7 ers. ent, functi	nultiple plate of ting capacity. Types of Brak ton of flywheel, overs and machin	xes, absor estimating	ption and	08	



		0
4.	Cams and Followers: Types of cams and followers, analysis of standard motions to the follower, determination of cam profiles for given follower motions, analysis of cams with specified contours- circular arc cam, tangent cam, eccentric cam, kinematically equivalent system, jump phenomenon,	08
5.	Gears and Gear trains:Definition, Classification of gears and Law of gearingSpur Gears: Terminology, conjugate action, involute and cycloidalprofile, path of contact, arc of contact, contact ratio, interference,undercutting, Methods to avoid interference and undercutting, Rack andpinion.Helical Gears, Spiral Gears, Worm gears, Bevel Gears, rack and piniongears.Gear trains: Types of gear trains (Simple, compound and epicyclic).Velocity ratio.	07
6.	Gyroscope: Principle, gyroscopic couple, effect of gyroscopic couple on stability of an automobile, gyroscopic effect on two wheelers, four wheels and aero planes.	06
	Total	45
	Books:	
	Thomas Beven (2009), "Theory of Machines", 3rd Edition, Pearson.	
	S. S. Rattan (2009), "Theory of Machines", 3rd Edition, Tata McGraw Hill,	New Delhi.
	ence Books:	
1.	John Uicker, G R Pennock J. E. Shigley (2010), "Theory of Mechanisms an	nd Machines"
2.	 3rd Edition, University Press. P. L. Ballaney (2005), "Theory of Machines and Mechanisms", 24th Ed Publishing, New Delhi. 	ition, <i>Khann</i>
3.	Ghosh and Malik (1988). "Theory of Mechanisms and machines", East W Ltd.	est press Pv
Any o	other information:	
Total	Marks of Internal Continuous Assessment (ICA): 50 Marks	
Distri	ibution of ICA Marks:	
	ription of ICA Marks	

Description of ICA	Marks
Test Marks	20
Term Work Marks	30
Total Marks :	50

Details of Term work:

Term work should consist of the following:

- 1. Assignments given by the faculty based on above syllabus (Min. 3).
- 2. Minimum 6 experiments based on above syllabus
- 3. Viva Voce or Multiple Choice Questions (MCQ) Examination.



Signature (Prepared by Concerned Faculty/HOD)

Progra	m: B. Tech. (Me	chatronics	Engineerir	ıg)		Semest	er: V		
	e/Module: Indust	rial Electro				Modul	e Code: BTM	A05009	
	Drive								
_		ing Scheme					uation Schem	ie	
(Hour per	Lecture (Hours per per veek) Hours per veek) Hours Per veek		Credit	C Asses	Interna ontinuo ssment	ous (ICA)	Term End Ex (TE (Marks	EE)	
week)	week)			larks -	-	in Questio		
3		0	4		Scale		Marks Sca		
	quisite: Basic El A03012)	ectrical Eng	gineering (BIMA)1002)	and Ana	llog Devices a	nd Circuits	
Object	ives:								
2. T 3. T 4. T	To understand the To study converte To study AC, DC To design drives a To expose student	r circuits fo & synchror and regulate	or AC-DC a nous motor ory circuits	and AC- drive c used in	AC pov ircuits. power	wer conv electroni	c industry.		
Outcor				1			•		
1. K 2. A 3. U ii	ompletion of the Know power elect Analyze and desig Inderstand the sign ndustry.	tronic semic gn power ele ignificance	conductor of ectronic cir of drives	devices rcuits fo	for diffe r indust	rial appl	ications.	electronic	
	d Syllabus: (per	session pla	an)					I	
Unit	Description							Duration	
1.	Power Device ratings of SCR, Methods of turn Methods of turn	, GTO, IGB ning on of S	T, DIAC a SCR- Gate	nd TRL triggerin	AC. ng circu			08	
2.	Power Conver	-						07	
	Single phase a and waveforms controlled recti Cycloconverte waveforms of configuration o	and three p s for R and fiers using o r: Circuit single ph	d R-L loa controlled Diagram,	ds of si devices. basic	ngle pl princip	hase and	three phase peration and		
3.	DC Drives: Ba Single Phase D Full Converter Three Phase D Full Converter Chopper Drive Brake Control	sic Charact prives-Half Drives, Dua rives-Half v Drives, Dua s-Principle	wave conv al Converto vave conv al Converto of Power	erter Dr er Drive erter Dr er Drive Contro	ives, So s. ives, So s. 1, Princ	emi conv emi conv ciple of	verter Drives, verter Drives, Regenerative	14	



Total		45
	Brushless DC and AC Motor Drives	
	Reluctance Motors, Closed-Loop Control of Synchronous Motors,	
	Motors, Reluctance Motors, Permanent-Magnet Motors, Switched	
5.	Synchronous Motor Drives: Cylindrical Rotor Motors, Salient-Pole	07
	Control of Induction Motors.	
	Current Control, Voltage, current and Frequency Control, Closed-Loop	
	power recovery, Frequency Control, Voltage and Frequency Control,	
	Characteristics, Stator Voltage Control, Rotor Voltage Control, Slip	
4.	AC Drives: Introduction, Induction Motor Drives, Performance	09
	Microcomputer Control of DC Drives.	
	Closed Loop Transfer Function, Phase Locked Loop Control,	
	Closed Loop Control of DC Drives- Open Loop Transfer Function,	

Text Books:

- 1. M. Rashid, "Power Electronics", Prentice Hall of India Publication, 3rd Edition, 2010.
- 2. M. D. Singh & K. B. Khanchandani, "Power Electronics", Tata McGraw Hill, 2nd edition, 2006.
- 3. Dubey G.K, "Fundamentals of Electrical Drives", Narosa Press, 2nd Edition, 2002

Reference Books:

- 1. Ned Mohan, Undeland Robbins, "Power Electronics", John Wiley Publication year, 3rd Edition, 2009
- 2. Landers, "Power Electronics", McGraw Hill, 3rd Edition, 1993.

Any other information:

Total Marks of Internal Continuous Assessment (ICA): 50 Marks

Distribution of ICA Marks:

Description of ICA	Marks
Test Marks	20
Term Work Marks	30
Total Marks :	50

Details of Term work:

Term work should consist of the following:

- 1. Minimum two assignments.
- 2. Minimum ten experiments covering the whole of syllabus, duly recorded and graded.
- 3. Two term test papers.



Progra	m : B. Tech. (N	Mechatronic	s Engineer	ring)	Semeste	er: V	
Course	/Module: Esse	ence of India	n Traditio	nal	Module	Code : BTM	IA05010
	Kno	wledge					
	Те	eaching Sch	eme		I	Evaluation S	cheme
Lectur (Hours per week)	s (Hours per	Tutorial (Hours per week)	Credit	Internal Con Assessment (Marks -	(ICA)	Examinat (Mar	n End ions (TEE) ks ion Paper)
2	0	0	0	Marks Scale	ed to 50	-	
	uisite: NIL						
n	This course prov nodern society.		uction to I	ndian traditiona	l knowled	lge and its rel	evance in the
Outcon	ne: ompletion of th	e course st	idents wor	ıld he ahle to:			
	1	-			d ita inan	ortonac	
		-		ll knowledge an tics to solve pr	-	onance	
		-		iti in modern m		at	
				ni modern m	anagemen	ni –	
Unit	d Syllabus: (p Description	er session p	1a11)				Duration
1.	Ĩ	to tradition	nal lunavi	edge: Define t	n dition al	Imaguladaa	Duration
1.	nature and ch knowledge, t knowledge de knowledge s traditional kn	naracteristics the physica evelop, the h systems. In nowledge Vs western	s, scope a l and soo istorical in digenous vis-à-vis	ind importance cial contexts npact of social Knowledge indigenous kn ge traditional	, kinds o in which change o (IK), cha owledge,	f traditional traditional n traditional aracteristics, traditional	05
2.	and engineeri TK in agricul healthcare n	ng, Traditic ture, Traditic teeds, Imp of environ	onal medic ional socie ortance on nment, M	ent sectors: T vine system, Th eties depend on of conservation lanagement of on of TK.	K and bio it for the on and	eir food and sustainable	05
3.		quadratic		subtraction, mu , simultaneou	-		10
4.	-		-	ent: leadership	, qualities	of a leader,	10
	people manag	gement, strat	egy, teamv	work			20
	Total						30



Text Books:

- 1. R. Pillai, Corporate Chanakya, Jaico Publishing House: Mumbai, 2012.
- 2. S. B. K. Tirtha and V. S. Agrawala, Vedic Mathematics, New Delhi: Motilal Banarsidass, 2004.
- 3. A. Jha, Traditional Knowledge System in India, New Delhi: Atlantic Publishers and Distributors (P) Ltd, 2009.

Reference Books:

- 1. D. Bathia, Vedic Mathematics Made Easy, Mumbai: Jaico Publishing House, 2014.
- 2. B. K. Mohanta and V. K. Singh, Traditional Knowledge System and Technology in India, Delhi: Pratibha Prakashan, 2012.
- 3. S. Bose, Vedic Mathematics, V&S Publishers: New Delhi, 2015.

Any other information:

Total Marks of Internal Continuous Assessment (ICA): 50 Marks

Distribution of ICA Marks:

Description of ICA	Marks
Test Marks	
Term Work Marks	50
Total Marks :	50

Details of Term work: As per Institute norms.



		echatronics Eng			Semest		
Course/N	Iodule: Manag	gement Accoun	ting for Engi	neers	Module	e Code : BTMA	405011
	Teachin	ng Scheme		E	Evaluatio	n Scheme	
Lecture (Hours per week)	Practical (Hours per week)	Tutorial (Hours per week)	Credit	Internal Cont Assessment (Marks -	(ICA) 50)	Term F Examinatior (Marks - in Question	ns (TEE) · 100
2			2	Marks Scale	d to 50	Marks Scal	ed to 50
Prerequi	site: Nil						
Objectiv	es:						
pr	rinciples and j	practices relev	ant for busi	Cost and Man ness analysis a alyze and use c	nd decis	sion making.	u to day
	isiness function		erstand, and	alyze allu use c			y-t0-uay
3. То		understanding	g of measure	ement of cost a	nd tracir	ng the costs to)
	o explain the 1 rategies.	cole of relevar	nt costs in de	ecision making	and dev	eloping bette	r
	o discuss cont cactical applic		ues in Cost a	and Manageme	ent Acco	unting and th	eir
Outcome							
	-	-	-	ould be able to;			
		of principles of Job and Proc		sting methods Methods	v1z., Act	ivity Based C	osting
`	eparation of e	-	costing	wiethous.			
	1		nalysis in b	usiness decisio	n makin	<i>σ</i> .	
-		nd Cost Varia	-			0	
	5			nanagerial dec	ision ma	king	
	0 0	, methods of I	-	e		0	
			5	e reliable and a	accurate	product cost	data
		er session pla				-	
Unit	Description						Durati on
1	InterfaceMethodsTypes of	of Financial a of costing	ccounting v	Cost concepts: vith Cost accou ehaviour	inting –		2



	Classification of Costs based on Behaviour	
	Readings: Cost accounting. 5/e, Lal. J., & Srivastava, S. (2013). New Delhi, Tata McGraw Hill – Chapter1 and 2	
	Outcome addressed 1	
2	 Topic: Cost Concepts Classification of Costs based on Degree of Traceability to the product Functional Classification of Costs Costs for Decision making and planning 	2
	Readings: Cost accounting. 5/e, Lal. J., & Srivastava, S. (2013). New Delhi, Tata McGraw Hill - Chapter 2	
	Outcome addressed 1	
3	Topic: Preparation of Cost sheet	2
	Readings: Cost accounting. 5/e, Lal. J., & Srivastava, S. (2013). New Delhi, Tata McGraw Hill - Chapter 2	
	Outcome addressed 2	
4	 Topic: Cost-Volume-Profit Analysis: Concept of Marginal Costing Cost-Volume-Profit relationship – The break-even point – Readings: Cost accounting. 5/e, Lal. J., & Srivastava, S. (2013). New Delhi, Tata McGraw Hill - Chapter 16 	2
	Outcome addressed 3	



	Topic:	
	Cost-Volume-Profit Analysis:	
5	Contribution margin concept –	
	Margin of safety	2
	Readings	
	Readings: Cost accounting. 5/e, Lal. J., & Srivastava, S. (2013). New Delhi, Tata	
	McGraw Hill - Chapter 16	
	Outcome addressed 3 Topic:	
	Topic.	
	Cost-Volume-Profit Analysis:	
6		
	Applying cost-volume-profit analysis –	2
	Des din set	2
	Readings: Cost accounting. 5/e, Lal. J., & Srivastava, S. (2013). New Delhi, Tata	
	McGraw Hill - Chapter 16	
	Outcome addressed 3	
	Topic:	
7		
/	Decisions making:	
	Alternative choice decisions –	
	Limiting factor decisions	
	Add or drop products	2
	Readings:	
	Readings: Cost accounting. 5/e, Lal. J., & Srivastava, S. (2013). New Delhi, Tata	
	McGraw Hill - Chapter 17	
	Outer man data and 2	
	Outcome addressed 3	



	Topic:	
	Decisions making:	
8	Make or Buy decisions	
	Shut down decision	
	Special orders	
		2
	Readings:	
	Cost accounting. 5/e, Lal. J., & Srivastava, S. (2013). New Delhi, Tata McGraw Hill - Chapter 17	
	Outcome addressed 3	
	Topic:	
	Variance analysis-	
9		
	Direct material variances	
	Cost Variance	
	Price Variance	2
	Usage Variance	
	Readings:	
	Cost accounting. 5/e, Lal. J., & Srivastava, S. (2013). New Delhi, Tata	
	McGraw Hill - Chapter 19	
	Outcome addressed 4 Topic:	
	Topic.	
10	Variance analysis-	
	Direct labour variances	
	Cost Variance	
	Rate Variance	2
	Efficiency Variance	2
	Readings:	
	Cost accounting. 5/e, Lal. J., & Srivastava, S. (2013). New Delhi, Tata McGraw Hill - Chapter 19	
	Outcome addressed 4	



	Topic:	
11	Budgetary Control	
	Flexible Budget	
	Readings: Cost accounting. 5/e, Lal. J., & Srivastava, S. (2013). New Delhi, Tata McGraw Hill - Chapter 20	2
	Outcome addressed 5	
	Topic:	
	Budgetary Control	
	Cash Budget	
12	Readings: Cost accounting. 5/e, Lal. J., & Srivastava, S. (2013). New Delhi, Tata McGraw Hill - Chapter 20	2
	Outcome addressed 5	
	Topic:	
13	 Inventory Management EOQ Inventory levels- Minimum, Maximum, Re-order, Average Inventory control Techniques- ABC Analysis, JIT method 	2
	Readings: Cost accounting. 5/e, Lal. J., & Srivastava, S. (2013). New Delhi, Tata McGraw Hill - Chapter 3	
	Outcome addressed 6	
14	Topic:	
	Activity Based Costing	2
	under costing and over costing-traditional vs activity-based costing-	
NQ/		

	10(01	50
	Total	30
	Outcome addressed 7	
	McGraw Hill - Chapter 8	
	Cost accounting. 5/e, Lal. J., & Srivastava, S. (2013). New Delhi, Tata	
	Readings:	
15		2
	Application of Activity based costing in decision making	
	Activity Based Costing	
	Topic:	
	Outcome addressed 7	
	McGraw Hill - Chapter 8	
	Cost accounting. 5/e, Lal. J., & Srivastava, S. (2013). New Delhi, Tata	
	Readings:	
	• Evaluation of costs and benefits of implementing ABC systems	

Text Book :

Cost accounting. 5/e, Lal. J., & Srivastava, S. (2013). New Delhi, Tata McGraw Hill.

Reference Books:

- Horngren, C., Datar, S. & Rajan, M. (2014). Cost accounting: A managerial emphasis. 15/e, New Delhi, Pearson Publication.
- Khan, M.Y., & Jain, P.K. (2007). Cost accounting. 7/e, New Delhi, Tata Mc- Graw Hill.
- Ramanathan, S. (2014). Accounting for Management. New Delhi, Oxford University ٠ Press.
- Shah, P. (2012). Management Accounting. 7/e, New Delhi, Oxford University Press.
- Sanyers, J., & Jenkins, & Arora. (2012). *Managerial Accounting*. 1/e, Delhi, Cengage Learning.

Internet References :

http://icmai.in

https://www.cimaglobal.com

Any other information:



Detail of Test: Questions based on concepts, applications and numerical

MT-01: Scope: Topics from Unit - 01 to 06 for 10 Marks MT-02: Scope: Topics from Unit - 07 to 09 for 10 Marks

Test Marks – 20 Marks Term Work – 30 Marks

Details of Term work: Projects/Presentations application of concepts from on Unit 01 to Unit 15.



<u> </u>		```	atronics Eng			Semester : V		
Cours			Mechanical	Workshop		Module Code:		
		Teaching S	Scheme	1			on Schem	
	ours	Practical (Hours per week)	Tutorial (Hours per week)	Credit		Internal Continuous sessment (ICA) (Marks - 50)	Examin (M	rm End ations (TEE) arks stion Paper)
()	2	0	1	Ma	rks Scaled to 50		
Pre-r	equisite:	Workshop	Practice (BT.	AB02006)	•			
1. Outco After 1.	omes: completion Perform	on of the co n different c	urse, student	s would be Machine T	e able Fools	cepts of Mechatro to: or specific applica		
	-		ession plan)	wicchation		n specific applica	10115.	
Unit	Descrij							Duration
1.			chine Shop &	& jobs usin	ig var	ious machining pr	ocesses.	10
2.	of a Mi	nor Project	based on Mi	croprocess	ors/ N	ronics for implem Aotors/ Digital Cin ives/PLC program	rcuits/	20
	Total		,			<u> </u>		30
Any o	ther infor	rmation:						
		Internal Co ICA Marks	ontinuous Ass :	essment (I	CA):	50 Marks		
	ription of	ICA	Marks			_		
	Marks	<u> </u>				_		
Tern	n Work N	1arks	50			_		
1								
Tote	l Marks :		50					



Prog	ram: B	<u>s. Tech</u> . (M	echatronics I	Ingineering	g)		ester: V	
Cour	rse/ Moo	dule: (Prot	fessional Ele	ctive Cour	se-1)	Mod	ule Code: B	ГМА05013
		Ther	modynamic	s and Hea	t Transfer			
		Teaching	Scheme		Eva	luatio	n Scheme	
Lectu (Ho per w	ours	Practical (Hours per week)	Tutorial (Hours per week)	Credit	Internal Contin Assessment (I (Marks - 50)	CA)	Term Examinati (Mark in Questi	ons (TEE) s- 100
3	3	2	0	4	Marks Scaled t	o 50	Marks Sc	aled to 50
Pre-r	requisit	e: Physics	(BTMA0100	3), Mathem	natics-I (BTMA010	01),Ma	thematics-II	
BTM	/A0200	8) Mather	natics – IV (I	BTMA0400	08)			
3. <u>4.</u> Outco	problen To intro	ns. oduce the b	oroad-based u	ınderstandiı	modynamics and the second seco	es of he	at transfer.	0
1. 2. 3.	Know t Analyze thermoo Proficie and so	the fundam the closed s dynamics(ently apply plution of	ystems, stea energy), seco heat transfer engineering	ts of engine dy and un nd law of th principles	be able to: ering thermodynam steady flow open nermodynamics(ent (conduction, conve including analytic	system ropy). ction a	nd radiation)	to modeling
1. 2. 3.	Know t Analyze thermoo Proficie and so governi	the fundam the closed s dynamics(or ently apply plution of ing equation	ental concept ystems, stea energy), seco heat transfer engineering ns.	ts of engine dy and un nd law of th principles problems	ering thermodynam steady flow open nermodynamics(ent (conduction, conve	system ropy). ction a	nd radiation)	to modeling
1. 2. 3.	Know t Analyze thermoo Proficie and so governi iled Syl	the fundam the closed s dynamics(or ently apply plution of ing equation	ental concept ystems, stea energy), seco heat transfer engineering	ts of engine dy and un nd law of th principles problems	ering thermodynam steady flow open nermodynamics(ent (conduction, conve including analytic	system ropy). ction a	nd radiation)	to modeling
1. 2. 3. Detai	Know t Analyze thermoo Proficie and so governi iled Syll Introd descrij thermo proper thermo contin Pressu tempe thermo thermo	the fundam are closed s dynamics(ently apply blution of ing equation labus: (per duction: E aption of m odynamic rties, proce odynamic nuum. ure, Volu erature and odynamics s, compari- iometers; in	ental concept ystems, stea energy), seco heat transfer engineering ns. r session pla Definition, an hatter – mach system, surro esses and cy equilibrium; me and Te l their meas ; – thermor son of diff	ts of engine dy and un nd law of the principles problems n) Descri d basic cor roscopic de oundings an ycles; home quasi-static mperature surements; netric prop ferent type	ering thermodynam steady flow open nermodynamics(ent (conduction, conve including analytic	system ropy). ction a al and ng ther oscopic ary; the rogene ostance essure, um; Zo uperatu rs; ide	nd radiation) numerical s modynamics; e description; ermodynamic ous systems; ; concepts of volume and eroth law of re, reference sal gas; gas	to modelin solutions t Duratio
1. 2. 3. Detai Unit	Know t Analyze thermoo Proficie and so governi iled Syll Introo descrip thermo contin Press thermo tempe thermo points thermo Examp law fo forms	the fundam the closed s dynamics(ently apply blution of ing equatio labus: (per duction: E aption of m odynamics rties, proce odynamic strue, proce odynamics arties, proce odynamics s, compari- tometers; in ples. Law of The or a closed	ental concept ystems, stea energy), seco heat transfer engineering ns. r session pla Definition, an eatter – mach system, surro esses and cy equilibrium; me and Te I their meas ; – thermor son of diff deal gas ten ermodynam system und energy; pure	ts of engine dy and un nd law of the principles problems n) Descri d basic correscopic de oundings an ycles; home quasi-static mperature surements; netric prop ferent type nperature; itcs: Definit	ering thermodynam steady flow open nermodynamics(ent (conduction, conve including analytic ption neepts of engineerin scription and micr d the system bound ogeneous and hete c process; pure sub : definition of pro Thermal equilibrius perty, scale of ten es of thermomete	system ropy). ction a al and ng ther oscopic ary; the rogene ostance essure, um; Zo operatu rs; ide e scale Appli	nd radiation) numerical s modynamics; e description; ermodynamic ous systems; ; concepts of volume and eroth law of re, reference eal gas; gas e; illustrative	to modelin solutions Duratio



	statement of second law; Clausius statement of second law; equivalence between the two statements; reversibility and irreversibility- definition of a reversible heat engine; Statement of Third Law of Thermodynamics and its importance	
4.	Entropy: Introduction; Clausius inequality (or Clausius theorem); Entropy as a property of a system; Temperature – entropy plot and its usefulness in analyzing thermodynamic processes; entropy change for an irreversible process; principle of increase of entrop; Carnot cycle, entropy generation in closed and open systems; Tds relations and their significance(first and second law combined), Isentropic process.	06
5.	Basic ConceptsModes of Heat Transfer, its mechanism and mathematical model.Conduction Heat Transfer:Fourier's general conduction equation in Cartesian, cylindrical and spherical co- ordinates, thermal resistance, Solution of Fourier's equation for one dimensional steady state heat conduction through various configurations such as plane, cylindrical, spherical wall, composite medium.(for cylindrical and spherical walls derivation of Fourier's three-dimensional equation is not included), Critical thickness of insulation and its importanceHeat Transfer from extended surfaces: Types of fins, Governing equation, fin effectiveness, efficiency of fin, concept of corrected fin length, application of fins.	12
6.	 Unsteady State Heat Conduction: Lumped System Analysis, Heat Transfer in Semi Infinite solids, Use of Transient-Temperature Charts. Convection Heat Transfer: Classification of convection heat transfer- Forced & Natural, Hydrodynamic and thermal boundary layer, Momentum and energy equation for laminar boundary layer, Laminar and Turbulent flow. Convection heat transfer coefficient, Boundary layer similarities 	08
7.	Coefficient, Boundary aryor similaritiesThermal Radiation:Introduction to Physical Mechanism, concept of black body, and grey body,radiation properties. Basic laws of radiation- Planck's law, Kirchoff's law,Stefan-Boltzman law, Wein's-displacement law and Lambert's Cosine law	04
	Total	45
1. 2. Refer	 Books: P. K. Nag, "Engineering Thermodynamics", Tata McGraw Hill, 2008 Fundamentals of Heat and Mass Transfer (2017) by Theodore Bergman & Adrien 8th edition, Wiley Publication rence Books: Y. Cengel and M. Boles, "Thermodynamics -An Engineering Approach", Tat Hill, 2008. 	
2	Introduction to Thermodynamics and Heat Transfer by Yunus A. Cengel McGr	aw-Hill

2. Introduction to Thermodynamics and Heat Transfer by Yunus A. Cengel McGraw-Hill,.



Any other information:

Total Marks of Internal Continuous Assessment (ICA): 50 Marks

Distribution of ICA Marks:

Description of ICA	Marks
Test Marks	20
Term Work Marks	30
Total Marks :	50

Details of Term work:

Term work should consist of the following:

1. Assignments given by the faculty based on above syllabus (Min. 3).

- 2. Two term test papers.
- 3. Minimum 6 experiments based on the above syllabus



Program: 1	B. Tech. (Mech	atronics Eng	gineering)		Semester: V	V	
ē	dule: (Professi			÷-1)	Module Co	de: BTMA	05014
	Materials	s Engineerir	ıg				
	Teaching Se	cheme			Evaluatio	on Scheme	
Lecture	Practical	Tutorial		Int	ernal	Tern	n End
(Hours	(Hours per	(Hours	Credit	Cont	inuous	Examinat	ions (TEE)
per week)	week)	per	Cicuit		ent (ICA)		ks -100
1 /	,	week)		· · · ·	rks-50)		on Paper)
3	2	0	4		caled to 50	Marks Sc	caled to 50
-	te: Physics (B7	FMA01003)	, Chemistr	y (BTMA	02010)		
Objectives							
1. To le	arn the fundame	ental science	e and engin	neering rele	evant to mate	rials	
2. To in	troduce the con	cept of mec	hanical de	formation i	n metals		
3. To in	part the knowl	edge of vari	ious failur	e mechanis	ms in materi	als and the	theories and
desig	n modifications	to avoid the	em.				
Outcomes:							
	letion of the cou	urse, student	ts would b	e able to:			
-	n a process, mi	-			satisfy the sys	tem require	ments.
-	ze the root cau		1			1	
•	rstand formatio			• 1			
4. Selec	t appropriate	materials f	for variou	is applicat	ions depend	ing on the	e structural
requi	rements.						
Detailed Sy	llabus: (per se	ession plan)					
	cription						Duration
1. Me	chanical Behav	viour of Me	tals:				
	ormation: Def		-	stic deforr	1 .		10
	lesign and shap		,		nation and si	gnificance	10
mat	erials, critical st					-	10
Ma	,		ormation.	single crys	tal and poly	crystalline	10
1	terial Testing:	Destructiv	ormation. v e Testin g	single crys g: Basic	tal and poly	crystalline	10
	terial Testing: ile testing, hard	Destructiv	ormation. ve Testing , Impact te	single crys g: Basic esting.	tal and poly	crystalline properties,	10
Nor	terial Testing: ile testing, hard Destructive T	Destructiv	ormation. ve Testing , Impact te	single crys g: Basic esting.	tal and poly	crystalline properties,	10
Nor test	terial Testing: ile testing, hard Destructive T ng	Destructiv ness testing esting: Dye	ormation. v e Testing , Impact te e Penetran	single crys g: Basic esting. t, magnetic	tal and poly mechanical	crystalline properties, ultrasonic	10
Nor testi Stra	terial Testing: ile testing, hard Destructive T ng iin Hardening:	Destruction ness testing Cesting: Dyo	ormation. ve Testing , Impact te e Penetran and impor	single crys g: Basic esting. t, magnetic tance, dislo	tal and poly mechanical particle and pocation theory	crystalline properties, ultrasonic y, effect of	10
Nor testi Stra stra	terial Testing: ile testing, hard Destructive T ng in Hardening n hardening of	Destructive ness testing Sesting: Dye Definition n engineerin	ormation. ve Testing , Impact te e Penetran and impor ng behavio	single crys g: Basic esting. t, magnetic tance, dislo our of ma	tal and poly mechanical particle and potation theory terial. Recrys	crystalline properties, ultrasonic y, effect of	10
Nor testi Stra stra ann	terial Testing: ile testing, hard Destructive T ng in Hardening n hardening of ealing, recovery	Destructive ness testing Sesting: Dye Definition n engineerin	ormation. ve Testing , Impact te e Penetran and impor ng behavio	single crys g: Basic esting. t, magnetic tance, dislo our of ma	tal and poly mechanical particle and potation theory terial. Recrys	crystalline properties, ultrasonic y, effect of	
NortestiStrastraanni2.Fail	terial Testing: ile testing, hard Destructive T ng n Hardening n hardening of ealing, recovery ure of Metals:	Destructiv ness testing Cesting: Dyd c Definition n engineerin y, recrystalli	ormation. ve Testing , Impact te e Penetran and impor ng behavio zation and	single crys g: Basic esting. t, magnetic tance, dislo our of ma grain grov	tal and poly mechanical particle and potation theory terial. Recrys	crystalline properties, ultrasonic 7, effect of stallization	10
NortestiStrastraanno2.FailFra	terial Testing: ile testing, hard Destructive T ng in Hardening n hardening of ealing, recovery ure of Metals: cture: Definiti	Destructiv ness testing Cesting: Dyd Cesting:	ormation. ve Testing , Impact te e Penetran and impor ng behavio zation and	single crys g: Basic esting. t, magnetic tance, dislo our of ma grain grov	tal and poly mechanical particle and potation theory terial. Recrys	crystalline properties, ultrasonic 7, effect of stallization	
NortestiStrastraann2.FailFraMod	terial Testing: ile testing, hard Destructive T ng nin Hardening n hardening of ealing, recovery ure of Metals: cture: Definiti lification.	Destructiv ness testing Cesting: Dyd Cesting:	ormation. ve Testing , Impact te e Penetran and impor ng behavio zation and es, Griffth	single crys g: Basic esting. t, magnetic tance, dislo our of ma grain grov n's theory	tal and poly mechanical particle and ocation theory terial. Recrys yth. of fracture,	crystalline properties, ultrasonic , effect of stallization Orowan's	
NortestiStrastraanno2.FailFraMooFat	terial Testing: ile testing, hard of Destructive T ng nin Hardening of ealing, recovery ure of Metals: cture: Definiti lification. gue: Definition	Destruction ness testing Cesting: Dyd Definition n engineering, recrystalli on and typ	ormation. ve Testing , Impact te e Penetran and impor ng behavion zation and es, Griffth cance of c	single crys g: Basic esting. t, magnetic tance, dislo our of ma grain grov n's theory	tal and poly mechanical particle and ocation theory terial. Recrys with. of fracture, s, mechanism	crystalline properties, ultrasonic y, effect of stallization Orowan's of fatigue	
NortestiStrastraann2.FailFraMooFatand	terial Testing: ile testing, hard Destructive T ng in Hardening of ealing, recovery ure of Metals: cture: Definiti lification. gue: Definition theories of fa	Destructiv ness testing `esting: Dyd : Definition n engineerin <u>y</u> , recrystalli on and typ n and signifitingue failur	ormation. ve Testing , Impact te e Penetran and impor ng behavio zation and es, Grifftl cance of c e, S-N cu	single crys g: Basic esting. t, magnetic tance, dislo our of ma grain grov n's theory syclic stress rve and it	tal and poly mechanical particle and ocation theory terial. Recrys yth. of fracture, s, mechanism s interpretati	crystalline properties, ultrasonic y, effect of stallization Orowan's of fatigue	
NortestiStrastraanne2.FailFraMooFatiandeffe	terial Testing: ile testing, hard Destructive T ng in Hardening of ealing, recovery ure of Metals: cture: Definiti lification. gue: Definition theories of fa ct, surface effect	Destructive ness testing 'esting: Dye contained contained on and type n and signific tigue failure ct, Corrosion	ormation. ve Testing , Impact te e Penetran and impor- ng behavior zation and es, Griffth cance of c e, S-N cu n and therm	single crys g: Basic esting. t, magnetic tance, dislo our of ma grain grov n's theory syclic stress rve and it nal fatigue.	tal and poly mechanical particle and peation theory terial. Recrysy th. of fracture, s, mechanism s interpretati	crystalline properties, ultrasonic , effect of stallization Orowan's of fatigue on, Notch	
NortestiStrastraanno2.FailFraMooFattandeffeCree	terial Testing: ile testing, hard Destructive T ng in Hardening of ealing, recovery ure of Metals: cture: Definiti lification. gue: Definition theories of fa	Destructiv Iness testing Cesting: Dye Cesting: Dye Construction In engineering on engineering on and typ In and signific tigue failure t, Corrosion and significa	ormation. ve Testing , Impact te e Penetran and impor- ng behavion zation and es, Griffth cance of c e, S-N cu n and thermance of creations of creations of creations and thermance of creations of	single crys g: Basic esting. t, magnetic tance, dislo our of ma grain grov n's theory syclic stress rve and it nal fatigue.	tal and poly mechanical particle and peation theory terial. Recrysy th. of fracture, s, mechanism s interpretati	crystalline properties, ultrasonic , effect of stallization Orowan's of fatigue on, Notch	



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Engineering Allovs	07
operations	
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	07
Coring and dendritic segregation, Eutectic and eutectoid system.	
and structural constituent of phase diagram, Gibb's phase rule, Lever rule.	
solidification of alloys, progressive and directional solidification. phases	
pure metals, solid solutions, nucleation, growth of the new phase,	
	 solidification of alloys, progressive and directional solidification. phases and structural constituent of phase diagram, Gibb's phase rule, Lever rule. Coring and dendritic segregation, Eutectic and eutectoid system. Fe-Fe₃C Equilibrium Diagram: Importance of iron as engineering material, Allotropic forms of irons, Fe-Fe₃C diagram: phases, reactions, and critical temperatures Solidification and microstructure of different steels Effect of Alloying Elements in Steels: Limitation of plain carbon steels. Significance of alloying elements. Cast irons: White, gray and malleable cast iron, Nodular and mottled cast iron, Alloy cast iron Heat Treatment of Steel: Definition and significance of heat treatment, Time temperature transformation diagrams (TTT), Continuous cooling Transformation (CCT). Annealing: Process, properties and applications of full annealing, diffusion annealing, process Annealing and cyclic annealing. Normalizing: Hardening and Tempering. Powder Metallurgy: Characteristics and production of metal powders, blending and mixing, compacting, pre-sintering and sintering secondary

1. Willam D. Callister, Jr., Adopted by R. Balsubramanium (2012), "Material science and Engineering", Wiley India (P) Ltd.

2. S. H. Avner (2012), "Introduction to Physical Metallurgy", Tata McGraw Hill.

Reference Books:

- 1. V.D. Kodgire, S.V. Kodgire (2003) "Material science and Metallurgy" Everest Publishing House, Pune.
- 2. K.G. Budinksi & M.K. Budinksi (2016), "Engineering materials Properties and Selection", Pearson India Education Service Pvt. Ltd.



Any other information:

Total Marks of Internal Continuous Assessment (ICA): 50 Marks

Distribution of ICA Marks:

Description of ICA	Marks
Test Marks	20
Term Work Marks	30
Total Marks :	50

Details of Term Work:

Term work should consist of the following

- 1. A report on minimum 6 experiment based on the above syllabus
- 2. Minimum two assignments covering the syllabus



Program	: B. Tech. (N	Mechatronic	s Engineer	ring)	Semeste	er: V	
Course/N	Iodule: (Pro	fessional E id Mechanic		,	Module	Code : BTM	1A05015
		eaching Sch		iner y	F	Evaluation S	cheme
Lecture (Hours per week)	Practical (Hours per week)	Tutorial (Hours per week)	Credit	Internal Con Assessment (Marks -	(ICA)	m End tions (TEE) ks - 100 ion Paper)	
3	2	0	4	Marks Scale	ed to 50	Marks S	caled to 50
Pre-requi	(BTMA		· · · · · · · · · · · · · · · · · · ·	hematics-I (BT) – IV (BTMA04), Mathemati	ics-II
2. To 3. To Outcome After com 1. Ur 2. Ap life	b impart the less: s: pletion of the inderstand flu	lerstanding of knowledge of e course, stu id properties entals of lan	of various of character udents wou s, and their ninar and th	flow measurem ristics of the co ald be able to: r static-dynamic urbulent flow, b	mponents	of fluid mac	
	Syllabus: (p			i turonites			
·	escription	•					Duration
C re F N C B C t	Classification elationship. Tuid Statics Aanometers a urved subme Buoyancy an enter of buoy	of fluid, Ne Basic hydr and mechani rged surface d Floatatio yancy, metae entric height	wton's lav ostatic equ cal gauges es. n: Archim- center, met , condition	nuum, fluid pro v of viscosity, s ation, Pascal's s, hydrostatic fo edes' Principle tacentric height n of equilibrium	Law, app brces on pl , buoyanc , analytica	lication to lane and y force and al method	10
E u d	uler's methoniform and r	od, classifica on-uniform low, rotation	tion of flo , laminar a nal and irro	luid motion-La w types- steady and turbulent, or otational, lamin	and unstone and and unstone two and	eady, d three-	05
it Iı	s application	s-Venturim nentum equa	eter, orification and it	of motion, Berr e meter, rotame s applications,	eter, pitot	tube,	03



4.	Laminar Flow: Navier-Stokes equation of motion, developing	07
	expression for flow rate, pressure drop, shear stress, friction factor. Flow	-
	of viscous fluid in circular pipes.	
	Turbulent Flow: Shear stresses in turbulent flow, theories of turbulent	
	shear stress, hydro-dynamically smooth and rough surface, modeling of	
	turbulence.	
	Flow through pipes: Energy losses in pipes: Minor and Major losses,	
	Darcy-Weisbatch equation for head loss in pipes, hydraulic gradient	
~	lines, and total energy lines, pipes in series and parallel.	0.4
5.	Principles of hydraulic machines: Impacts of jet on flat plate and	04
	cured vanes, elements of a hydro power plant, types of heads and	
	efficiencies. Theory of impulse and reaction machines, Euler's energy equation applied to a turbine and pump, velocity triangles, expression	
	for work done.	
6.	Impulse Turbines & Reaction Turbines	06
	Construction, working and performance of Pelton turbine, Francis	
	Turbine and Kaplan Turbine	
7.	Pumps: Introduction, Classification of pumps - positive displacement	10
	and non - positive displacement.	
	Reciprocating Pump: Basic theory, construction, operation,	
	Slip, Indicator diagram. Types of reciprocating pumps, use of air vessel.	
	Rotary Pumps: Basic theory, types, construction and working, variable	
	delivery pumps.	
	Centrifugal pumps: Basic Theory, Euler's equation and velocity	
	triangles, classification, construction, operation, characteristics Priming	
	of pumps and NPSH	
	Theory, Construction and working of Air lift pump, Jet pump and	
	Hydraulic Ram.	
	Total	45
	Books:	
	Frank M. White (2008), "Fluid Mechanics", 6 th Edition, McGraw Hill.	
2.	S.K. Som, Biswas G., "Introduction to Fluid Mechanics and Fluid Machine	s", Tata
-	McGraw-Hill, 2nd Edition, 2008	-
3.	Yunus A. Cengel and John Cimbala (2008), "Fluid Mechanics", 2 nd Edition	n, Tata
Dafe	McGraw Hill.	
	ence Books: John F. Douglas, Janusz Gasiorek (2001), "Fluid Mechanics", 4 th Edition, <i>I</i>	Doarson
1.	Education.	eurson
2	P. N. Modi and S.M. Seth(2015), Fluid Mechanics and Hydraulic Machiner	rv Standar
<u> </u>		, , , , , unun

 P. N. Modi and S.M. Seth(2015), Fluid Mechanics and Hydraulic Machinery, Standard Book House, 22nd Edition.



Any other information:

Total Marks of Internal Continuous Assessment (ICA): 50 Marks

Distribution of ICA Marks:

Description of ICA	Marks
Test Marks	20
Term Work Marks	30
Total Marks :	50

Details of Term work:

Term work should consist of the following:

- 1. Assignments given by the faculty based on above syllabus (Min.3).
- 2. Minimum 6 experiments based on the above syllabus
- 3. Two term test papers.



	am: B. Tech. (M	lechatronics Eng	(ineering)		Semester : V			
Cours	se/ Module: (Pro	ofessional Electi	ve Course	-2)	Module Code: I	BTMA0501	6	
		strial Data Com	munication	1				
	Teachi	ng Scheme	1			on Scheme		
Lect	ture Practica	al Tutorial			Internal		erm End	
(Ho			Credit		Continuous		ions (TEE)	
•	week) ner week) Assessment (ICA) (Ma		· ·	rks- 100				
P ·	(Marks - 50) in Que			tion Paper)				
3	3 2	0	4	Ma	rks Scaled to 50	Marks S	caled to 50	
Pre-r	equisite: Princip	les of Communio	tation Engi	ineeri	ng (BTMA04012)			
	tives:		U					
1.	To create aware	eness about the C	OSI referen	ce mo	odel.			
2.	To acquaint the	students with th	e different	types	of networks at va	rious levels	such as	
	· · · · · · · · · · · · · · · · · · ·	vice network and						
	To provide suff							
	To impart the fu	undamentals of f	oundation	field	ous.			
Outed		. 1 .	111	11				
	completion of the							
		-			, various networkin			
	Use HART for	• 1	networks a	i vario	ous levels of field	communica	lion.	
			ommunica	tion				
	Investigate the			uon.				
	led Syllabus: (pe		uevices.					
Unit	Description	er session plan)					Duration	
<u>e me</u>	Introduction t	o Networks:					Durution	
			nodel. Tra	nsmis	sion media, UTP-	STP cable.		
1.		· · ·	,		bridge, hub, swit	· · ·	07	
	gateways.	1	1)	6, ,	, ,		
	Open Control	Network:						
2.	-		ous Structu	re, Im	plementation, GP	В,	08	
	Proprietary Con	ntrol N/Modbus	Plus.		-			
	Networks at d	ifferent levels:					08	
_	Sensor level ne	twork: AS-i, CA	N, Device	net, l	nterbus and LON			
2	Device network	ks: Foundation F	ieldbus H1	-HAI	RT Profibus-PA			
3.			4 1 4 FT	F-HSE				
3.		rk: BACnet, con	trol-net, FI	-1151	E, Profibus-DP.			
3.	HART:							
	HART: Architecture, P	hysical, Data Li	nk, Applic	ation,	Communication	- ·	08	
3. 4.	HART: Architecture, P Normal and bu	hysical, Data Li	nk, Applic	ation,		- ·	08	
	HART: Architecture, P Normal and bu HART	hysical, Data Li urst mode of co	nk, Applic	ation,	Communication	- ·	08	
	HART: Architecture, P Normal and bu HART Foundation Fi	hysical, Data Li urst mode of cc eldbus:	nk, Applic ommunicati	ation, ion, 7	Communication Troubleshooting, F	Benefits of	08	
4.	HART: Architecture, P Normal and bu HART Foundation Fi Fieldbus requi	hysical, Data Li urst mode of co eldbus: rement, features	nk, Applic ommunicati	ation, ion, T ges, f	Communication Troubleshooting, E	Benefits of nts, types,		
	HART: Architecture, P Normal and bu HART Foundation Fi Fieldbus requi architecture-ph	hysical, Data Li urst mode of co eldbus: rement, features nysical, data lin	nk, Applic ommunicati s, advanta ık, applica	ation, ion, T ges, f	Communication Troubleshooting, E Fieldbus component layer, system and	Benefits of nts, types, d network	08	
4.	HART: Architecture, P Normal and bu HART Foundation Fi Fieldbus requi architecture-ph management, v	hysical, Data Li urst mode of co eldbus: rement, features hysical, data lin wiring, segment	nk, Applic ommunicati s, advantag ik, applica functional	ation, ion, T ges, f ution lity c	Communication Troubleshooting, E	Benefits of nts, types, d network on in safe		



6.	ZigBee/IEEE 802	logies: , Wireless LANs (WLANs), WiFi, VPAN, 6LoWPAN, 2.15.4 protocol, Bluetooth Low Energy (BLE), GPRS and n, limitations and characteristics.	06
	Total		45
Text I	Books:		
	Communication,	s, Steve Mackay, Edwin Wright, Practical Indu 1st edition ELSEVEIR, 2005.	
2.	Lawrence M T	hompson, Industrial Data Communication, 2 nd editi	on, 1997.
Refer	ence Books:		
1.	Daniel T Miklovic	c, Real Time Control Networks, ISA 1993.	
2.	Bela G Liptak, Pro	ocess Software and Digital Networks,3 rd edition2002.	
		baum, Computer Networks, 4 th edition, PHI/Pearson Educat	ion,2002.
4.		uzan, Data Communications and Networking, 2 nd edition, Toompany, New Delhi, 2000.	ata McGrav
5.	Douglas E.Corner Asia, 5th Indian re	r, Computer Networks and Internets, 2nd edition, Pearso eprint, 2001.	n Educatio
Any of	ther information:	▲ · ·	
Total 1	Marks of Intornal C	continuous Assessment (ICA): 50 Marks	
TOTAL	viarks of internal C	ontinuous Assessment (ICA): 50 Marks	
Distrik	oution of ICA Marks	s:	
Desc	ription of ICA	Marks	
	Marks	20	
1	n Work Marks	30	
Tern			

- 1. At least ten laboratory experiments based on the entire syllabus duly recorded and graded.
- 2. Presentation/Application based experiment and Quiz/Practical exam/Viva/Any other mode of evaluation.



Progr	am: B. Tech. (N	lechatronics	Fngineeri	ng)	Semester : V		
0	e/ Module: (Pro		<u> </u>	0/	Module Code	: BTMA05	5017
	· · ·	non Program					
	Teaching		<u> </u>		Evaluatio	n Scheme	
Lectu	Ŭ V	Tutorial		T		Ter	m End
(Hou	rs (Hours	(Hours	Credit		l Continuous	Examina	tions (TEE)
per	per	per	Crean		ment (ICA) arks - 50)	(Ma	rks- 100
week	x) week)	week)			,		tion Paper)
3	2	0	4		Scaled to 50	Marks	Scaled to 50
Pre-re	equisite: Program	nming for P	roblem So	lving (BT	MA02009)		
Objec	tives:						
•	To know the ba	asics of algo	rithmic pro	oblem solv	ving		
2.	To develop Pyt	hon program	ns with co	nditionals	and loops.		
3.	To define Pyth				1		
4.	•				with files in Pyt	hon.	
Outco			1	1	5		
	completion of the	e course, stu	dents wou	ld be able	to:		
	Develop algori					ns	
	Decompose a F		-		-		
3.	Represent com				ples, dictionarie	es.	
4.	Read and write				-		
	ed Syllabus: (p			J	6		
Unit	Description	•	,				Duration
	Algorithm Pro	oblem Solvi	ng:				
	Algorithms, bu	uilding bloc	ks of alg	orithms (s	statements, state	e, control	
					ow chart, prog	gramming	
1.	language), al	0	1	U .	1	0	08
					lustrative probl		
				ist of sorte	ed cards, guess	an integer	
	number in a rai	0					
	Data, Express			a a day 1-	ing and transm	int flast	
					ues and types:		
2.		-		-	sions, statements; modules and	-	10
۷.					cution, parame		10
					e values of two		
	-	-	-	-	ween two points		
	Control Flow,				P = 1105		l
	· · · · · · · · · · · · · · · · · · ·			erators, co	onditional (if), a	lternative	
			-	-	eration: state, v		10
3.	· /·			· · ·	values, parame		
э.			-		ion; Strings: str	-	
					string module;		
					, exponentiation	n, sum an	
	array of numbe	ers, linear se	arch, binar	y search.			



1	Lists: list operations, list slices, list methods, list loop, mutability, aliasing, cloning lists, list parameters; Tuples: tuple assignment, tuple as return value; Dictionaries: operations and methods; advanced list processing - list comprehension; Illustrative programs: selection sort, insertion sort, merge sort, histogram. Files, Modules, Packages:					
5.	Files and exception operator; command	ckages: on: text files, reading and writing files, format d line arguments, errors and exceptions, handling s, packages; Illustrative programs: word count, copy	08			
	Total		45			
Text B		high Buthons How to Thigh Like a Computer Scienting	t and adition			
	•	'hink Python: How to Think Like a Computer Scientist 3, Shroff/O'Reilly Publishers, 2016.	t, 2nd edition,			
		and Fred L. Drake Jr, An Introduction to Python –	Revised and			
		3.2, Network Theory Ltd., 2011.	itevised and			
	ence Books:	5.2, Network Theory Edd., 2011.				
	Python: An Inter-di 2016.	Kevin Wayne, Robert Dondero, —Introduction to Pro sciplinary Approach, Pearson India Education Servic	ces Pvt. Ltd.,			
	2015.	-Exploring Python ^{II} , Mc-Graw Hill Education (India)	Private Ltd.,,			
	Kenneth A. Lamb Learning, 2012.	ert, —Fundamentals of Python: First Programs ^{II} ,	CENGAGE			
		-Introduction to Computer Science using Python: A C cus, Wiley India Edition, 2013.	Computational			
Any o	ther information:					
Total]	Marks of Internal	Continuous Assessment (ICA): 50 Marks				
Distri	bution of ICA Ma	rks:				
Desc	ription of ICA	Marks				
Test I	Marks	20				
Term	Work Marks	30				
Total	Marks:	50				

- 1. At least ten laboratory experiments based on the entire syllabus duly recorded and graded.
- 2. Presentation/Application based experiment and Quiz/Practical exam/Viva/Any other mode of evaluation.



Progr	am: B.	Tech. (Mech	natronics Eng	ineering)		Semester : V		
<u> </u>		lule: (Profes	sional Electi	ve Course	-2)	Module Code:	BTMA050	18
		v	and Systems		1			
		Teaching S	Scheme	I			on Scheme	
Lect (Ho	urs	Practical (Hours per week)	Tutorial (Hours per week)	Credit		Internal Continuous sessment (ICA)	Examina (Ma	rm End ations (TEE) rks- 100
-	,	i ,	- /			(Marks - 50)		tion Paper)
3		2		4	Ma	rks Scaled to 50	Marks	Scaled to 50
Objec 1.	tives: To pro doma	ovide knowle in analysis.	cs-III (BTM) edge of analog ontinuous and	g domain s	C	s and systems for t	ime and fr	equency
<u></u> Outco		icy various c	ommuous alle			141151011115.		
		tion of the co	ourse, student	s would be	able	to:		
2. 3. 4.	Apply Apply Use v	/ mathematic / various mat	hematical tran orms to analy	to analyze nsforms fo	signa r con	ils and systems. tinuous time signa signal and system	•	ms.
Unit	Desci	ription						Duration
1.	- U	ls, classificat	ion of signals ation of signa	-		gnals - analog and	discrete	04
2.	& dis Class causa syster	crete): ification of l, non-causa	systems, ser l, memory l	ries and pless and	oarallo with	invariant systems el connection of memory, stable for first and seco	systems, invertible	07
3.	Four Repressignal	ier Series for esentation of ls, Types Fo	signals in te	erms of or – Exponen	thogo ntial	ete time signals: nal functions, ort and Trigonometric on.		08
4.	Fouri Fouri period	ier Transfor er transform dic signals. F	m for contin , their prope	uous time rties, Fou ponse of c	sign rier t			06
5.	Analy Introc Appli Lapla	ysis of continution to bio cation of LT ce transform	uous time sy directional La in electrical	v stem usin aplace tran circuit , LT of Laplace	sforn Γ of e trans	place transforms: as and ROC, its p lementary signals sform, Using L.T system.	roperties, unilateral	08



	Analysis of discr	ete time system using Z transforms:						
6.	Introduction, Z ti	ntroduction, Z transform of elementary signals, ROC, Properties of Z						
0.	transform, Invers	ion of Z transform, system function, solution of						
	difference equation	on, unilateral Z transform.						
	Total		45					
Fext I	Books:							
		vat, Signals and Systems, Oxford University Press, July-201						
2.	Nagoor Kani , Sig	nals and Systems, McGraw-Hill publication, 1 st Edition, M	arch-2010					
	ence Books:							
1.	Oppenheim & Wi edition, 2008.	llsky, Signal and Systems, Prentice Hall of India publication	$1, 2^{nd}$					
2.	Simon Haykin &	Barry van veen, Signal and Systems, John Wiley publication	n. 2 nd					
	edition, 2008.							
3.	H. P. HSU, Signal	ls and Systems, Schaum's Outlines, McGraw-Hill publicatio	on, 3^{rd}					
	E 1' 2012							
	Edition, 2013.							
Any o	ther information:							
Fotal	ther information:	Continuous Assessment (ICA): 50 Marks rks:						
Fotal Distri	ther information: Marks of Internal							
Fotal Distri Desc	ther information: Marks of Internal bution of ICA Ma	rks:						
Fotal Distri Desc Test	ther information: Marks of Internal bution of ICA Ma ription of ICA	rks: Marks						

- 1. At least ten laboratory experiments based on the entire syllabus duly recorded and graded.
- 2. Presentation/Application based experiment and Quiz/Practical exam/Viva/Any other mode of evaluation.



Program:	B. Tech. (M	lechatronics I	Engineerin	g)	Sem	ester: VI		
Course/ M	lodule : PLC	and Data Ac	cquisition	-	Mod	lule Code: H	BTMA06007	
	Teaching	Scheme	-	Eval	uatio	n Scheme		
Lecture (Hours per week)	Practical (Hours per week)	Tutorial (Hours per week)	Credit	Assessment (ICA) Examina (Marks - 50) (Ma		Assessment (ICA) Examinatio (Marks - 50) (Marks		tions (TEE)
3	2	0	4	Marks Scaled to 5	50		caled to 50	
Pre-requis	ite : Digital I	Electronics (E	BTMA0300	09), Microprocessors	and M	licrocontrol	ler	
(BTMA040	-	·						
Objectives	s:							
ů.		mentals of D	ata conver	sion, PLC and SCAD	DA.			
				ased sequencing appl		ns.		
Outcomes	•	0 0	U					
After comp	oletion of the	course, stude	ents would	be able to:				
1. Under	stand the bas	sics of data co	onversion,	data acquisition, PLC	and S	SCADA.		
		mance of dat		-				
3. Apply	PLC for seq	uence contro	1.					
4. Create	PLC Ladde	r logic progra	ums for ind	lustrial applications.				
Detailed S	yllabus: (pe	r session pla	n)					
Unit I	Description						Duration	
1. I	Data Conver	rters: Introdu	uction to s	signal conditioning a	nd its	elements,		
S I i i A a I I e	 Data Converters: Introduction to signal conditioning and its elements, Sampling Theorem, Sampling process, Quantization, Encoding, Aliasing, Sample and hold circuit. DACs – basic DAC technique, weighted resister, R -2R ladder and inverted R -2R ladder types of DACs. ADCs – parallel feedback ADC, dual slope ADC, frequency based ADC and their comparison. DAC/ADC Specifications, Typical ICs for ADC and DAC. Design examples on ADCs and DACs. 							
2. Data Acquisition Systems (DAS): Introduction, definition and need for data acquisition systems. Objectives of DAS, Single Channel DAS, Multiplexer – multiplexed channel operation, Multichannel DAS,						05		
3. H S I N	Interfacing DAS with computer.Programmable Logic Controller (PLC): Evolution of PLCs, DiscreteState Control, Block Diagram of PLC, Classification of PLCs.Description of PLC components: Power Supply, Input and OutputModules , Discrete Input and Output Modules, Analog Input and outputModules, Programming Devices, CPU, I/O module specifications.Typical PLC specifications. Different Addressing modes.							
F	Program Scar	n Cycle.		anization, Program F			10	



	block diagram, Sequential flow chart, Instruction List, Structured Text.								
	Rules for ladder logic Programming, Relay Logic Instructions, Latching,								
	Interlocking, Tr	Interlocking, Triggers, Logic gates programming in PLC.							
	Timer Instruction								
	Counter Instruc	Counter Instructions: Up counter and Down Counter.							
	Data manipulation instructions, Mathematical instructions, Sequence and								
	Shift register instructions. Analog Module programming.								
5.	Application Development: Interfacing of various inputs & outputs to								
	PLC- Electromagnetic Control Relays, Contactors, Motor Starters,								
	Manually operated switches, Mechanically operated switches, Proximity								
	sensors, Encoders, Decoders. Interfacing Remote I/O s with PLC. Design of Tank level control System, Sequential switching of motors,								
	Motor starters,								
	Cylinder contro								
6.	Supervisory Control and Data Acquisition (SCADA): Introduction to								
	supervisory control, Need of SCADA, Architecture of SCADA.								
	Components of SCADA: MTU, RTU and HMI. Wireless SCADA,								
	Interfacing of SCADA with PLC.								
	Total		45						
Text Bo			a						
1. Cur	tis D. Johnson, "	Process control Instrumentation Technology", Prentice Hall	<i>ll</i> , 8 th Editior						
Jun	e 2005.								
2. M.N	Mitra and S.Gup	ota, "Programmable logic controllers and Industrial Aut	comation: A						
Intr	oduction", Penra	m International Publishing (India) Pvt. Ltd., 2nd Edition, 20	<i>)17</i> .						
Referen	ce Books:								
1. Pet	treuzeulla, "Progr	cammable Controllers", Tata McGraw Hill publication, 2 nd E	Edition, 2005						
		a Converters", Palgrave Macmillan Press, 4th Edition, 2012.							
	er information:								
·		Continuous Assessment (ICA): 50 Marks							
	ition of ICA Ma	rks:							
	ption of ICA	Marks							
Test M		20							
Term	Work Marks	30							
Total N	Marks :	50							
Details	of Term work:								
T									

Term work should consist of the following:

- 1. Minimum Ten experiments based on the above syllabus.
- 2. Industrial Case study on applications of PLC/SCADA.

Program: B. Tech. (Mechatronics Engineering)						Semester: VI			
8 \ C C/							Code: BTMA06008		
	Inst	rumentation							
Teaching Scheme Evaluation Scheme									
Lecture (Hours per week)	Practical (Hours per week)	Tutorial (Hours per week)	Credit	Internal Continuous Assessment (ICA) (Marks - 50)		Term End Examinations (TEE) (Marks- 100 in Question Paper)			
3	2	0	4	Marks Scaled to	50	Marks Scaled to 50			
Pre-requi	site: Basic El	ectrical Engi	neering (BT	MA01002), Physics	(BTN	IA01003), Dig	gital		
-	s (BTMA030	-	U V	· · ·					
Objective		,							
3. To s Outcomes After comp 1. Und mea 2. Ana	tudy differen control the control the con	t types of sen course, stude significance ments. act of factors 1	sors and tra ents would of calibrati like surface	and working of vario ansducers used in ind be able to: on, specifications a finish on performan for various physical	nd ch	aracteristics of machines.			
				bridge circuits for	-		Resistance		
	ctance and C		uniorent	offage effectives for	mea	Jurement of	resistance,		
		•	n)						
Detailed Syllabus: (per session plan) Unit Description									
	roduction to	Metrology a		•	initior	and concept	Duration		
of Con of Spa	Introduction to Metrology and measurement system: Definition and concept of metrology, standards of measurements, methods of measurement. Configuration of Generalized measurement system. Performance characteristics of measuring instruments, Static characteristics- Error, Accuracy, Precision, Span, Range, Sensitivity, Linearity, Reliability and Resolution. Dynamic characteristics- Dynamic error, Speed of response, Fidelity and Lag.								
2. Lin gau Con Ele Int and	ear Measur ges, design a nparators: ctrical, Pneur erferometry their interpro-	rements: Lin nd manufactu Types, cons matic Compar Basic princi etation	e and end uring of gau struction and rators. ples, source	standards, Wavelen ges. nd working of Me e of light, Optical fla	gth st echani ts, Fri	andards, slip cal, Optical, nge pattern	07		
auto bev Sur	ocollimator, el protractor face finish	angle Dekke Measurem	er, optical ent: Surfa	andards, sine bar square, taper meas ace texture, assess l other surface measu	ureme sment	nt, universal of surface	05		
4. Mo Pro	dern Optica file Projector	l Measurem	ent and Me are. Basics	etrology: Tool Make of Optical Interferer	r's M	icroscope,	05		



5.	Sensors and Transducers: Principles, Classification and applications.	
	Transducer Selection Criteria for Mechatronics applications.	
	Pressure Transducers: Bellows, Diaphragm, Bourdon tubes, Pirani Gauge,	
	Ionization Gauge, Piezoelectric transducer and Strain Gauge.	
	Flow Transducers: Orifice Plate, Pitot tube, Ventury tube, Rotameter,	10
	Ultrasonic Flow meter, Electromagnetic flow meter.	10
	Temperature Transducers: RTD, Thermistor, Thermocouple, Pyrometers.	
	Displacement/Position Transducers: LVDT, Hall effect transducers, Optical	
	encoders.	
	Resonant Sensor, Optical Fiber based sensor, Grating Leakage.	
6.	Proximity Sensors: Basic Principle, Construction, Working and applications of	
	Inductive, Capacitive, Ultrasonic, Magnetic and Photoelectric proximity	06
	sensors. Modes of operation of Photoelectric proximity sensors. Performance	00
	Comparison and Specifications of different Proximity sensors.	
7.	Measurement of R, L, C: Measurement of Resistance, low, medium and high.	
	Kelvin's double bridge, Wheatstone's bridge and Megger.	07
	AC bridge circuits for measurement of inductance and capacitance, Maxwell's,	07
	Hay's, Schering's and Wein bridge.	
	Total	45
Text	Books:	
1.	Nakra and Chowdhury, "Measurement and Control", 3rd Edition, Tata McGraw Hill,	2009.
2	U.S. Kalai "Electronic Instrumentation" Teta McCurry Hill 2 rd Edition 2010	

H.S. Kalsi," Electronic Instrumentation", *Tata McGraw Hill*, 3rd Edition, 2010.
 R. K. Jain, "Engineering Metrology", *Khanna Publishers*, 2009.

Reference Books:

- 1. A. K. Sawhney, "Electrical and Electronic Measurements and Instrumentation", *Dhanpat Rai* and Co., 2012
- 2. E.O. Doebelin and D. N. Manik, "Doebelin's Measurement Systems", 6" Edition, *McGraw Hill*, 2010.

Any other information:

Total Marks of Internal Continuous Assessment (ICA): 50 Marks

Distribution of ICA Marks:

Description of ICA	Marks
Test Marks	20
Term Work Marks	30
Total Marks :	50

Details of Term work:

Term work should consist of the following:

- 1. Minimum Ten experiments based on the above syllabus.
- 2. Industrial Case study on applications of sensors and transducers.



Program: B. Tech. (Mechatronics Engineering) Semester:					VI			
Course/Module: Professional Ethics and Legal				Aspects Module Code: BTMA06009				
		Teaching	g Scheme			Evaluatio	on Scheme	
Lecture (Hours per week)Practical (Hours per week)Tutorial (Hours per week)Credit			Internal Continuous Assessment (ICA) (Marks = 50)		n End tions (TEE) s- 100 in on Paper)			
2		0	0	2		caled to 50	Marks So	caled to 50
Pre-ree	quisit	e: Constitut	tion of India (B	TMA01005	5)			
2. 7 3. 7 Outcor After co 1. 1 2. 4	Fo pro Fo fac nes: omple Know Appli enviro	evide knowl cilitate socia etion of the dedge about cation and i	th basic concepledge of recent and legal awa course, student the basic conc nterpretation of r session plan)	developme areness from as would be cepts of the f the busine	nts in Law n legal pers able to: important l	at the national spective business laws	ıl level	iness
		ription	jession plan)					Duration
1	<u>India</u> • • • •	Stages to Essential OC Essential OC Essential Case Fr In OC Essential Case Fr In OC Case Essential OC Essenti	ion to Concepts formation of a Elements- ffer & Accepta apacity of parti aw) ree Consent (Vi fluence, Fraud, awful Consider ossibility to Per greement Expra lid, Void & Vo nce & Discharg s for Breach of	Contract nce (Essent es (Minors, itiating Eler Misreprese ation & Lav form (Doct essly Decla pidable Agr ge of Contra	tials) , Unsound I ments & Ef entation, M wful Objec trine of Fru red Void eements	Mind, Disqua fects- Coercie listake) t	•	03



	Sale of Goods Act, 1979	
	Concept of Sale as a Contract	
	• Essentials of contract of sale & it's conditions	
2	• The Rule of Caveat Emptor and the Exceptions	02
	Conditions & Warranties including implied Conditions & Warranties	
	Rules of Delivery, Unpaid Seller & his rights	
	Suits for Breach of contract	
	Companies Act, 2013	
	Introduction to Act	
	Administration of Company Law (NCLT/NCLAT)	
	Types of companies	
	Characteristics of a company	
3	• Essential Documents and their clause: Memorandum of Association,	03
	Articles of Association, Certificate of Incorporation	
	• Management: Classification of directors, Key managerial personnel,	
	Types of meetings & resolutions	
	Lifting of the Corporate Veil	
	• Concept and modes of Winding Up a company	
	Partnership Laws	
	A) The Partnership Act, 1932	
	Nature and Characteristics of Partnership	
	• Types of Partners	
	Rights and Duties of Partners	
	Incoming and outgoing Partners	
4	Mode of Dissolution of Partnership	03
	B) The Limited Liability Partnership Act, 2008	
	Salient Features of LLP	
	• Differences between LLP and Partnership, LLP and Company	
	LLP Agreement	
	Partners and Designated Partners	
	• Partners and their Relationship	
	Industrial Relations	
	• The Trade Union Act, 1926 - Emergence of Trade Unions in India and	
	the changing trends in Trade Unionism and their politics	
5	• Industrial Disputes Act, 1947 - Industrial Strikes and Employer	02
5	Lockouts	03
	• Managing Industrial conflicts - Trends and Issues in effective Labour	
	Court Administration	
	Role of Conciliation Officers in the Resolution of Industrial Disputes	
	Intellectual Property Rights	
6	• Introduction and the need for IPR (WIPO, TRIPS)	02
	• Trade Marks Act, 1999 - Registration of Trademarks; passing off and	02
	infringement	



-		
	• Indian Copyright Act, 1957 - Registration and infringement of	
	copyright	
	• Patents Act, 1970 - Meaning of patent & Inventions; Opposition	
	proceedings & Grant of Patent	
	Overview of Trade secrets and Industrial Designs	
	Competition Act, 2002	
	Objectives of Competition Law	
	• Concept of Appreciable Adverse Effect on Competition (AAEC)	
	• Anti-Competitive Agreements (S.3)- Horizontal Agreements, Vertical	
7	Agreements, Cartels, Blanket provision for IPR	02
	• Abuse of Dominance (S.4)	
	• Competition Commission of India - Role, Duties, Competition	
	Advocacy	
	Appellate Tribunal – Role of NCLAT	
	Alternative Dispute Resolution	
	• The Law and Methods of Alternative Dispute Resolution	
	 Comparative Study of the various forms of ADR 	
8	 Application of ADR Methods in Different Fields & Areas 	02
Ū	Arbitration & Conciliation Act, 1996 & International Developments	
	• Arbitration clauses, Preparation for Arbitration, Conducting an	
	Arbitration, Seat, Venue, Examinations and its various aspects,	
	Evidence	
	Universal Ethics	
0	Nature and Essence of Ethics	
9	Role of ethics in Governance	02
	Business Ethics Concepts	
	Professional ethics	
	Understanding Professional Ethics	
10	Characteristics of ethical organizations	02
	Causes of unethical behaviour	
	Benefits of ethical behaviour	
	Applied Ethics: Unethical Practices in Businesses	
11	Bribery, Conflict of interest and Anti-corruption behaviour	02
11	• Insider-Trading; meaning and legal provisions	03
	• Sexual harassment: The Sexual Harassment of Women at Workplace	
	(Prevention, Prohibition and Redressal) Act, 2013	
	Applied Ethics: Combating Unethical Practices in Businesses	
	Whistleblowing: Concept and Mechanism Seciel Research Seciel Research it it is in the second secon	
12	 Socially responsible leadership and Corporate Social Responsibility's role in comparate governmence 	03
	role in corporate governance	
	 Alternative Dispute Resolution as a tool to overcome unethical practices 	
		30
L	Total	30



Text Books:

- 1.
- Pathak A, 2013, *Legal Aspects of Business*, 6th Edition, McGraw Hill P Narayanan, 2009, *Intellectual Property Law; 3rd Edition*, Eastern Book Company 2.

Reference Books:

- Mahesh Tandon, (6th Edition), *Company Law* 1.
- 2. K R Bulchandani, (2009), Business Law, Himalaya Publications
- 3. H M Jhala, (2007), Intellectual Property and Competition Law in India; N M Tripathi P. Ltd.
- 4. Lucjan Klimsza, (1st Edition), Business Ethics Introduction to Ethics of Value; ISBN: 978-87-403-0690-3
- 5. Padhi, P.K. (2012), Labor and Industrial Laws, PHI
- 6. Venkatratnam, C.S. (2004). Industrial Relations, OUP.

Internet References:

- 1. www.mahalibrary.com
- 2. www.alllaw.com
- www.findlaw.com 3.
- 4. www.justice.com
- 5. www.legalpundits.com
- 6. www.indlaw.com
- www.maupatra.com 7.

Any other information:

Total Marks of Internal Continuous Assessment (ICA): 50 Marks

Distribution of ICA Marks:

Description of ICA	Marks
Test Marks	20
Term Work Marks	30
Total Marks :	50

Details of Term work:

Term work should consist of the following:

Class Test/ Assignment/Case Studies/Projects/ Presentations



Program : B. Tech. (Mechatronics Engineering)Semester : VI							
Course/Module : Research MethodologyModule Code : BTM.Teaching SchemeEvaluation Scheme						[A06010	
						cheme	
LecturePracticalTutorial(Hours(Hours(Hoursperperper			Tutorial (Hours per Credit Internal Co Assessmen (Marks		t (ICA) - 50)		n End ions (TEE) ks ion Paper)
1	2	0	2	Marks Scale	ed to 50		
Objecti 1. To	o familiarize st	-	-	strial research p search in the me	•	-	gy.
 Pro Ide Ad 	entify and use plant if the second seco	report relat print and ele guidelines	ed to the re ectronic lib for writing	esearch conduc prary resources g reports and co	effectively llecting inf		iately
				e review finding	gs		
Detaile	d Syllabus: (p			e review finding	38		Duration
Detaile	d Syllabus: (p Description Definition and of Construct, Objective of	er session p I Characteri Postulate, F research. Va	blan) istics of res Proposition, arious func	search: Researc , Thesis, Hypo ctions that desc fiable, empirical	h – Definiti thesis, Law cribe chara	, Principle. cteristics of	Duration 06
Detaile Unit	d Syllabus: (p Description Definition and of Construct, Objective of research such a Types of rese research. Qual	er session p I Characteri Postulate, F research. Vans systematic, arch: Pure a itative and q ature Review	blan) istics of res Proposition, arious fund , valid, verif and applied juantitative , Developir	search: Research , Thesis, Hypo ctions that desc fiable, empirical l research. Desc approaches. Fo ng the objectives	h – Definiti thesis, Law cribe chara and critical riptive and rmulating t	 Principle. cteristics of approach. explanatory he Research 	
Detaile Unit 1.	d Syllabus: (p Description Definition and of Construct, Objective of research such a Types of rese research. Qual Problem, Liter design includir - Identii and ap	er session p I Characteri Postulate, F research. Va s systematic, arch: Pure a itative and q ature Review ng sample De	blan) istics of res Proposition, arious fund, valid, verif and applied puantitative by Developin sign, Samp rint and ele	search: Research , Thesis, Hypo ctions that desc fiable, empirical l research. Desc approaches. Fo ng the objectives le size. ectronic library	h – Definiti thesis, Law cribe chara and critical riptive and rmulating t s, Preparing	 Principle. cteristics of approach. explanatory he Research the research 	06
Detaile Unit 1. 2.	d Syllabus: (p Description Definition and of Construct, Objective of research such a Types of rese research. Qual Problem, Liter design includir - Identi and ap - Litera - Refere	er session p I Characteri Postulate, F research. Va s systematic, arch: Pure a itative and q ature Review ng sample De fy and use p ppropriately ture search a	blan) istics of res Proposition, arious func , valid, verif and applied juantitative r, Developir sign, Samp rint and ele and review , plagiarism	search: Research , Thesis, Hypo ctions that desc fiable, empirical l research. Desc approaches. Fo ng the objectives le size. ectronic library	h – Definiti thesis, Law cribe chara and critical riptive and rmulating t s, Preparing resources	 Principle. cteristics of approach. explanatory he Research the research 	06
Detaile Unit 1. 2. 3.	d Syllabus: (p Description Definition and of Construct, Objective of research such a Types of rese research. Qual Problem, Liter design includir - Identit and ap - Litera - Refere - Writir	er session p er session p l Characteri Postulate, F research. Va s systematic, arch: Pure a itative and q ature Review ng sample De fy and use p popropriately ture search a encing style,	istics of res Proposition, arious func , valid, verif and applied uantitative y, Developir sign, Samp rint and ele and review , plagiarism report	search: Research, Thesis, Hypo ctions that desc fiable, empirical l research. Desc approaches. Fo ng the objectives le size. ectronic library n basics and ch	h – Definiti thesis, Law cribe chara and critical riptive and rmulating t s, Preparing resources	 Principle. cteristics of approach. explanatory he Research the research 	06 06 06
Detaile Unit 1. 2. 3. 4.	d Syllabus: (p Description Definition and of Construct, Objective of research such a Types of rese research. Qual Problem, Liter design includir - Identir and ap - Litera - Refere - Writir - Drafti Outcome of I	er session p I Characteri Postulate, F research. Va as systematic, arch: Pure a itative and q ature Review ng sample De fy and use p popropriately ture search a encing style, ng a research research ou	blan) istics of res Proposition, arious func , valid, verif and applied puantitative r, Developin sign, Samp rint and ele and review , plagiarism report h proposal	search: Research, Thesis, Hypo ctions that desc fiable, empirical l research. Desc approaches. Fo ng the objectives le size. ectronic library n basics and ch	h – Definiti thesis, Law cribe chara and critical riptive and rmulating t preparing resources	 Principle. cteristics of approach. explanatory he Research the research effectively 	06 06 06 04



2. Kothari, C.R., 1985, *Research Methodology-Methods and Techniques*, New Delhi, Wiley

Reference books:

1. Dawson, Catherine, 2002, *Practical Research Methods*, New Delhi, UBS Publishers' Distributors. Eastern Limited.

Any other information:

Total Marks of Internal Continuous Assessment (ICA): 50 Marks

Distribution of ICA Marks:

Description of ICA	Marks
Test Marks	
Term Work Marks	50
Total Marks :	50

Details of Term work:

Term work should consist of the following:

1. Assignment/Presentation/Report Writing/Case Study



Program	Program : B. Tech. (Mechatronics Engineering)Semester : VI						
Course/	Module: (Pro CAI	o fessional E D/CAM/CIN		urse-3)	Module	Code : BTM	IA06011
	Teaching Scheme Evaluation Sch						cheme
Lecture (Hours per week)		(Hours perInternal Continuous Assessment (ICA) (Marks - 50)Examinati (Marks - 50)		m End tions (TEE) ks - 100 tion Paper)			
3	2	0	4	Marks Scale	ed to 50	Marks S	caled to 50
Pre-req	-	ering Graph A03011)	ics & Desi	ign(BTMA0100	04), Manu	facturing Pro	ocesses
3. To co d. To Outcom After co 1. Cre geo 2. Ap cut 3. Un sys	impart knowl des. provide conce mes: mpletion of the eate accurate pometric models ply the concep ting tools for (edge of NC/ epts of GT, (and precise s in different ots of machin CNC milling epts of different	CNC mach CAPP, CA udents wou e geometr t engineeri ning for the g and turnin rent CAD/	Ild be able to: y of complex ng applications e purpose of se	engineer lection of	ing systems machining pa	and use the arameters and
Unit	Description	er session p	1a11)				Duration
1.	Introduction design process using CAD, Computer-Aid product desig	ss, the role product life ded Manuf n and develo	of model e cycle an facturing(C opment, Co	teractive comp ing and comm d Computer-A CAM), Concur ollaborative En chitecture-Soft	nunication ided Des rent eng gineering,	. Modeling ign (CAD)/ ineering in Computers	08
2.	parametric re curve, B-Spli and parabol representation modeling, fe	epresentation ne curve, pa a, Constru n (B-rep), W ature based	n of geon arametric n ctive sol /ire Frame l modelin	leling : Grap metry-Bezier c representation of lid geometry modeling, Sol g, Assembly Parent child re	curves, C of line, ci (CSG), lid modeli Modeling	ubic spline rcle, ellipse Boundary ing, Surface - Different	06
3.	Transformation Transformation Concatenation	ion, Manij ons (Transla ns, Matrix 1	pulation ation, Rot representat	and Data Station, Scaling ion, Problems sformation, Bi	orage: 2 and Mag on Trans	D and 3D gnification), sformations.	08



	base for design, object oriental database, Design Information Systems.	
4.	NC and CNC technology: Introduction, basic components of Numeric Control (NC) system, NC procedure, NC coordinate systems, NC motion control systems, Various actuation systems and feedback devices like encoder, tachogenerator, etc. Applications, Advantages and Disadvantages of NC machines. Constructional details of Computer Numeric Control (CNC) machines, CNC programming concepts, Manual part programming methods, Various G and M codes, Absolute and incremental system, Tool length and diameter compensation, Programming of turning and milling, Use of canned cycles, subroutines. Flexible Manufacturing Systems (FMS), Machining Centers and its types, Automated Material Handling and Storage Systems like Robots, Automated Guided Vehicles (AGV) and Automated Storage and Retrieval Systems (AS/RS)	10
5.	Group Technology, CAPP and CAQC: Introduction to Group Technology (GT), Part families, Part Classification and Coding, GT Machines cells, Benefits of GT. Introduction to Computer Aided Process Planning (CAPP), Retrieval type Process Planning Systems, Generative type Process Planning Systems, Benefits of CAPP, PFA, Similarity coefficient matrix. Introduction to Computer Aided Quality Control (CAQC), Computers in QC, Contact Inspection Methods, Non-Contact Inspection Methods, Integration of CAQC with CAD/CAM	07
6.	Computer Integrated Manufacturing and Technology driven practices: Introduction, Evolution, Objectives, CIM Hardware and software, CIM Benefits, Nature and role of elements of CIM, Identifying CIM needs, Data base requirements of CIM, Role of CAD/CAM in CIM, Obstacles to Computer Integrated Manufacturing, CIM wheel, Design for Manufacturing (DFM) and Design for Assembly (DFA). Introduction to Rapid Prototyping, Virtual Prototyping. Introduction to Smart Manufacturing and Smart Design Concept.	06

2. Ibrahim Zeid, R. Sivasubramanian (2009), "CAD/ CAM, Theory and Practice" *Tata McGraw Hill Publications*.



Reference books:

- 1. P. N. Rao (2010), "CAD/CAM Principles and Applications" Tata McGraw *Hill Publications*.
- 2. P. Radhakrishan, S. Subramanyan, V. Raju (2004), "CAD/CAM/CIM", *New Age International Publishers*.

Any other information:

Total Marks of Internal Continuous Assessment (ICA): 50 Marks

Distribution of ICA Marks:

Description of ICA	Marks
Test Marks	20
Term Work Marks	30
Total Marks :	50

Details of Term work:

Term work should consist of the following:

- 1. Assignments based on syllabus (Min. 3).
- 2. Laboratory assignments on solid modeling/assembly using any 3D modeling software (Solid Works/Catia/Pro-E). (Min. 6)
- 3. Part programming and part fabrication on CNC trainer (Turning/Milling). (Min. 2)
- 4. Viva Voice, Quiz based on syllabus/laboratory examination based on solid modeling.



Progra	m: B. Tech. (M	echatronics	Engineerir	ng)	Semester	r: VI				
	Course/Module: (Professional Elective Course-3) Module Code: BTMA						A06012			
Modeling and Simulation										
	Teaching Scheme Evaluation Scheme									
Lectur	Internal Continuous						n End			
(Hour	(Hours (Hours Credit Assessment (ICA) Examin			tions (TEE)						
per	per	per	orean	(Marks			ks- 100			
week		week)	4		,		tion Paper)			
3 Dra ra		0 min a far Dr	4	Marks Scal		Marks S	caled to 50			
Pre-ree	quisite: Program	inning for Pr	oblem Sol	ving (BTMA0	2009)					
Object	ives:									
1. Т	To provide an ex	posure on h	ow to simu	ulate a system.						
Outcor	nes:									
After co	ompletion of the	course, stud	lents woul	d be able to:						
	Evaluate decision				echniques					
2. 8	Select the right n	nethod of sir	nulation as	s per the system	n.					
	d Syllabus: (pe									
Unit	Description	F -	/				Duration			
1.	System – way	s to analyz	e the syst	em – Model	- types of	f models –	10			
	Simulation – I	Definition –	Types of a	simulation mo	dels – ster	os involved				
	in simulation -		• •		-					
	Parameter est	-		•						
	estimate – cor					-				
				-		-				
	hypothesis – ty			ps – types 1 α	2 errors –	- Framing –				
	strong law of la	-								
2.	Building of Sin					•	08			
	their timing – verification –				-	-				
	Modeling of		-	1	0					
	procedures –									
	suitability in m									
3.	Generation of		ariates –	factors for se	lection –	methods -	09			
	inverse transfo	-			-	•				
	– generation o									
	normal Bernou			-						
	- comparison o		0 0	U		0 0				
	Simulation lar									
	capabilities –				Simulation	of M/M/I				
	queue – compa				utout data	analysis	08			
4.	Output data an warmup perio	• • • •			-	•	08			
			-			•				
	7 marysis – rep	D = D	Analysis – replication – Batch means methods – comparisons							



]	M/M/1 queues with	Simulation – flow shop system – job shop system – ith infinite and finite capacities – Simple fixed period – New boy paper problem	10
	Total		45
Text Boo			
1. L	aw & Kelton (200	00) ,"Simulation Modeling and Analysis", 3 rd Edition., M	IcGraw-Hill
Ir	nc.		
Referen	ce Books:		
1. C	Carrie A. & Wiley	(1990), Simulation of Manufacturing Systems, NY, 199	0.
Any oth	er information:		
Total Ma	arks of Internal	Continuous Assessment (ICA): 50 Marks	
Distribu	tion of ICA Mar	ks:	
Descrip	otion of ICA	Marks	
Test M	arks	20	
Term V	Vork Marks	30	
Total N	Iarks :	50	

Details of Term work:

Term work should consist of the following:

- 1. Assignments based on the above syllabus (Min. 3).
- 2. Viva Voce, Quiz based on syllabus/laboratory examination
- 3. Two term test papers.
- 4. Project based on simulation.



Progra	am: B. Tech. (N		s Engineer	ing)	Semest	er: VI	
	e/ Module: (Pro		-	-		e Code: BTM	A06013
				g and Analysis			
Teaching Scheme			Evaluation Scheme				
Lectu	re Practical	Tutorial		Internal Continuous Term En		n End	
(Hou	rs (Hours	(Hours	Credit	Assessment			ions (TEE)
per	per	per	Creat	(Marks -	. ,		ks- 100
week	· · · · · ·	week)		``			on Paper)
-	3 2 0 4 Marks Scaled to 50 Marks S						
Pre-re	quisite: Enginee						
	BTMA	.03001), The	ermodynar	nics and Heat T	ransfer (BTMA05012)
Object	tives:						
	To understand p				ctrical, tl	hermal and f	luid systems
	and converting th						
	To understand th				onse anal	ysis of dyna	mic systems
	hat is required in		0	0			
	To learn the use of	of any mathe	ematical so	oftware.			
Outco			1				
	completion of the						
	Design the mathe					• • • • • • • • • • • • • •	
	Analyse the respo			a also modify u	ne systen	is as per the i	requirements
	ising mathematic						
Detail Unit	ed Syllabus: (pe Description	er session pl	lan)				Duration
1.		to system	n dynan	nics: Introduc	tion N	[athematica]	05
1.				analysis and E			05
	Systems.		<i>ystern,</i> 11	linary bio and 2	001811 0	1 2 juante	
2.		transform:	Introduct	tion, Complex	Number	s, Complex	05
	-			, Laplace Tran		-	
	-		0	Linear, Time-Ir		Differential	
	-			olutions, Probler			
3.	•			Mechanical Eler			06
	•	-	•	stems, Work, I	Energy,	and Power,	
4.	Example Proble Transfer-Fund				dynami	o sustama	08
4.		11		modeling Partial-Fraction	•	•	Võ
	,			alysis with N			
	Problems and S		+			, <u></u>	
5.		,		ng dynamic sy	stem: I	ntroduction,	07
	-			ystems in Stat			
		-	-	of System with	-		
				Models with N	IATLAE	B, Example	
	Problems and S	Solutions, Pi	oblems.				



6.	Electrical systems and electromechanical systems: Introduction, Fundamentals of Electrical Circuits, Mathematical Modeling of Electrical Systems, Analogous Systems, Mathematical Modeling of Electromechanical Systems, Mathematical Modeling of Operational- Amplifier Systems	08
7.	Fluid systems and thermal systems: Introduction, Mathematical Modeling of Liquid-Level Systems, Mathematical Modeling of Pneumatic Systems, Linearization of Nonlinear Systems, Mathematical Modeling of Hydraulic Systems, Mathematical Modeling of Thermal Systems	06
	Total	45

Text Books:

- 1. Oghata (2007), "System Dynamics" Pearson Publications.
- 2. Norman Nise (2008), "Control System Engineering" Wiley.

Reference Books:

- 1. Close, Fredrik (2001), "Modeling and Analysis of Dynamic System" Wiley.
- 2. Narsico, George Julius (2005), "Modeling and Control of Dynamic System" *Thomson*.

Any other information:

Total Marks of Internal Continuous Assessment (ICA): 50 Marks

Distribution of ICA Marks:

Description of ICA	Marks
Test Marks	20
Term Work Marks	30
Total Marks :	50

Details of Term work:

Term work should consist of the following:

- 1. Assignments based on above topics (Min. 3).
- 2. Viva Voce Examination
- 3. Two term test papers.
- 4. Project based on simulation.



0	am: B. Tech. (M			Semester : VI			
Course/Module: (Professional Elective Course-4) Automobile EngineeringModule Code : BTM							14
			eering				
	Teaching	Scheme		Evaluation Scheme			End
Lectu	re Practical	Tutorial			Continuous		
(Hour	` •	(Hours per	Credit		ent (ICA)	Examinations (TEE (Marks - 100 in Question Paper)	
per wee	ek) week)	week)		(Marl	ks - 50)		
3	2	0	4	Marks So	caled to 50	Marks Sc	
Pre-re	quisite: Theory	of Machines	(BTMA0	5008)		I	
Object	tives:						
1.	To impart the k	nowledge of	the basics	of the automo	obiles.		
2.	To introduce the	e different au	tomobile s	systems like s	uspension, axl	es and steering	g and
	transmission sy	stems in the A	Automobil	es.			
Outco							
	completion of the						
1.	Understand the		nes used in	n automobile	and their chara	acteristics, sele	ections of
2	suitable rear axl	.0			ef an an air air air an	a and alutah a	
2.	Analyze the cha mechanism of v	•	leering geo	Sinetry, types	of suspension	s, and clutch a	nd gear
3	Understand the		aking mee	hanisms			
	ed Syllabus: (pe			numbrits.			
Unit	Description		,				Duration
1.	Vehicle Perfo	rmance: T	ypes of	engines use	ed in autom	obiles, their	06
	characteristics a	and selection	s, resistan	ce to motion	of vehicle, air	r, rolling and	
	gradient resista	ances, powe	r requirer	ment for acc	celeration and	l tradability,	
	selection of suit	able rear axle	e and gear	ratios.			
2.	Chassis: Chass	is layout, po	wer plant	location, typ	pes of automo	biles, weight	04
	distribution stat	oility, type of	frame, ma	terials.		_	
3.	Steering: Steer	ring geometr	y, wheel	alignment an	nd wheel bala	ncing, center	12
	point Steering,	Ackerman ar	d Davis st	teering, corne	ering force slip	angle, scrub	
	radius, steering	conventiona	l layout o	of steering sy	stem. Steering	systems for	
	independent sus						
	Axle: Axle mat	erial, load an	d stresses	on front axle	design, steerin	g heads, axle	
	bearing wheel a				•	-	
	two speed rear a	-		• •		<i>2</i> /	
	Tires: Function	-		-			
						1	00
4.	Suspension Sys	stem: types (or suspensi	ions, material	ls, shackles an	a mountings,	08
4.		• -	-			-	08
4.	types of spring	gs, shock at	osorbers, s	sprung weigh	ht and un sp	rung weight,	08
4.		gs, shock at uspension s	osorbers, s ystem, ind	sprung weigh dependent su	ht and un sp uspension, air	rung weight, suspension,	08



5.	Drive mechanisms: Torque reaction, driving thrust, propeller shaft, universal joints, and constant velocity universal joints. Differential, action of differential, constructional details, types of rear axles, materials, bearing loads, double reduction and two speed axle, front wheel drive, all-wheel drive, introduction to continuous variable transmission (CVT).	07
6.	Clutch and braking mechanisms:	08
	Clutch: Clutch mechanism-wet/dry clutch- constant pressure, constant wear	
	type, back up plate, cone clutch, centrifugal clutch, multi-plate clutch, clutch	
	materials, influence of temperature on the performance, torque limiter.	
	Numerical Examples.	
	Braking Systems: types and construction, mechanical, hydraulic system,	
	diagonal braking system, antilock braking system. Numerical Examples.	
	Total	45

Text Books:

- 1. K. K. Jain and Asthana (2002), "Automobile Engineering", TTI Publications.
- 2. R.K. Rajput (2007), "A Text Book of Automobile Engineering", Laxmi Publications.
- 3. S. Kripal (2009), "Automobile Engineering Vol I", New Chand Jain.

Reference Books:

- 1. G. Genta, Morello (2009), "The Automotive Chassis: System Design", Springer.
- 2. Society of Automotive Engineering (1997), "Automotive Engineering".
- 3. D. Crolla (2009), "Automotive Engineering: Powertrain, Chassis System, Vehicle, Body", *Butterworth- Heinemann*.

Any other information:

Total Marks of Internal Continuous Assessment (ICA): 50 Marks

Distribution of ICA Marks:

Description of ICA	Marks
Test Marks	20
Term Work Marks	30
Total Marks :	50

Details of Term work:

Term work should consist of the following:

- 1. One assignment from each unit.
- 2. Experiments (any 5) based on the above syllabus
- 3. Study of Engines, systems and mechanisms of vehicles with sketches and write ups.
- 4. Viva Voce /Presentations
- 5. Two term test papers.



Progra	Program : B. Tech. (Mechatronics Engineering)Semester : VI							
Cours	e/Module: (Professio	onal Elective Co	ourse-4)	Module C	ode: BTM	A06015		
	Design of	Machine Eleme	nts					
	Teachiı	ng Scheme		Eva	aluation Sc	heme		
Lecture Practical Tutorial (Hours (Hours (Hours		ours er Credit	Internal Continuous		Term End Examinations (TEE (Marks- 100 in Question Paper)			
3	, , , , , , , , , , , , , , , , , , , ,	0 4	Marks Sca	ed to 50		caled to 50		
Pre-re	quisite: Engineering (BTMA0401	,	MA03010), Stre	ength of Mat	erials			
Object	tives:	· · ·						
	o understand the imp	act of different ty	ypes of stresses	on compone	ents			
	o introduce the funda	mental concepts	of design of sin	nple machir	ne parts.			
Outco								
	ompletion of the cou							
	Inderstand the import	ance of materials	s in design and	select approp	priate mate	rials for saf		
de	anian							
	esign.			_				
2. A	pply the principle and	-		-	-			
2. A 3. A	pply the principle and nalyze the different t	ypes of loads and	d stresses acting	g on compon	ients.			
 A A A A 	pply the principle and nalyze the different t besign of various mac	ypes of loads and	d stresses acting	g on compon	ients.	gears and		
2. A 3. A 4. D be	pply the principle and nalyze the different t besign of various machelits.	types of loads and hine components	d stresses acting	g on compon	ients.	gears and		
2. A 3. A 4. D be Detaile	pply the principle an nalyze the different t esign of various mac elts. ed Syllabus: (per ses	types of loads and hine components	d stresses acting	g on compon	ients.			
2. A 3. A 4. D bo Detaile Unit	pply the principle and nalyze the different t besign of various machelits.	types of loads and hine components	d stresses acting	g on compon	ients.	Duration		
2. A 3. A 4. D be Detaile	pply the principle an nalyze the different t esign of various mac elts. ed Syllabus: (per ses	ypes of loads and hine components ssion plan) election of mat bending and shea	d stresses acting s like shafts, co terials-preferred ar stress-combi	g on comport uplings, spri	fits and -eccentric			
2. A 3. A 4. D bo Detaile Unit	pply the principle and nalyze the different to resign of various macher ed Syllabus: (per sesting Description Stress Analysis: Design process-Sectolerances, direct, be loading on machine Design of Shafts, Construction Design of solid states	ypes of loads and hine components ssion plan) election of mat bending and shea e members-stress Coupling and Sp hafts based on	d stresses acting s like shafts, co terials-preferred ar stress-combi s concentration prings: strength, rigid	g on comport uplings, spri	fits and eccentric ensitivity.	Duration		
2. A 3. A 4. D bo Detaile Unit 1. 2.	pply the principle and nalyze the different to esign of various macher ed Syllabus: (per session Description Stress Analysis: Design process-Sectolerances, direct, be loading on machine Design of Shafts, Co Design of solid	ypes of loads and hine components ssion plan) election of mat bending and shea e members-stress Coupling and Sp hafts based on	d stresses acting s like shafts, co terials-preferred ar stress-combi s concentration prings: strength, rigid	g on comport uplings, spri	fits and eccentric ensitivity.	Duration 09 12		
2. A 3. A 4. D bo Detailo Unit 1.	pply the principle and nalyze the different to resign of various macher ed Syllabus: (per sesting Description Stress Analysis: Design process-Sectolerances, direct, be loading on machine Design of Shafts, Construction Design of solid states	ypes of loads and hine components ssion plan) election of mat bending and shea e members-stress Coupling and Sp hafts based on flange coupling, joints including s, Bolt of unifor	d stresses acting s like shafts, co terials-preferred ar stress-combi s concentration prings: strength, rigid Design of coil axial and tens rm strength, Th	g on comport uplings, spri I numbers, ned stresses and notch se lity. Design springs.	fits and eccentric ensitivity. of muff Knuckle	Duration 09		
2. A 3. A 4. D bo Detailo Unit 1. 2.	 pply the principle and nalyze the different the sign of various mached stress of various mached stress and stress analysis: Description Stress Analysis: Design process-Sectorer and stress analysis: Design of Shafts, Consign of solid stress and rigid the sign of bolted gioints, Cotter joints 	ypes of loads and hine components ssion plan) election of mat bending and shea e members-stress Coupling and Sp hafts based on flange coupling, joints including s, Bolt of unifor oints for structure r based on contact	d stresses acting s like shafts, co terials-preferred ar stress-combi s concentration prings: strength, rigid Design of coil axial and tens rm strength, Th es.	g on comport uplings, spri I numbers, ned stresses and notch se lity. Design springs. sile loading, read locking	fits and eccentric ensitivity. of muff Knuckle g devices,	Duration 09 12		
2. A 3. A 4. D bo Detailo Unit 1. 2. 3.	 pply the principle and nalyze the different the sign of various mached sign of various mached sign of various mached sign of various mached sign process-Sectorer and sign process-Sectorer and sign of solid sign of bolted sign of bolted sign of riveted journers. Design of riveted journers and results are an are supported by the second second	ypes of loads and hine components ssion plan) election of mat bending and shea e members-stress Coupling and Sp hafts based on flange coupling, joints including s, Bolt of unifor oints for structure r based on contact tingham equation	d stresses acting s like shafts, co terials-preferred ar stress-combi s concentration prings: strength, rigid Design of coil axial and tens rm strength, Th es. ct stress and beaus.	g on comport uplings, spri I numbers, ned stresses and notch se lity. Design springs. sile loading, read locking	fits and eccentric ensitivity. of muff Knuckle g devices, and based	Duration 09 12 10		



Text Books:

- 1. J. F. Shigley (2008), "Mechanical Engineering Design", 8th Edition, Tata McGraw Hill
- 2. V. B. Bhandari (2010), "Design of Machine Elements", 3rd Edition, Tata McGraw Hill

Reference Books:

- 1. Hall, Holowenko, Laughen, (2008) "Machine Design" Schaum's outline series Tata McGraw Hill Publication.
- 2. M. F. Spotts (2004), "Design of Machine Elements", 8th Edition, Pearson Publication.
- 3. PSG design data book

Any other information:

Total Marks of Internal Continuous Assessment (ICA): 50 Marks

Distribution of ICA Marks:

Description of ICA	Marks
Test Marks	20
Term Work Marks	30
Total Marks:	50

Details of Term work:

Term work should consist of the following:

- 1. Design project on Assemblies covering above syllabus. The design project shall consist of sheet involving assembly-drawing with a part list and overall dimensions and drawings of individual components. A design report giving all necessary calculations of the design of components and assembly should be submitted in a separate file. Design data book shall be used wherever necessary for selection of standard components.
- 2. Assignments based on the above syllabus (Min. 3). Computational platform Octave/Scilab 6.0.1 will be used extensively for simulation
- 3. Viva Voice or Multiple Choice Questions (MCQ) Examination.



Program:B. Tech. (Mechatronics Engineering)Semester:VI						er: VI	
Course/Mo	dule: (Profes Additiv	sional Electi e Manufactur		· · · · · · · · · · · · · · · · · · ·			A06016
	Teaching	Scheme]	Evaluatio	on Scheme	
Lecture (Hours per week)Practical (Hours per week)Tutorial (Hours per week)Credit		Internal Continuous Assessment (ICA) (Marks - 50)		ons (TEE)			
						Marks Sc	
Pre-requisi	te: Manufactu	uring Process	es(BTMA() 3011), Material	s Enginee	ering (BTMA	5013)
- Objectives:			· · · · · · · · · · · · · · · · · · ·				
0		y knowledge o	of Additive	e Manufacturing	(AM) and	d its capabilit	ies in the
-	n digital manu	-		U	× /	1	
2. To get	acquainted w	ith the operat	ing princip	oles and application	ions of m	ost prominent	-
	logies in the f			0	a		
-	•			ring capabilities	of each A	M process an	d to
	y and create c	omplex and n	lovel desig	ns.			
Outcomes:	letion of the c	ourse studen	te would be	e able to:			
-				arious Additive	Manufact	uring (AM) te	chnologie
		amonda princ			manaraet		omoiogie
materia	al requirement	-	-	ns with regards to	o each Al	A process.	-
	-	ts and cost co	nsideration	ns with regards to lied to create val		-	ct life-
	-	ts and cost co	nsideration	ns with regards to lied to create val		-	ct life-
 Identif cycle. Select 	y critical area	ts and cost co s where AM o process for a	nsideration can be app given appl	lied to create val	ue for the	e entire produ	
 Identificycle. Select Develor 	y critical area the right AM op an enterpris	ts and cost co s where AM o process for a sing perspecti	nsideration can be app given appl	lied to create val	ue for the	e entire produ	
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 Identif cycle. Select Develo product Detailed Sy Unit Des	y critical area the right AM op an enterpris t, either entire llabus: (per s cription	ts and cost co s where AM o process for a sing perspecti ely or partly. session plan)	nsideration can be app given appl ve concern	lied to create val lication. hing the application	ue for the	e entire production of the design	n of a Duratio
 Identif cycle. Select Develor product Detailed Sy Unit Dest Intr 	y critical area the right AM op an enterpris t, either entire 'llabus: (per s cription	ts and cost co s where AM of process for a sing perspecti- ely or partly. session plan)	nsideration can be app given appl ve concern nufacturin	lied to create val lication. hing the application ng: Introduction	ue for the	e entire production of AM,	n of a Duratio 04
 Identific cycle. Select Developroduce Detailed Sy Unit Desonality Intradefi 	y critical area the right AM op an enterpris t, either entire cllabus: (per s cription roduction to A nition, distin	ts and cost co s where AM of process for a sing perspecti- ely or partly. session plan) Additive Man ction betwee	nsideration can be app given appl ve concern nufacturin en AM, C	lied to create val lication. hing the application rg: Introduction CNC & other	ue for the	f in the design story of AM, nanufacturing	n of a Duratio 04
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 Identific cycle. Select Developeroduce Detailed Sy Unit Des Intradefit tech Add chait Man 2. Ext FDN bony beno of: 	y critical area the right AM op an enterprise t, either entire cllabus: (per second cription coduction to A nition, distin niques, reaso litive Manufac n, CAD and nufacturing. L crusion based M, material ding, solidifi- efits and limi	ts and cost co s where AM of process for a sing perspecti- ely or partly. session plan) Additive Man ction betweet ons to use Al- cturing (DfAM d file formation aser Cutting AM process requirement cation, support tations, post etals, biomate	nsideration can be app given appl ve concern nufacturin en AM, C M, classifi M), AM ind ts for Al vs Water jo es: Fused s, workfle ort genera c-processin	lied to create val lication. hing the application rg: Introduction CNC & other lications of AM dustry: present a M. Introduction	ue for the ion of AM to AM, hi digital n processe nd future n to Me eling(FDN loading, ynamics, racterizati	f in the design f in the design astory of AM, nanufacturing s, design for , AM process tal Additive M), history of liquefaction, applications, on, extrusion	n of a Duratio 04 05

	Total	45
8.	Design for Additive Manufacturing (DfAM): Key process-specific DfAM guidelines, AM file formats (STL, 3MF, AMF, PLY, VRML, LEO): processing, conversion and repair algorithms, tool path generation, topology optimization, generative design, slicing and support generation.	06
7.	Directed Energy Deposition (DED) Processes: Process workflow, materials feeding for DED: powder (Laser Engineered Net Shaping) & wire, process parameters and optimization, Electron Beam Additive Manufacturing (EBAM) plasma-based DED, Cold Spray.	04
6.	Binder Jetting (BJ) & Material Jetting AM Process: workflow, thermal and piezoelectric inkjet, material requirements, material jetting fluid mechanics, drop-on-demand and continuous methods of MJ, material jetting of metals, ceramics, nanomaterial, BJ AM Process: process workflow, material requirements, powder characterization for BJ process, binder-powder interaction, binder properties.	06
5.	Powder Bed Fusion AM Process: Selective Laser Sintering (SLS): process workflow and material requirements, powder production methods, powder fusion mechanism, polymer ageing and recycling, High Speed Sintering(HSS), Multi-Jet Fusion(MJF), polymer powder characterization and selection, Selective Laser Melting (SLM): process workflow and material requirements, powder melting mechanism, melt pool dynamics, laser scan patterns, post-processing, powder production, handling and recycling, Electron Beam Melting (EBM) Process.	11
4.	Sheet Lamination AM Processes: Laminated Object Manufacturing (LOM), LOM of paper, polymer and composite sheets, LOM mechanism: gluing, adhesive bonding, bond then from, from then bond, thermal bonding, sheet metal clamping, Ultrasonic Additive Manufacturing(UAM), ultrasonic welding fundamentals, UAM process parameters, material characterization.	04
	scan patterns, applications, benefits and limitations, other liquid polymer-based systems: Solid Ground Curing (SGC), Microstreolithography, Digital Light Processing (DLP), Continuous Liquid Interface Production (CLIP), Large-Scale Rapid Liquid Printing.	

1. Gibson I, Rosen D W, Stucker B (2015), "Additive Manufacturing Technologies: R Prototyping to Direct Digital Manufacturing", *Springer*.



Reference Books:

- 1. Yang, L., Hsu, K., Baughman, B., Godfrey, D., Medina, F., Menon, M., & Wiener, S. (2017). "Additive manufacturing of metals: the technology, materials, design and production", *Springer*.
- 2. Gebhardt, Andreas. (2011). "Understanding additive manufacturing." Hanser Publication
- 3. Bártolo, P. J. (Ed.). (2011). Stereolithography: materials, processes and applications. *Springer Science & Business Media*.

Any other information:

Total Marks of Internal Continuous Assessment (ICA): 50 Marks

Distribution of ICA Marks:

Description of ICA	Marks
Test Marks	20
Term Work Marks	30
Total Marks :	50

Details of Term work:

Term work should consist of the following:

- 1. Mini Project: Teams with 3~4 members will work on a small project related to AM OR Case study
- 2. Experiments (min 8) based on the above syllabus
- 3. Industrial visit and report



Program	B. Tech.	(Mechatroni	cs Enginee	ering)	Semester : VI	I	
Course :	Mechatro	nics System I	Design		Code: BTMAC	07001	
	Teaching	Scheme			Evaluation	n Scheme	
Lecture Hours per week	Practical Hours per week	Tutorial Hours per week	Credit	Co Asses As p	nternal ntinuous sment (ICA) er Institute Norms arks – 50)		eory 70 Marks)
3	2	0	4	Scaled	to 30 marks	Scaled to	70 marks
-	Systems (BTM.	,	,		ntation (BTMA nterfacing (BTM	,	t Basic
,	o develop skill	ls related to N	Mechatron	ic systen	ıs.		
	o understand] ystems	low cost proc	luction of s	sensor ai	nd actuator syst	tem and bi	omedical
З. Т	o expose stude		0	-	inciples, Microp ation and testin	•	, circuit
Outcom	es: After succe	ssfully comp	letion of th	is course	e, students shou	ıld be able	to
1. S	elect appropria	ate sensors/t	ransducers	s for flui	d power control	1.	
2. k	Know the contr	ol system the	eory and m	icroproc	essor based ap	plications.	
3. I	mplement and	control the n	nodel of a	mechani	cal system plan	t.	
Detailed	l Syllabus:						
Unit	Description						Duration (Hours)
I					Systems, Meas r based contro		06

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2.	Study of Actuation Systems	00
	Pneumatic and Hydraulic Systems, Mechanical Actuation System,	06
	Electrical Actuation Systems.	
3.	Smart Sensors Principles, design, working and selection of sensors for Mechatronic system design, Sensor data acquirement. Basic principles of the acquirement and transmission of the data (signals and buses), Data processing, Pattern recognition and classification, Intelligent sensors, Definitions, examples, Complex sensors, biometric sensors (fingerprint scanners, retina scanners, etc.)	08
4.	Intelligent Sensors Soft-Computing (fuzzy logic, neural networks, agents), use in the intelligent sensors, Sensor networks. Centralized and decentralized system of the measurement chains. Communication (IEEE 1415), distributed systems, Future of the intelligent sensors, trends (Nano sensors, biosensors).	04
5.	Closed Loop controllers: Continuous and discrete processes control modes, two step mode, proportional mode, derivative control, integral control, PID controller, digital controllers, control system performance, controller tuning.	06
6.	Hardware components and Real Time Interfacing for Mechatronics Transducer signal conditioning and devices for data conversion, programmable Controllers, Introduction to Real Time, Elements of Data Acquisition and Control system, Overview of the I/O processes, Installation of the I/O card and installation of the application software.	08
7.	Modeling for Mechatronic Systems Design Introduction, System, Mechanical System, Electrical System, Fluid system, Thermal System, Engineering system, Translational mechanical system with spring, damper and mass, Rotational mechanical system with spring, damper and mass, Modeling of electric motor, Chamber filled with fluid, Pneumatic actuator.	07
	Total	45 Hours
Text B	ooks:	<u> </u>

1. Devdas Shetty and Richard A. Kolk, Mechatronics System Design, Second Edition,

Cengage Learning, 2011

- **2.** Ida, N., Sensors, Actuators, and their Interfaces; 2014; Scitech Publishing; ISBN: 978-1-61353-006-1.
- **3.** W. Bolton, Mechatronics, Third Edition, Pearson Education, 2009.

Reference Books:

- 1. Stephen D. Senturia, Microsystems Design, Kluwer, Boston, 2001 (Classic)
- **2.** Kenneth J. Ayala, "The 8086 microprocessor: programming and interfacing the PC", Cengage Learning, 8th Indian reprint, 2011.
- **3.** Katsuhiko Ogata, Modern Control Engineering, Prentice Hall of India, 5th edition, 2006

Term Work:

- **1.** Minimum two assignments.
- **2.** Minimum ten experiments and tutorials covering the whole syllabus duly recorded and graded.
- 3. Two term test papers.



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Program	: B. Tech. (Me	echatronics Er	ngineerin	<u>g)</u>	Semester: VII		
Course:	Industrial Eng	gineering	-	-	Code: BTMA070	002	
	Teaching	Scheme			Evaluation S	Scheme	
Lecture Hours per week	Practical Hours per week	Tutorial Hours per week	Credit	Asse As per	nal Continuous essment (ICA) Institute Norms Marks – 50)		heory , 70 Marks)
3	0	2	4	Scale	ed to 30 marks	Scaled	to 70 marks
Pre-requ	isite: Manufact	uring Process	es (BTMA	04005)			
 T T Outcome After succ C Ir p A the succession of the succession o	o apply ergono ccupational stre o introduce the es: ccessful comple alculate the pro nprove the met erformed.	ledge of work mic principles esses. <u>concept of va</u> tion of this con oductivity of r hods to mease	-study tec s to enable lue engin urse, stud esources f ure paran	chniques e workin eering ar ents sho for impro- neters suc	for examination of g effectively with r nd applications. uld be able to	minimiza gnitude c	ntion of
Unit	Description						Duration (Hours)
1	job to ident Interdepende Significance o	ify and red nce between v of theory of Sc vity through	uce/elimi vorking co cientific M Work st	inate the onditions fanagem tudy. V	ing the work conte e excess work o s and productivity ent. Improving Eff Vork study comp e Study.	content. ficiency	06
2	job to a stu	died. Record	ing the f	facts wit	udy. Factors in sele th charts and dia f new method. I	agrams.	08

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		1
	Management and workers in implementation.	
3	Facilities & Workplace Design: Aligning the physical facilities- plant	05
	layout, equipment and work flow as per the production processes.	
	Principles of Motion Economy. Standardization of the process.	
4	Work Measurement: Significance of work measurement. Techniques	10
	of work measurement. Need of work sampling technique. Conducting	
	work sampling study. Analytical estimation of work. Concept of	
	rating factor. Consideration of various allowances. Standard time for	
	work. Predetermined time standards. Use standard data. MOST for	
	work measurement. Use of time standards.	
5	Ergonomics: Field of Ergonomics. Physical and cognitive issues of	07
	ergonomics. Aims of ergonomics considerations. Working postures of	
	operatives. Design of objects, facilities and environment.	
	Anthropometrical details. Database of human factors. Ergonomic	
	improvement of physical and cognitive issues. Ergonomics principals.	
	Information input and human control of systems. Work space and	
	arrangement. Living environment. Visual displays	
6	Value Engineering: Definition of Value Engineering, Uses of Value	09
	Engineering, Reasons for unnecessary costs, Difference between Value	
	Engineering and other cost reduction techniques. Case studies	
	Total	45 Hour
Text B	ooks:	
1.	International Labor Office (2014), "Introduction to Work Study", Oxford & II	зЦ
1.	Publishing Co. Ltd.	511
2.	Ralph Barnes (2002), "Time & Motion study", Asia Publishing.	
	ence Books:	
1.	M. S. Sanders & E J McCormick (2002), "Human factors in Engineering	& Design
-	Tata McGraw Hill.	
	K. B. Zandin (2003), "Most Work Measurement System".	Dooring Th
3.	Merton E. Davis, William D. Falcon, Value Analysis (2002), "Value Engir Implications for Managers", <i>American Management Association</i> .	ieering: If
4.	By Richard J Park (1999), "Value Engineering: A Plan for Invention", CRC I	Press.
5	Other K NI (2008) "The dust Design" Design Education	

5. Otto, K. N. (2008), "Product Design", Pearson Education.

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Term work:

- **1.** Assignment on above syllabus (Min. 3).
- 2. Report on Experiments given below and presentation.
- **3.** Two term test papers.

List of Experiments:

- **1.** Experiment on rating to understand the concept of Standard Time.
- **2.** Experiment on appropriate Recording Techniques of Method Study.
- **3.** Experiment on Layout of Physical facilities (using Flow diagram/ String diagram/ Travel chart or any other work study technique)
- **4.** Experiment on Designing a Workplace / workstation for any process using principles of Motion Economy.
- 5. Study Experiment on Ergonomic assessment of an Industrial product.
- 6. At least one Case Study for Value Engineering.



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Cours		Mechatronic		8/	Semester : VII Code :BTMA07003
Cours	Teaching				Evaluation Scheme
Lectu		Tutorial			
Hou per wee	rs Hours per	Hours per week	Credit	In	ternal Continuous Assessment (ICA) As per Institute Norms (Marks - 100)
0	8	0	4		Scaled to 100 Marks
Pre-re	quisite: Core Me	chatronics su	abjects till 3	3 rd year	
Objec	tives:				
1. Te	o do literature su	rvey in the to	opic selecte	ed for n	najor project.
	o explore the feas	•	- /		
	0	nulate the w	ork to be ca	arried c	out in next phase.
Outco	mes:				
After	successful comple	etion of the p	project phas	se, the s	student will be able to
	1. Select an app				
	2. Analyse diffe	0	01		
<u> </u>			he work to	be car	ried out in next project phase.
	ties to be done in		nod consist	ing of r	not more than 3 students.
	, ,	-		0	
2.	,	-			d in consultation with Project Mentors
•	alternatively stu	-		-	(the Desired to be a busiled in the first
3.				-	f the Project to be submitted in the firs
1	week of the sem	0			
4.	-	- /	ct will invo	Sive Lit	terature Survey, feasibility study, Design
-	and Part Impler				and the second second states to the
5.	-		-		weekly report on the work done to th
			0	-	port. There would continuous evaluation
-	based on the we				
6.		5	0		vey, feasibility study, Design and Par
_	-				of the Semester. (Spiral Bound Report)
7.					lone during the Semester to be evaluate
		miner and P			

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Progra	m: B. Tech. (M	lechatronics l	Engineeri	ng)	Semester	: VII	
Course		5	tem Mode	ling	Code: B	ГМА07004	
	and Analysi		I		- - - -		
	Teaching			Internal Co	Evaluation	Scheme	
Lectu	re Practical	Tutorial		Assessme			
Hour	s Hours	Hours	Credit	As per In	. ,		neory
per	per	per	cicuit	Nori		(3 Hrs.,	70 Marks)
weel	week	week		(Marks			
3	0	2	4	Scaled to 3	0 marks	Scaled to	o 70 marks
Pre-re	equisite: Enginee	ering Mathem	atics - I, II	and III (BTAI	B01001, BTA	AB02001 ar	nd
BTMA	A03001), Thermo	dynamics and	d Heat Tra	nsfer (BTMA	04004)		
Object	tive:						
,		nd physical	systems	e.g. mechanio	cal, electric	al, therma	al and fluid
	systems and	converting th	iem to mat	thematical mo	dels.		
				Modeling an	-	e analysis	of dynamic
	•	-		cal engineerin	g.		
	• To learn the	use of any ma	athematica	l software.			
Outco				المتعدية والمعام	a a h 1 a ƙa		
After s	successful comple	euon of the co	Jurse, stuc	ients should b	e able to		
٠	Convert the ph	ysical system	into ma	thematical m	odels and v	will be abl	e to identify
	the response of	the systems a	nd also m	odify the syst	ems as per	the require	ements using
	mathematical so	oftware.			-	-	0
Detail	ed Syllabus						
Unit	Description						Duration (Hours)
1	Introduction	to system	dynamic	s: Introduct	tion, Matl	nematical	05
	Modeling of l	Dynamic Sys	stem, An	alysis and E	Design of	Dynamic	
	Systems.						
2	The Laplace t						05
	Variables, and						
	Laplace Transf					tterential	
2	Equations, Exar						06
3	Mechanical sys modeling of si						06
	Example Proble				snergy, and	a rower,	
	LAmple 110016		10113, 1101	/iciiio,			

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4	Transfer-Functionapproachtomodellingdynamicsystem:Introduction,BlockDiagrams,Partial-FractionExpansionwithMATLAB,Transient-ResponseAnalysiswithMATLAB,Example	08
	Problems and Solutions, Problems.	
5	State-Space approach to modelling dynamic system: Introduction, Transient-Response Analysis OF Systems in State-Space Form with MATLAB, State-Space Modelling of System with Input Derivatives, Transformation of Mathematical Models with MATLAB, Example Problems and Solutions, Problems.	07
6	Electrical systems and electromechanical systems: Introduction, Fundamentals of Electrical Circuits, Mathematical Modelling of Electrical Systems, Analogous Systems, Mathematical Modelling of Electromechanical Systems, Mathematical Modelling of Operational- Amplifier Systems	08
7	Fluid systems and thermal systems: Introduction, Mathematical Modelling of Liquid-Level Systems, Mathematical Modelling of Pneumatic Systems, Linearization of Nonlinear Systems, Mathematical Modelling of Hydraulic Systems, Mathematical Modelling of Thermal Systems	06
	Total	45 Hours
Text B		
1.	Oghata (2007), "System Dynamics" Pearson Publications.	
	Norman Nise (2008), "Control System Engineering" Wiley.	
-	ence Books:	
1.	Close, Fredrik (2001), "Modelling and Analysis of Dynamic System" Wiley	
2.	Narsico, George Julius (2005), "Modelling and Control of Dynamic System	" Thomson.
Term	Work:	
1.	Five Assignments based on above topics (Min. 3).	
2.	Viva Voce Examination	
3.	Two term test papers.	



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Program:	B. Tech. (M	lechatronics H	Engineeri	ng)	Semes	ter : VII	
Course: (lexible Manuf	<u> </u>	0,	Code:	BTMA07	005
	Teaching	Scheme		Eva	aluation	Scheme	
Lecture Hours per week	Practical Hours per week	Tutorial Hours per week	Credit	Internal Contin Assessment (As per Instit Norms (Marks – 5	ICA) ute		neory 70 Marks)
3	0	2	4	Scaled to 30 n	narks	Scaled	to 70marks
Pre-requi	site: Manufa	acturing Proce	ess (BTMA	404005)			
ma • To Outcomes • Ur so • Ar FN	aterial handli impart the k s: After succes nderstand the ftware develo nalyze the imp /IS.	ng, loading, so nowledge of r sful completio development opment. portance of m	cheduling nodelling on of this o t & Impler aterial har	flexible manufa , storage etc. and Analysis in course students v mentation of an F ndling, loading, s	FMS. vill be a MS wit	ble to h its hard ing, stora	ware and
Detailed	Syllabus						
Unit	Description	L					Duration (Hours)
1	of an FMS - & performa	- Types & con	figuration Function	F MS - an Overv ns concepts – Typ n of FMS host co stribution.	pes of fl	exibility	04
2	Integration- Project dev	System configue velopment sternt-Host system	guration - eps. Proje	of an FMS: Pl FMS layouts - S ect managemen pment - plannir	imulatio t - Equ	on -FMS uipment	07
3	Automated Analysis of	Material Ha	-	z Storage: Func pment's, Design			05

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4	Automated Storages: Storage system performance - AS/RS -	07
	Carousel storage system - WIP storage system - interfacing	
	handling storage with manufacturing, modelling and analysis of	
	FMS using Queuing Simulation and Heuristics	
5	Concepts of Distributed Numerical Control: DNC system -	06
	Communication between DNC computer & machine control unit -	
	Hierarchical processing of date in DNC system - Features of DNC	
	systems.	
6	Scheduling & Loading of FMS:	09
	Introduction - Scheduling of operations on a single machine - two	
	machine flows hop scheduling - two machine job shop scheduling,	
	three machine flow shop scheduling - scheduling 'n' operations on	
	'n' machines - Scheduling rules - loading problems - Tool	
	management of FMS - material Handling system schedule. Problems.	
	Inspection & Cleaning stations. CMM, Sequence of operations, Advantages Types of CMM, Problems.	
	Advantages Types of Civily, Troblems.	
7	FMS Relational:	07
	Economic and technological justification for FMS - as GT, JIT -	
	operation and evaluation - Personnel and infra structural aspects -	
	typical case studies – Future prospects.	
	Total	45 Hours
Text B	Books:	
	Parrish D J (1993), "Flexible manufacturing", ButterWorth – Heinemann L	td Oxford.
	Groover M P (1989), "Automation, Production Systems and Compute	2
	Manufacturing", Prentice Hall India (P) Ltd.	0
3.	Kusiak A (1990), "Intelligent Manufacturing Systems", Prentice Hall	l, Englewood
	Clitts, NJ.	0
4.	William W. Luggen, "Flexible Manufacturing Cells & Systems", Prentice	hall, NJ
Refere	ence Books:	
1.	Considine D M (1986), "Standard Handbook of Industrial Automation	n", Chupmai
	and Hall, London.	
2.	Viswanatham N & Narahari Y (1992), "Performance Modeling of	Automated
	Manufacturing Systems", Prentice Hall of India (P) Ltd.	
	Ranky PG (1988), "The design and Operation of FMS", IFS Pub. UK.	
1	Dr U V Chivapand "Elovible Manufacturing System" Dhawnat Pai	Dublications

4. Dr. H. K. Shivanand, "Flexible Manufacturing System", Dhanpat Rai Publications, New Delhi.

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Term Work:

- 1. Assignments based on the above syllabus (Min. 4).
- 2. Visit to FMS unit.
- 3. Viva Voce, Quizzes, Presentations based on syllabus.
- **4.** Two term test papers.



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Program	n: B. Tech. (M	Iechatronics	Engineeri	ng)	Semester: V	II	
Course	e: (Elective I)	- Automobile	Engineeri	ng	Code: BTMA	.07006	
	Teaching	Scheme			Evaluation	Scheme	
Lecture	e Practical	Tutorial		Internal	Continuous		
Hours	Hours	Hours	Credit	Assessn	nent (ICA)	The	ory
per	per	per	Cleun	As per Ins	titute Norms	(3 Hrs., 7	0 Marks)
week	week	week		(Mar	ks – 50)		
3	0	2	4	Scaled to	o 30 marks	Scaled to	70 marks
Pre-req	uisite: Theory of		`	,		<u> </u>	
	Design of	Machine Ele	ements (BT	'MA05001)			
Objecti	ve:						
• '	Го impart the k	nowledge of	the basics	of the autom	obiles.		
• '	Γο introduce th	e different au	atomobile :	systems like s	suspension, axle	s and steering	g and
	transmission sy	stems in the	Automobi	les.			
Outcon							
	ccessful compl						_
			ines used	in automobile	e and their chara	acteristics, sel	ections of
	suitable rear ax	0					
			steering ge	ometry, types	s of suspensions	s, and clutch a	and gear
	mechanism of v			D 1			
	Perform the cal	culations of c	lutch and	Brakes.			
Detaile	d Syllabus						Duration
Unit	Description						Duration (Hours)
	characteristics a gradient resist selection of suit	and selection ances, powe able rear axle	s, resistan r require and gear	ce to motion ment for acc ratios.	d in automol of vehicle, air, celeration and	rolling and tradability,	06
	Chassis: Chass distribution sta				bes of automob	iles, weight	04
3	Steering: Steer point Steering, radius, steering independent su Axle: Axle ma axle bearing	ing geometr Ackerman ar convention spension, wl terial, load a wheel align	y, wheel a nd Davis s al layout o neel wobbl nd stresse ment, dif	alignment an teering, corne of steering sy e and shimm es on front a: ferential and	d wheel baland ering force slip a rstem. Steering y, power steerin xle design, stee d their types, e and triple red	angle, scrub systems for ng. rring heads, rear axle	12

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	Tires: Function, construction, types of tires, tubeless tire.	
4	Suspension System: types of suspensions, materials, shackles and mountings,	08
	types of springs, shock absorbers, sprung weight and un sprung weight,	
	conventional suspension system, independent suspension, air suspension,	
	hydra-gas suspension, rubber suspension, interconnected suspension, self-	
	leveling suspension	
5	Drive mechanisms: Torque reaction, driving thrust, propeller shaft, universal	07
	joints, and constant velocity universal joints. Differential, action of differential,	
	constructional details, types of rear axles, materials, bearing loads, double	
	reduction and two speed axle, front wheel drive, all-wheel drive, introduction	
	to continuous variable transmission (CVT).	
6	Clutch and braking mechanisms:	08
	Clutch: Clutch mechanism-wet/dry clutch- constant pressure, constant wear	
	type, back up plate, cone clutch, centrifugal clutch, multi-plate clutch, clutch	
	materials, influence of temperature on the performance, torque limiter.	
	Numerical Examples.	
	Braking Systems: types and construction, mechanical, hydraulic system,	
	diagonal braking system, antilock braking system. Numerical Examples.	
	Total	45 Hours
	Total Books:	45 Hours
1.	Total Books: K. K. Jain and Asthana (2002), "Automobile Engineering", <i>TTI Publications</i> .	L
1. 2.	Total Books: K. K. Jain and Asthana (2002), "Automobile Engineering", <i>TTI Publications</i> . R.K. Rajput (2007), "A Text Book of Automobile Engineering", <i>Laxmi Publication</i> .	L
1. 2.	Total Books: K. K. Jain and Asthana (2002), "Automobile Engineering", <i>TTI Publications</i> .	L
1. 2. 3.	Total Books: K. K. Jain and Asthana (2002), "Automobile Engineering", <i>TTI Publications</i> . R.K. Rajput (2007), "A Text Book of Automobile Engineering", <i>Laxmi Publication</i> .	L
1. 2. 3. Referent 1.	Total Books: K. K. Jain and Asthana (2002), "Automobile Engineering", TTI Publications. R.K. Rajput (2007), "A Text Book of Automobile Engineering", Laxmi Publication. S. Kripal (2009), "Automobile Engineering Vol I", New Chand Jain. ence Books: G. Genta, Morello (2009), "The Automotive Chassis: System Design", Springer.	L
1. 2. 3. Refere 1. 2.	Total Books: K. K. Jain and Asthana (2002), "Automobile Engineering", TTI Publications. R.K. Rajput (2007), "A Text Book of Automobile Engineering", Laxmi Publication. S. Kripal (2009), "Automobile Engineering Vol I", New Chand Jain. ence Books: G. Genta, Morello (2009), "The Automotive Chassis: System Design", Springer. Society of Automotive Engineering (1997), "Automotive Engineering".	s.
1. 2. 3. Refere 1. 2.	Total Books: K. K. Jain and Asthana (2002), "Automobile Engineering", TTI Publications. R.K. Rajput (2007), "A Text Book of Automobile Engineering", Laxmi Publication. S. Kripal (2009), "Automobile Engineering Vol I", New Chand Jain. ence Books: G. Genta, Morello (2009), "The Automotive Chassis: System Design", Springer. Society of Automotive Engineering (1997), "Automotive Engineering". D. Crolla (2009), "Automotive Engineering: Powertrain, Chassis System, Veh	s.
1. 2. 3. Refere 1. 2.	Total Books: K. K. Jain and Asthana (2002), "Automobile Engineering", TTI Publications. R.K. Rajput (2007), "A Text Book of Automobile Engineering", Laxmi Publication. S. Kripal (2009), "Automobile Engineering Vol I", New Chand Jain. ence Books: G. Genta, Morello (2009), "The Automotive Chassis: System Design", Springer. Society of Automotive Engineering (1997), "Automotive Engineering".	S.
1. 2. 3. Referen 1. 2. 3.	Total Books: K. K. Jain and Asthana (2002), "Automobile Engineering", TTI Publications. R.K. Rajput (2007), "A Text Book of Automobile Engineering", Laxmi Publication. S. Kripal (2009), "Automobile Engineering Vol I", New Chand Jain. ence Books: G. Genta, Morello (2009), "The Automotive Chassis: System Design", Springer. Society of Automotive Engineering (1997), "Automotive Engineering". D. Crolla (2009), "Automotive Engineering: Powertrain, Chassis System, Veh	s.
1. 2. 3. Refere 1. 2. 3. Term	Total Books: K. K. Jain and Asthana (2002), "Automobile Engineering", TTI Publications. R.K. Rajput (2007), "A Text Book of Automobile Engineering", Laxmi Publication. S. Kripal (2009), "Automobile Engineering Vol I", New Chand Jain. ence Books: G. Genta, Morello (2009), "The Automotive Chassis: System Design", Springer. Society of Automotive Engineering (1997), "Automotive Engineering". D. Crolla (2009), "Automotive Engineering: Powertrain, Chassis System, Veh Butterworth-Heinemann.	s.
1. 2. 3. Refere 1. 2. 3. Term 1.	Total Books: K. K. Jain and Asthana (2002), "Automobile Engineering", TTI Publications. R.K. Rajput (2007), "A Text Book of Automobile Engineering", Laxmi Publication. S. Kripal (2009), "Automobile Engineering Vol I", New Chand Jain. ence Books: G. Genta, Morello (2009), "The Automotive Chassis: System Design", Springer. Society of Automotive Engineering (1997), "Automotive Engineering". D. Crolla (2009), "Automotive Engineering: Powertrain, Chassis System, Veh Butterworth- Heinemann. Work:	S.
1. 2. 3. Referen 1. 2. 3. Term 1. 2.	Total Books: K. K. Jain and Asthana (2002), "Automobile Engineering", TTI Publications. R.K. Rajput (2007), "A Text Book of Automobile Engineering", Laxmi Publication. S. Kripal (2009), "Automobile Engineering Vol I", New Chand Jain. ence Books: G. Genta, Morello (2009), "The Automotive Chassis: System Design", Springer. Society of Automotive Engineering (1997), "Automotive Engineering". D. Crolla (2009), "Automotive Engineering: Powertrain, Chassis System, Veh Butterworth- Heinemann. Work: One assignment from each unit.	s. icle, Body'
1. 2. 3. Refere 1. 2. 3. Term 1. 2. 3.	Total Books: K. K. Jain and Asthana (2002), "Automobile Engineering", TTI Publications. R.K. Rajput (2007), "A Text Book of Automobile Engineering", Laxmi Publication. S. Kripal (2009), "Automobile Engineering Vol I", New Chand Jain. ence Books: G. Genta, Morello (2009), "The Automotive Chassis: System Design", Springer. Society of Automotive Engineering (1997), "Automotive Engineering". D. Crolla (2009), "Automotive Engineering: Powertrain, Chassis System, Veh Butterworth- Heinemann. Work: One assignment from each unit. Experiments (any 5) from the list given below	s. iicle, Body'

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List of Experiments:

- 1. Study of Chassis Layout.
- 2. Study of Power plant location and mounting.
- 3. Study of Steering mechanism and Power Steering.
- **4.** Experiment on wheel balancing.
- 5. Experiment on Suspension system (coil spring and leaf spring) mounting and design calculations.
- 6. Study of Universal joint and differential mechanism.
- 7. Study of Clutches of different types.
- 8. Study of construction of mechanical, hydraulic and pneumatic brakes.



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Progra	Program: B. Tech. (Mechatronics Engineering) Semester : VII							
Cours	Course: (Elective II) - Digital Signal Processing Code:BTMA07007							
Teaching Scheme Evaluation Scheme								
Lectu Hour per weel	rs Hours per	Tutorial Hours per week	Credit	Internal Continuous Assessment (ICA)			Theory ., 70 Marks)	
3	2	0	4	Scaled t	o 30 marks	Scaled to	o 70 marks	
Cours 1.	quisite: Signals a e Objectives: Understand dif	ferent types of	of linear sy	stems				
3.	Understanding Designing of fil e Outcomes:		rete transfo	orms				
2. 3. Detail	Understand the Use various tran Design Finite In ed Syllabus:	nsforms like	DCT and I	OFT.		filters.		
Unit	Description						Duratior (Hours)	
1	Properties of LTI systems: Definition, convolution and solution of Linear difference equations with constant coefficients. Causality & stability, Frequency response of LTI systems, phase distortion and delay, all pass systems, minimum, maximum mixed phase systems, linear phase filters, causal generalized linear phase system (pole zero plots), symmetric, anti-symmetric filters & review of low pass, high pass, band pass filters, frequency transformations, digital resonator, comb filters, notch filters, digital sinusoidal oscillators					ponse of inimum, neralized ric filters requency	09	
2	Discrete cosine transform (DCT): Definition of DCT, DCT-1 and DCT-2, relationship between FT ,DCT-1 and DCT-2, energy compaction property of DCT-2, applications of DCT						04	
3	Discrete Fouri two DFTs- the DFT in linear	circular conv	volution, a	dditional	DFT propertie	es, use of	07	

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	erse FFT 10 ng method, zeen no. of
4 Design of filters: Design of FIR filters - windowing method frequency sampling FIR differentiator, Hilbert transformers, relationship betw coefficients and filters, characteristics of raised cosine transit Design of IIR filters: Mapping of differentials, Impulse Bilinear transformation, Matched Z-transforms, B	ng method, zeen no. of
Design of FIR filters - windowing method frequency sampling FIR differentiator, Hilbert transformers, relationship betwo coefficients and filters, characteristics of raised cosine transit Design of IIR filters: Mapping of differentials, Impulse Bilinear transformation, Matched Z-transforms, B	ng method, zeen no. of
FIR differentiator, Hilbert transformers, relationship betw coefficients and filters, characteristics of raised cosine transit Design of IIR filters: Mapping of differentials, Impulse Bilinear transformation, Matched Z-transforms, B	veen no. of
coefficients and filters, characteristics of raised cosine transit Design of IIR filters: Mapping of differentials, Impulse Bilinear transformation, Matched Z-transforms, B	
Design of IIR filters: Mapping of differentials, Impulse Bilinear transformation, Matched Z-transforms, B	ion filton
Bilinear transformation, Matched Z-transforms, B	ion inter.
, , , , , , , , , , , , , , , , , , , ,	invariance,
Chabrachers filter I. Chabrachers filter II and Elliptic filters	utterworth,
Chebyshev filter I, Chebyshev filter II, and Elliptic filters	
Frequency transformation low pass to high pass, band pass,	band reject
filters, Design of digital filter based on least square method	,
5 Structures for discrete time systems:	
- FIR structures (direct form, cascade form, frequence	y sampling
and lattice); structures for linear phase filters.	07
- Structures for IIR systems, direct form-I, Dire	ct form-II,
Canonical, Lattice and Lattice ladder structures.	
- Basic structure of phase shifters, All-pass filters;	
analysis of cascaded and parallel IIR structures and FIR stru	ctures
6 Amplitude quantization: effect of coefficient quantization	
FIR systems, effect of round off noise in digital filters, q	uantization 02
errors, limit-cycle oscillations.	
7 Introduction to Programmable Digital Processor	
DSP processor v/s General purpose processor, multiplier,	MAC unit, 06
Bus Architecture and memory, Pipelining, Multiport mem	nory, VLIW
Architecture, data addressing capabilities, on-chip Peripher	als, P-DSPs
with RISC and CISC	
Total	45 Hours
Text Books:	
1. John Proakis, Digital Signal Processing, Prentice Hall of India	a Publication, 4 th
edition, 2010	
2. S. K. Mitra. Digital Signal Processing: A Computer-Based Ap	proach, McGraw-Hill,
New York, NY, fourth edition, 2010.	
Reference Books:	
1. Alan V. Oppenheim & Ronald W. Scheffer, Discrete time sign	nal processing, Prentice
Hall of India Publication, Third edition, 2009	
2. F.W. Smith, Scientist & Engineers' Guide to Digital Signal Pre	
(California Technical Publishing). Web-site : <u>www.DSPguide</u>	
3. Maurice Bellanger, Digital Processing of signals, (John Wiley	Publication) 2000

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Term Work:

- **1.** Minimum two assignments.
- 2. Minimum ten experiments covering the whole syllabus duly recorded and graded.
- **3.** Two term test papers.



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Progra	ram: B. Tech. (Mechatronics Engineering) Semester : VII							
Course								
	Embedde					<u> </u>	2.1	
Tasta	Teaching					Evaluation S	Scheme	
Lectur Hour per weel	s Hours per	Tutorial Hours per week	Credit	Internal Continuous Assessment (ICA) As per Institute Norms (3 1 (Marks – 50)			Theory Irs., 70 Marks)	
3	2	0	4	Scaled	l to	30 marks	Scaled	to 70 marks
Pre-ree	quisite: Digital E	lectronics (B	ГМА0300	4) and Mi	icrop	processors and	l Interfac	ing (04006)
1. 2. 3. 4. 5. Detail	mes: he successful cor	npletion of the erence betwo ntroller based of PIC18xx at embedded	nis course een micro d systems controller systems a	the stude oprocesso for differ und their	ent v rs ar rent a use.	vill be able to nd microcontr applications.		
Unit	Description							(Hours)
1.	Basics of 8051: 08 Comparison of microprocessor and microcontroller, Architecture and pin functions of 8051 chip controller, CPU timing and machine cycles, Internal memory organization, Program counter and stack, Input/output ports, · Counters and timers, Serial data input and output · Interrupts, Power saving modes. 08							08
2.	Programming with 8051: Instruction set, addressing modes, immediate, registers, direct and indirect data movement and exchange instructions, push and pop opcodes, arithmetic and logic instructions, bit level operations, jump and call instructions, input/ output port programming, Programming timers, asynchronous serial data communications, and						oop op-	09

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	hardware interrupt service routines. Interfacing of LCD display, hex keyboard, ADC0808, DAC0808 and Stepper motor with 8051 Current trends in microprocessors and practical implementation					
3.	PIC Controllers: PIC18	07				
	PIC18 memory organization, CPU registers, Pipelining, instruction format, Addressing modes, Sample of PIC18 Instructions. Overview of the 8-bit MCU Market	07				
4.	PIC18 Assembly language Programming Assembler directives, Writing programme to perform arithmetic computations, program loops, Reading and writing data in programmed memory, Logic Instructions, Using programmed loop to create time delays, Rotate instructions, Using rotate instructions to perform Multiplications & divisions. I/O Addressing, Interfacing with simple input/output devices.	08				
5.	Introduction to Embedded systems	07				
	Architecture of Embedded Systems, Design Metrics, Examples of embedded systems, hardware/software co-design, Embedded micro controller cores (ARM, RISC, CISC, and SOC), embedded memories, sensors and interfacing techniques.					
6.	Real-time operating system(RTOS)	06				
0.	RTOS concepts, real-time operating systems, Required RTOS services/capabilities (in contrast with traditional OS). Benefits of using RTOS, Concepts of Tasks/Threads/Process, Multitasking, Task Scheduling, Task management, Inter-task communication and Synchronization, Device Drivers, How to choose an RTOS					
	Total	45 Hours				
Text B	Books:					
1.	Muhammad A. Mazidi, "The 8051 microcontroller and embedded syste Education Asia, 2 nd edition, 2008.	em", Pearson				
2.	Han Way Huang, "PIC Microcontroller", Cengage learning, 2009					
3.	3. Rajkamal, "Embedded Systems - Architecture, Programming and Design", Tata McGraw Hill, 2 nd edition, 2009.					
Refere	ence Books:					
1.	Kenneth J Ayala, "The 8051 microcontrollers", Thomson, 3rd edition, 2006					
2.	John B. Peatman, "Design with PIC Microcontrollers", Pearson Educatio 2010	n, 2 nd edition				
-						

3. David E. Simon, "An Embedded Software Primer", Pearson Education, 1999.

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Term Work:

- **1.** Minimum two assignments.
- 2. Minimum ten experiments covering the whole syllabus duly recorded and graded.
- **3.** Two term test papers.



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Progra	m: B. Tech. (N	Mechatronics	s Engineer	ring)	Semester : VI	I	
Course	se : (Elective II) - Microelectromechanical Code: BTMA07009						
	Systems						
	Teaching			I	Evaluation	Scheme	
Lectur		Tutorial Hours	Credit		Continuous ment (ICA)	Tł	neory
per	per	per	Credit		stitute Norms	(3 Hrs.,	70 Marks)
week	-	week			rks – 50)	(**)	· · · · · · · · · · · · · · · · · · ·
3	2	0	4	Scaled	to 30 marks	Scaled to	o 70 marks
Pre-rec	l uisite: Fundam Engineeri		nce and In	strumentat	ion (BTMA0500)4)	
2. 3. Outcor 1. 2. 3.	To develop cert To understand I systems To expose stude actuation princi nes: After succes Able to learn fal Able to determi Implement adva ed Syllabus: Description MEMS and Mie	low cost proc ents to mater ples, circuit a ssfully comp brication tech ne the perfor anced MEMs	luction of ials proper and system letion of th miques us mance of design flo	sensor and rties, fabrica n issues, pa nis course, s ed MEMs r MEMs desi ow used in	actuator system ation techniques <u>ckaging, calibra</u> students will be nanufacturing. gn.	n and biom s, sensing <u>tion and t</u> able to	nedical and esting.
	MEMS and Microsystems Technology:Introduction to Micro sensors, Evolution of micro sensors,Microelectronics technologies for MEMS, Mechanical, Inertial, Biological,Chemical, Acoustic technology.						
2	Sensor network and Protocol: Actuating or sensing concept, Integrated smart sensors Smart transducers: Concept, hardware structure , software structure						08
3	MEMS Fabrica Background in	tion:			Pr D. Surface		08



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Progra	m: B. Tech. (1	Mechatronics	s Engineer	ring)	Semester : VI	II		
Course	e: Industrial	Robotics			Code: BTMA08001			
	Teaching	Scheme			Evalua	tion Scheme		
Lectu Hour per we	rs Hours	Tutorial Hours per week	Credit	As	rnal Continuou sessment (ICA) s per Institute Norms (Marks – 50)) Th	eory 70 Marks)	
3	2	0	4	Sca	led to 30 mark	s Scaled to	o 70 marks	
Pre-rec	quisite: Linear Al	gebra Vector	rs and Mat	rix (B	TAB01001) (BT	AB02001)		
Object		George Vector			111D01001))/ (D1	11002001)		
3. Outcor After t 1. 2. 3. 4. 5.	he successful com Know the basics Apply the know and Inverse) mo Perform trajector Use image repre Perform autonor	ntrol. ants to evalua ng of robots. and analyze t npletion of th of Robots. and ge of vec tion. ry planning a sentation for	te, choose <u>he various</u> is course, t torial mat und work s robotic mo	and in <u>appli</u> the stu hema pace a overm	ncorporate robo cations of robot ident will be ab tics and geome analysis for robo	ts in engineer <u>s.</u> le to try for kinem	ing systems	
	ed Syllabus:							
Unit	Description						Duration (Hours)	
1.	Basic Concepts in Robotics Introduction, Advantages & Applications of Robots, Automation and Robots, Non-Industrial applications, Basic structures of Robots, Numerical control of Machine tools, Resolution, Accuracy & Repeatability, Position Representation. Point to Point Continuous path systems, Point to Point Robotic systems, Continuous – path Robotic systems, Control loop of Robotic Systems, The Manipulator, Cartesian Coordinate Robots, Cylindrical Coordinate robots, Spherical Coordinate robots, Articulated Robots 07							
2.	Kinematic Anal		linate Trai	nsfor	nation			
	Direct Kinemati	c Problem in	Robotics.	Geom	etry based dire	ct Kinematic		

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	of Planar motion.	
6.	Task Planning: Task planner, Task level programming, Uncertainty, Configuration, Space, Gross motion, Planning, grasp planning, Fine-motion, Simulation	04
5.	 Robot Vision: Image representation and analysis, Template matching, polyhedral objects, shape analysis, Segmentation (Thresholding, region labelling) Iterative processing, Perspective transformation, Structuring Illumination, Camera calibration. 	08
4.	Workspace Analysis and Trajectory Planning of Robots: Robot work space envelops and examples, Detailed Work space analysis of two axis planar articulated robot arm, Four axis robot. Different type of motions such as Pick and place motions, Continuous path motion, interpolated motion, Straight-line motion, workspace fixtures.	08
3.	Inverse Kinematics: General properties of solution, tool configuration vector for: Two axes planar articulated robot arm, Three axis robot, Four axis robot, and Five axis robot. Inverse kinematics analysis of Two axes planar articulated robot arm, Three axis robot, and Four axis robot.	06
	 Analysis Coordinate & Vector Transformation using Matrices, The orientation Matrix & Translator Vector, Homogeneous Transformation Matrices, Three dimensional Homogeneous Transformations, Denavit Hartenberg Convention-Implementing the DH Convention, Obtaining the DH Displacement Matrices. Applications of DH method- Three axis Robot Arms, Three Axis wrists, Six axis Robot Manipulators, Assigning the Tool Coordinate System. 	08

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Text Books:

- **1.** Fu, Gonzales and Lee, Robotics- Control, Sensing, Vision and Intelligence, McGraw Hill, 1st edition, 2008.
- 2. Robert Schilling, Fundamentals of Robotics-Analysis and control, Prentice Hall of India, 1990. (Classic)

Reference Books:

- 1. J. J. Craig, Introduction to Robotics, Pearson Education, 8th edition, 2004
- **2**. Roland Siegwart & Illah R Nourbaksh, "Introduction to Autonomous Mobile Robots", EEE ed PHI 2004

3. Mittal and Nagrath, Robotics and Control, Tata McGraw Hill, 3rd edition, 2003

Term Work:

- **1.** Minimum two assignments.
- 2. Minimum ten experiments covering the whole syllabus duly recorded and graded.
- **3.** Two term test papers.

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Program:	B. Tech. (Me	chatronics E	ngineerin	g) Semester: VIII				
Course:	Product Desig	n and Develo	pment		Code: BTMA08002			
Teaching Scheme				Evaluation Scheme				
Lecture	ture Practical Tutorial			Continuous nent (ICA)	Theo	ory		
Hours per week	Hours per week	Hours per week	Credit	As per Institute Norms (Mark – 50)		(3 Hrs., 70 Marks)		
3	0	2	4	Scaled to	o 30 marks	Scaled to 2	70 marks	
Pre-requi	site: Manufactı	aring Process	es (BTMA	.04005)				
To of	provide the up impart knowl product develo introduce con	edge of busir opment.	ness and te	echnical co	ncerns about t	pects of produc he different me agement.		
U1 U1 K1 de Be U1	now the impo velopment. nchmark produ nderstand Prod se techniques li	rent stages of ortance of ' ucts and tech uct Life Cycl	product of Technolog nologies. e concept	developme gy Forecas and its imp	nt and design ting using S portance in pro	with modern a 5-Curve in ne oduct developm	ew product	
	escription						Duration (Hours)	
de m ar ar de pr de	(Hours)						· · · · · ·	
2 Pr Fo	coduct Develo precasting and ad Technical Q	pment – Te Technology	S-Curve (Technology	v Stage), Miss	ion Statement	09	

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	and Satisfaction, Customer Population and Market Segmentation, Customer	
	Needs-Types and Models, Gathering Customer Needs Information, Analysis	
	of Gathered Information.	
3	Product Development from Concept to Product Function: Generating concepts, information gathering and brainstorming, morphological analysis, concept selection-design evaluation, estimation of technical feasibility, concept selection process, Pugh's concept, selection charts, numerical concept scoring, process of concept embodiment, system modeling, Failure Mode Effect Analysis (FMEA), functional modeling and decomposition, fast method, subtract and operate procedure, establishing system functionality, augmentation and aggregation.	12
4	Quality function deployment (QFD) : Quality function deployment studies to validate design characteristics; Affinity diagram, Tree diagram, Matrix diagram, Prioritization matrix; Design validation	06
5	Design for 'X' (DFX): Design for manufacture, assembly, testing,	06
	maintenance, service, reliability; Product safety and hazard evaluation; Final	
	disposal; Reverse Engineering.	
	Total	45 Hours
Text B	ooks:	I
1.	K. Otto and K. Wood (2009), "Product Design -Techniques in Reverse Engineer	ring and
	New Product Development", Pearson Education.	
2.	K. T. Ulrich and S. D. Eppinger (2008), "Product Design and Development", Ta	ta McGraw
	Hill.	
Defense		
	nce Books:	
	R. Rosenthal (2000), "Effective Product Design and Development", Business	One-Irwin S
1.	R. Rosenthal (2000), "Effective Product Design and Development", <i>Business Publication</i> .	
1.	 R. Rosenthal (2000), "Effective Product Design and Development", Business Publication. E.B. Magrab, S.K. Gupta, F. Patrick (2009), "Integrated Product and Process 	
1. 2.	 R. Rosenthal (2000), "Effective Product Design and Development", <i>Business Publication</i>. E.B. Magrab, S.K. Gupta, F. Patrick (2009), "Integrated Product and Process Development-The Product Realization Process", <i>CRC press</i>. 	
1. 2. Term v	 R. Rosenthal (2000), "Effective Product Design and Development", <i>Business Publication</i>. E.B. Magrab, S.K. Gupta, F. Patrick (2009), "Integrated Product and Process Development-The Product Realization Process", <i>CRC press.</i> work: 	
1. 2. Term v 1.	 R. Rosenthal (2000), "Effective Product Design and Development", Business Publication. E.B. Magrab, S.K. Gupta, F. Patrick (2009), "Integrated Product and Process Development-The Product Realization Process", CRC press. work: Assignments based on syllabus (Min. 5). 	
1. 2. Term v 1.	 R. Rosenthal (2000), "Effective Product Design and Development", Business Publication. E.B. Magrab, S.K. Gupta, F. Patrick (2009), "Integrated Product and Process Development-The Product Realization Process", CRC press. work: Assignments based on syllabus (Min. 5). Viva voce/Presentations/Quizzes 	

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Program:			s Engineerin	g) Semester : V	VIII
Course :	Project Pl		Code: BTMA08003		
		ig Scheme	Evaluation	n Scheme	
Lecture Hours per week	Practical Hours per week	Tutorial Hours per week	Credit	Internal Continuous Assessment (ICA) As per Institute Norms	5 Theory
0	8	0	4	Scaled to 100 Marks	
Pre-requi	s ite: Project F	hase I		I	I
	able to build	/simulate cir nd validate tl			
Outcomes			le rebuild.		
	 ementation of	the model.			
-		leshoot the r	nodel		
3. Sumr	narize the top	oic into a tech	nical report a	and demonstrate the mo	odel.
	to be done in		1		
		-	project will	involve development	implementation and
tes	ting of the pr	oject.		-	-
2. Stu	ident is requ	ired to subn	nit a 1-2 pag	es weekly report on tl	ne work done to the
me	entor. There v	vould continu	uous evaluati	on based on the weekly	report submitted.
3. Re	port primari	ily containin	g the entire	overview of the Pro	ject from Literature
Su	rvey, Feasibi	lity Study, I	Design, Anal	sis, Implementation,	and Testing is to be
su	omitted at the	e end of the S	emester. (Ha	rd Bound Report (Gold	en Embossing))
4. Pro	esentation (a	bout 30 mi	nutes) of th	e work done during	the semester to be
ev	aluated by In	ternal Exami	ner and Exter	nal Examiner.	

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Program	n: B. Tech. (Me	echatronics E	Engineerin	g)	Semester:	VIII
Course:	(Elective III) -	Project Mana	agement		Code: BT	MA08004
	Teaching	Scheme		Evalua	tion Schem	e
Lecture Hours per wee	Hours	Tutorial Hours per week	Credit	Internal Continuous Assessment (ICA) As per Institute Norms (Marks – 50)	As per Institute Norms (3 Hr	
3	0	2	4	Scaled to 30 marks	Scale	d to 70 marks
Prerequ	isite: Nil			1		
a - 7 - 7 tr - 7 - 1 - 1 - 1 - 4 - 4 - 4 - 4 - 4 - 4 - 4 - 4	nd control of provide with to provide with to impart know erminating a pr es: uccessful comple Understand the Understand the Create a work bit Apply cost estim dentify importa	roject. a high level o ledge associa oject. etion of this c process of Pro reakdown str nating and bu nt risks facin	overview o ted with p ourse, stud oject Mana ucture wit idgeting m g a new p	h specifications wethods to a project	heduling, c	
	l Syllabus					
Unit	Description					Duration (Hours)
1	Introduction to project management: Definition, Function, evolution of project management , classification of project management in different environments					
2	development	cycle: Scope	e, system	, methodologies and s approach, project b as development cycle.	2	04

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3 Project Planning : Planning fundamentals, project master plan, work	06
breakdown structure and other tools of project planning, work	
packages project organization structure and responsibilities,	
responsibility matrix.	
4 Project Scheduling : Use of Gantt charts and network diagrams,	04
activity of node diagrams, activity on arrow diagrams the critical	
path, time based networks.	
5 PERT, CPM, Resource Allocation Introduction to Tools and	05
techniques for scheduling development, crashing of networks, time-	
cost relationship, Resource leveling multiple project scheduling.	
6 Cost Estimating and Budgeting: Cost estimating process elements of	05
budgeting, Project cost accounting and management information	
systems, cost schedules and forecasts.	
7 Managing Risks in Projects: Risk concepts and identification, risk	04
assessment, risk priority, risk response planning, risk management	
methods.	
8 Project Control : Information monitoring, internal and external	05
project control, cost accounting systems for project control, control	
process, performance analysis, variance limits, and issues in project	
management software (MS Projects).	
9 Project Evaluation, Reporting and termination: Project reviews and	04
reporting, closing the contract.	
10 Project organization structure and integration :Requirement of	05
project organizations, different structure and integration in large	
scale projects, roles of project manager and project team	
Total	45 Hours
ext Books:	
1. John M. Nicholas (2001), "Project Management for Business and Technolo	9gy", 2 nd

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- **2.** Jack R Meredith, Samuel J Mantel (2000), "Project Management A Managerial Approach", 4th Edition, *JW and Sons*.
- 3. Choudhury (2006) "Project Management", Tata McGraw Hill.

References Books:

- 1. Dennis Lock, Gower (2003), "Project Management", 8th Edition.
- 2. Norman R Howes (2001), "Modern Project Management", Amacom.
- **3.** Prasanna Chandra (2004), "Projects: Planning, Analysis, Selection, Implementation and Review", 5th Edition, *Tata McGraw Hill*.
- 4. Gido and Clements (2003), "Successful Project Management", 2nd Edition, *Thomson*.

Term Work:

- **1.** Assignments based on the syllabus (Min 3).
- 2. Seminar or Presentation on topic based on syllabus.
- **3.** Viva Voce
- **4.** Two term test papers.



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e	rogram: B. Tech. (Mechatronics Engineering)					er: VIII	
Cours	se: (Elective II	I) - Additive	Manufact	uring	Code:	BTMA080	005
	Teaching Scheme			Evaluation Scheme			
Lectur Hours per week	Hours	Tutorials Hours per week	Credit	Assessment (ICA)As per Institute Norms (Marks -50) Theory		n End inations 'EE) (3 Hrs, 70 arks)	
3	2	0	4	Scaled to 30 n	narks	Scaled to	70 marks
Pre-req	uisite: Manufa	cturing Proce	esses (BTN	1A04005, CAD/C	AM/CIN	I (BTMA06	5006)
Objecti	ves:						
 To get acquainted with the operating principles of most prominent technologies in the field of Additive Manufacturing. Finding the common software issues associated with AM and addressing it using file repair algorithms. 							
Outcon			1.	111 11 /			
After co	ompletion of the	e course, stud	dents wou	ld be able to:			
		-		ve Manufacturing	and ider	ntifying va	rious
	industrial secto						
	Include AM as prototypes, the			oduct design cycle	e and to r	apidly dev	relop
	Understand an	•	0				
		*		the field of Addit	ive Manu	ıfacturing.	
Detaile	d Syllabus: (pe	er session pla	an)				
Unit	Description						Duration
1	History of AN between AN	Л, Why use t I, CNC & of AM, Cla	he term A other d assificatior	turing (AM): Intr dditive Manufact igital manufactu s of AM proce	uring, D tring teo	istinction chniques,	03

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2	Additive Manufacturing Process Chain: Basic eight steps in AM	07
	Process Chain, 3D Modelling, Data Conversion and Transmission,	
	Checking and Preparing, Building, Post processing, Application.	
3	Liquid-Based Processes: Introduction, Photo-polymerization-Basic	07
	overview, Stereolithography (SL) Process overview, Other liquid-based	
	processes: Solid Ground Curing (SGC), Solid Creation System (SCS),	
	Solid Object Ultraviolet-Laser Printer (SOUP), Rapid Freeze	
	Prototyping, Microfabrication.	
4	Powder Bed Fusion Process: SLS process overview, Powder fusion	08
	mechanism, Powder handling, Metal and Ceramic powder processing,	
	Other powder based processes- EOSINT Systems, Three-Dimensional	
	Printing (3DP), Laser Engineered Net Shaping (LENS), Direct Shell	
	Production Casting (DSPC), Multiphase Jet Solidification (MJS),	
	Electron Beam Melting (EBM).	
5	Extrusion-Based Processes: Fused deposition modelling, Basic	07
0	Extrusion Dused Trocesses. Tused deposition moderning, Duse	07
U	principle and process, FDM machines type, Materials used in FDM,	07
U	principle and process, FDM machines type, Materials used in FDM, Other extrusion based processes-Multi-Jet Modelling System (MJM),	07
0	principle and process, FDM machines type, Materials used in FDM,	07
6	principle and process, FDM machines type, Materials used in FDM, Other extrusion based processes-Multi-Jet Modelling System (MJM),	07
	principle and process, FDM machines type, Materials used in FDM, Other extrusion based processes-Multi-Jet Modelling System (MJM), Contour Crafting, Nonplanar System, FDM of Ceramics,	
	principle and process, FDM machines type, Materials used in FDM, Other extrusion based processes-Multi-Jet Modelling System (MJM), Contour Crafting, Nonplanar System, FDM of Ceramics,Software Issues for Additive Manufacturing: Conversion of CAD	
	 principle and process, FDM machines type, Materials used in FDM, Other extrusion based processes-Multi-Jet Modelling System (MJM), Contour Crafting, Nonplanar System, FDM of Ceramics, Software Issues for Additive Manufacturing: Conversion of CAD model into STL file, Issues with STL file, STL file manipulation, Other Translators, Newly Proposed Formats. Applications and Examples: Medical application, software for medical 	
6	 principle and process, FDM machines type, Materials used in FDM, Other extrusion based processes-Multi-Jet Modelling System (MJM), Contour Crafting, Nonplanar System, FDM of Ceramics, Software Issues for Additive Manufacturing: Conversion of CAD model into STL file, Issues with STL file, STL file manipulation, Other Translators, Newly Proposed Formats. 	07
6	 principle and process, FDM machines type, Materials used in FDM, Other extrusion based processes-Multi-Jet Modelling System (MJM), Contour Crafting, Nonplanar System, FDM of Ceramics, Software Issues for Additive Manufacturing: Conversion of CAD model into STL file, Issues with STL file, STL file manipulation, Other Translators, Newly Proposed Formats. Applications and Examples: Medical application, software for medical 	07
6	 principle and process, FDM machines type, Materials used in FDM, Other extrusion based processes-Multi-Jet Modelling System (MJM), Contour Crafting, Nonplanar System, FDM of Ceramics, Software Issues for Additive Manufacturing: Conversion of CAD model into STL file, Issues with STL file, STL file manipulation, Other Translators, Newly Proposed Formats. Applications and Examples: Medical application, software for medical application, Applications in Design, Aerospace Industry, Automotive 	07
6	 principle and process, FDM machines type, Materials used in FDM, Other extrusion based processes-Multi-Jet Modelling System (MJM), Contour Crafting, Nonplanar System, FDM of Ceramics, Software Issues for Additive Manufacturing: Conversion of CAD model into STL file, Issues with STL file, STL file manipulation, Other Translators, Newly Proposed Formats. Applications and Examples: Medical application, software for medical application, Applications in Design, Aerospace Industry, Automotive Industry, Biomedical Industry, Jewelry Industry. 	07
6	 principle and process, FDM machines type, Materials used in FDM, Other extrusion based processes-Multi-Jet Modelling System (MJM), Contour Crafting, Nonplanar System, FDM of Ceramics, Software Issues for Additive Manufacturing: Conversion of CAD model into STL file, Issues with STL file, STL file manipulation, Other Translators, Newly Proposed Formats. Applications and Examples: Medical application, software for medical application, Applications in Design, Aerospace Industry, Automotive Industry, Biomedical Industry, Jewelry Industry. Business Opportunities in Additive Manufacturing: Product 	07

- 1. Gibson I, Rosen D W, Stucker B (2010), "Additive Manufacturing Technologies: Rapid Prototyping to Direct Digital Manufacturing", *Springer*.
- 2. Chua, C. L., Lim, K., (2003), "Rapid Prototyping: Principles and Applications", World Scientific Publishing Co. Pte. Ltd.

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- 3. Noorani, R. (2006), "Rapid prototyping: Principles and Applications", John Wiley & Sons Incorporated.
- 4. Kamrani, A. K., & Nasr, E. A. (2006), "Rapid prototyping: theory and practice", (Vol. 6), Springer Science & Business Media.

Reference Books:

- **1.** Pham, D., & Dimov, S. S. (2012), "Rapid manufacturing: the technologies and applications of rapid prototyping and rapid tooling", *Springer Science & Business Media*.
- **2.** Gebhardt, A., & Gebhardt, A. (2012), "Understanding Additive Manufacturing", *Hanser Publications*

Term Work:

- 1. Mini Project and/or Case Studies
- 2. Experiments as per the list provided (min 8)
- 3. Industrial Visit and report

List of Experiments:

- 1. Review of CAD Modelling Software packages (AutoCAD, CATIA, SOLIDWORKS, CREO or any other suitable package) and modelling of 3D model using any one software.
- 2. Understanding the working of Leapfrog Creator FDM 3D printer and its software interface.
- 3. Processing the CAD data in Repeater software or Slicer (Selection of Orientation, Supports generation, Slicing, Tool path generation).
- 4. Understanding the properties of various plastic filament used in FDM printers
- 5. Fabricating the 3D models on FDM RP machine
- 6. Fabricating the 3D models with and without supports
- 7. Working with CAD Data Exchange formats: IGES, ACIS, DXF and STL
- 8. Identification of STL file problems using MAGICS software repairing the models
- 9. Converting CT/MRI scan data into STL file using MIMICS software (Demo)
- 10. Studying the machinability properties of 3D printed parts.

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Progra			0	0.	Semester:		
Course	· /	5	igineering		Code: BT		
	Teaching Sc			Evaluation Scheme			
Lect Hou pe we	urs Hours er per	Tutorial Hours per week	Credit	Assessme As per Ir Nor	Assessment (ICA) As per Institute Norms (Marks - 50)		-
3	0	2	4	Scaled to 3	30 marks	Scaled to	70 marks
Prereq	uisite: Engineering	Mathemati	cs - I & II	(BTAB01001 o	& BTAB020	01)	
• Outcoi	components / asse To familiarize with testing and predict mes :	failure ana		niques of relia	ability impr	ovement, relia	ability
• •	uccessful completio Understand the Re evaluation of safety Understand and w distributions. Conduct Product R CI, Hypothesis Tes Test.	liability terr y standard. rite the derr Reliability A	minology ivations o .cceptance	and its interr n mean life, n e tests, Stress s	elationship nedian life a screening, I	and model life Degradation To	of differer ests, MTBF
Detail	ed syllabus						
Units	Description						Duratior (Hours)
1	Reliability progr Interrelationship of management, In System Safety and Reliability Termin	of quality and tegrated real real and the re	nd reliabil eliability	ity, Failure co program, c	onsequence oncurrent	and liability engineering	05
2	Mathematical def cumulative hazar modal life	inition of					04
3	Typical Life-time	distributio	na (Doig	г		ill Commo	04

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	(PM) analysis. Total	45 Hours
	Maintenance time distributions, Preventive and Corrective maintenance	
10	Maintainability and availability, Maintainability and availability planning, Maintainability apportionment/allocation, Availability tradeoffs,	05
10	Kolmogorov-Smirnov test, Anderson Darling Test	
	Degradation Tests, MTBF, CI, Hypothesis Testing, Goodness of Fit,	
9	Product testing, Qualification/Demonstration testing (Sequential tests, Fixed length tests), Product Reliability Acceptance tests, Stress screening,	05
0	testing	05
	tests (e.g., single-stress, multiple-stress, sequential stress), Step-stress	
8	Development testing, elements of a reliability test plan, Accelerated life	04
	prediction methods for repairable and non-repairable devices, Reliability apportionment, reliability allocation	
	models, part count predictions and part stress analysis, reliability	
7	Reliability modeling and prediction, Reliability block diagrams and	05
	Temperature	
U	Miner's rule, Effects of Creep, Wear, Corrosion, Vibration and shock,	01
6	Reliability of Mechanical components and systems, Fatigue, S-N Diagram,	04
	analysis (FTA) in design, Monte Carlo simulation	
5	Reliability design techniques, Use factors, Stress-strength analysis Introduction to FMEA and FMECA from reliability perspective, Fault tree	05
	and repairable systems, bath-tub curve for repairable system	
4	Ranking of life data, probability plotting, Poisson process, non-repairable and repairable systems, bath-tub curve for repairable system	04

Text Books:

- 1. P. D. T. O. Connor (2012), "Practical Reliability Engineering", John Wiley.
- 2. "NY's RAC sheets on Reliability Engineering", (1998), System Reliability Center, Rome.

Reference Books:

- 1. R. A. Johnson (2007), "Probability and Statistics for Engineers", PHI Publications.
- 2. Juran (2010), "Quality Hand Book", Tata McGraw Hill."

Term Work:

- 1. Assignments based on the topics of the syllabus (Min. 3).
- 2. Seminar or presentation on topic based on syllabus.
- **3.** Viva voce.
- 4. Two term test papers.

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Program	m: B. Tech.	(Mechatronio	cs Enginee	ering)	Semester: VI	II	
Course	: (Elective I	V) - Virtual I	nstrument	ation	Code: BTMA)8007	
	Teaching	Scheme			Evaluation	n Scheme	
Lectur Hours per week	6 Hours per	Tutorial Hours per week	Credit	Assess As pe	nternal Continuous Assessment (ICA) T As per Institute		heory , 70 Marks)
3	2	0	4	Scaled	to 30 marks	Scaled	to 70 marks
Objecti 1. 1 2. 1 3. 1 4. 1 5. 7 Outcor After th 1. 2.	ives: Fo review backg Fo study the bas Fo study the var Fo study the var instrumentation Fo study a few a	nics (BTAB02 ground inform ic building b ious techniqu ious graphica n applications i mpletion of th virtual instru ogram in vir	2003) nation requilocks of virules of inter al program n virtual in his course umentation tual instru	uired for s rtual instr cfacing of nming env nstrument the studer the studer n. mentatior	studying virtual umentation. external instrum rironment in vir ration.	instruments of Pottual	ntation.
	ed Syllabus:						
Unit	Description						Duration (Hours)
	Review of Digi Representation quantization in theorem, ADC	of analog sig amplitude ar	nals in the	0			06
	Fundamentals Concept of virte Typical on boar Multiplexing of Different strate Concept of univ	ual instrumer d DAQ card analog inpu gies for samp	ntation – P – Resoluti ts – Single ling of mu	C based d on and sau -ended an ilti-channe	ata acquisition mpling frequen d differential in el analog inputs	cy - iputs –	10

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	outputs on the universal DAQ card.	
3	Cluster of Instruments in VI SYSTEM	
	Interfacing of external instruments to a PC - RS232, RS 422, RS 485 and	10
	USB standards - IEEE 488 standard - ISO-OSI model for serial bus -	
	Introduction to bus protocols of MOD bus and CAN bus.	
4	Graphical Programming environment in VI	
	Concepts of graphical programming - Lab-view software - Concept of	
	VIs and sub VI - Display types - Digital - Analog - Chart - Oscilloscopic	10
	types - Loops - Case and sequence structures - Types of data - Arrays -	
	Formulae nodes -Local and global variables - String and file I/O.	
5	Analysis Tools and Simple Applications in VI	
	Fourier transform - Power spectrum - Correlation – Windowing and	
	filtering tools – Simple temperature indicator – ON/OFF controller – P-	09
	I-D controller - CRO emulation - Simulation of a simple second order	
	system – Generation of HTML page.	
	Total	45 Hours
Text I	Books:	
1.	Jerome Jovitha, Virtual Instrumentation Using Labview, Paperback, 2010	
2.	S. Gupta and J.P Gupta, 'PC Interfacing for Data Acquisition and Process C	ontrol',
2.	S. Gupta and J.P Gupta, 'PC Interfacing for Data Acquisition and Process C Instrument society of America, 1994.	ontrol',
		ontrol',
Refer	Instrument society of America, 1994.	
Refer	Instrument society of America, 1994. ence Books:	
Refer 1.	Instrument society of America, 1994. ence Books: 1. Kevin James, 'PC Interfacing and Data Acquisition: Techniques for Meas Instrumentation and Control', Newness, 2000.	surement,
Refer 1.	Instrument society of America, 1994. ence Books: 1. Kevin James, 'PC Interfacing and Data Acquisition: Techniques for Meas	surement,
Refer 1. 2.	Instrument society of America, 1994. ence Books: 1. Kevin James, 'PC Interfacing and Data Acquisition: Techniques for Meas Instrumentation and Control', Newness, 2000. Gary W. Johnson, Richard Jennings, 'Lab-view Graphical Programming', N	surement,
Refer 1. 2. Term	Instrument society of America, 1994. ence Books: 1. Kevin James, 'PC Interfacing and Data Acquisition: Techniques for Meas Instrumentation and Control', Newness, 2000. Gary W. Johnson, Richard Jennings, 'Lab-view Graphical Programming', N Professional Publishing, 2001.	surement,
Refer 1. 2. Term 1.	Instrument society of America, 1994. ence Books: 1. Kevin James, 'PC Interfacing and Data Acquisition: Techniques for Meas Instrumentation and Control', Newness, 2000. Gary W. Johnson, Richard Jennings, 'Lab-view Graphical Programming', N Professional Publishing, 2001. Work:	surement, AcGraw Hil

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Program:	B. Tech.	(Mechatronio	s Enginee	ering)	Semester: V	/III	
Course :		IV) - Automo			Code: BTM	A08008	
	Teaching	Scheme			Evalu	ation Scheme	
Lecture	Practical	Tutorial		Internal (Continuous		
Hours	Hours	Hours		Assessm	nent (ICA) The Institute (2 Har 7		ry
			Credit	As per			Marke)
per week	per week	per week		No	orms	(3 Hrs., 70	lviai KSj
week	WEEK	week		(Marks – 50)			
3	2	0	4	Scaled to	30 marks	Scaled to 7	0 marks
Pre-requi	site: Autom	obile Engine	ering (BT	MA07006),	Digital Ele	ectronics (BTMA	03004), Basic
_	Contro	l Systems (B1	MA05006) and Instru	imentation (E	3TMA05004)	
Objective	es:	-					
1. To	o understand	electrical con	nponents ı	used in a ve	hicle		
2. To	study the ap	plication of l	Embedded	system in	automotive		
	o understand	-		-		required for	
	e Automotive			51	5	*	
Outcome				unit of p circs			
	successful con	mpletion of tl	nis course	the student	will be able	to	
		-				onic Systems lik	e
	2					Lighting System	
		•••			•	nd the role of ECU	
			• •			e for improveme	
	performance of					Ĩ	
3. Ap	oly embedde	ed system co	oncepts ar	nd how it i	s being usec	l in automotive	
	icles.	5	1		0		
Detailed	Syllabus:						
Unit D	Description						Duration (Hours)
1. St	orage Battery	/:					
	-		-			containers and	
	parators, ele		-	*		temperature on	08
						ods of charging	
						f idle and new	
	tteries. Recyc	0		evelopment	t in batteries		
	narging and l	0 0 2		the size of the		Combral sector t	
						Control cutout,	00
					0	Regulations for	08
	0 0	•				ystem, details of t dazzling and	
ne	au light all	i side light,	LED IIgi	ung syster	II, Heau IIgi	ii uazziiiig allu	

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	preventive methods. Static and Dynamic Bending lights.	
	Starter Motor & Drives: Battery motor starting system, condition at starting,	
	behavior of starter during starting series motor and its characteristics,	
	consideration affecting size of motor, types of drives, starting circuit.	
3.		
3.	Ignition systems and Engine Management Systems: Ignition fundamentals, Types of solid state ignition systems, components, construction And operating parameters, high energy ignition distributors, Electronic spark timing, Ignition Advance, Types DIS, MBT and control. Combined ignition and fuel management systems. Exhaust emission control, Digital control techniques – Dwell angle calculation, Ignition timing calculation and Injection duration calculation. Complete vehicle control systems, Artificial intelligence and engine management	08
4.	Chassis Electrical systems: Antilock brakes (ABS), Types, Active suspension, Traction control, Electronic control of automatic transmission, other chassis electrical systems, Central locking, Air bags and seat belt tensioners. Microprocessor And Microcomputer controlled devices in automobiles such as instrument cluster, Voice warning system, Travel information system, GPS, AUTOCOP, Keyless entry system	08
5.	Electronic Accessories: Warning and alarm instruments: Brake actuation warning system, trafficators, flash system, oil pressure warning system, and engine over heat warning system, air pressure warning system, speed warning system, door lock indicators, neutral gear indicator, horn design, permanent magnet horn, air & music horns. Wind shield wiper. Window washer, instrument wiring system and electromagnetic interference suppression, wiring circuits for instruments, electronic instruments, dash board illumination and MIL.	08
6.	Integration of Software and Hardware: Downloading the Software from Host Machine to Target Machine. Implementing application prototype: Power Window and Automotive Lighting System	05
	Total	45 Hours
Text B		10 110015
1. 2. 3.	Hillier, "Fundamentals of Automotive Electronics", Sixth edition, Oxford, 2010 Kohli P L., "Automotive Electrical Equipment", Tata McGraw Hill Publishing Co William B. Ribbens -Understanding Automotive Electronics, 5th edition- Butter w Heinemann, 1998	

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Reference Books:

- 1. Tom Denton "Automotive Electrical and Electronics"-SAE, 2000 2. Judge AW
- 2. Bosch, "Automotive Hand Book", 8th edition, SAE, 2007
- 3. U. Kiencke, and L. Nielsen," Automotive Control Systems", SAE and Springer-Verlag, 2000
- 4. Ljubo Vlacic, Michel Parent & Furnio Harshima, "Intelligent Vehicle Technologies: Theory and Applications", Butterworth-Heinemann publications, 2001.

Term Work:

- 1. Minimum two assignments.
- 2. Minimum ten tutorials based on the whole syllabus duly recorded and graded.
- 3. Two term test papers.



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Program	m: B. Tech.	(Mechatronio	s Enginee	ering)	Semester: VIII		
Course	: (Elective I	V) - Artificial	Intelligen	ce	Code: BTMA0	8009	
	Teaching	Scheme			Evaluatio	on Scheme	
Lectur	e Practical	Tutorial		Inter	nal Continuous		
Hours per week	per	Hours per week	Credit	As	essment (ICA) per Institute Norms Marks – 50)		eory 70 Marks)
3	2	0	4		ed to 30 marks	Scaled to	o 70 marks
Pre-req	•	Control Sys 01006), (BTAI	•	MA05(006), Computer	Programmi	ing I & II
2. 3. Outcor After th 1.	To understand To study the in To design and i nes:	nplementatio implement fu mpletion of tl gent system u	n principle uzzy logic a his course sing AI teo	es of in and ne the stu chniqu			ns
	Analyse ANN a	and Fuzzy sy	stem imple	ementa	ition.		
Detaile Unit	ed Syllabus: Description						Duration (Hours)
1.	0	ificance and			iew of application AI. Typical AI Prol		08
2.	AI Component Definition and Knowledge Bas Manipulation a	Importance c sed System, K ind Acquisition presentation	of Knowled Cnowledge on. Strateg Languages	lge, Co repres ies for 5, Issue	omponents of Kno sentation, Organiz Knowledge Acqu s in Knowledge anguage.	zation,	08
3.	Automated Rea The General Pr	asoning: oblem Solver ine Learning	and Diffe Perceptro	rence]	Tables. Resolution ning, Back Propa		05
4.	Knowledge Ba	sed Design A	Aids:	, Forw	ard Chaining, Hy	brid	05

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	Chaining Frather Bread Madelling Frates Bread it Desired	
	Chaining. Feature Based Modelling, Feature Recognition, Design by	
_	Features. Application of Feature Based Models.	
5.	Introduction to Neural Network	
	Fundamental Concepts and Models, Learning Process, Learning Rules,	00
	Single Layer Perceptron Classifier, Multilayer Feedforward Network,	08
	Single-Layer Feedback Networks. Hamming Net and MAXNET,	
	Unsupervised Learning of Clusters, Counter propagation Network,	
	Feature Mapping, Self-Organizing Feature Maps. Cluster Discovery Network.	
6.		
0.	Introduction to Fuzzy logic	
	Introduction, Fuzzy Sets, Fuzzy relations, Operations on Fuzzy Relations, Membership Functions, Fuzzification and Defuzzification,	08
	Logic and Fuzzy System, Fuzzy Arithmetic, The Extension Principle,	00
	Fuzzy Associative Memories.	
7.	Fuzzy System and Applications Decision making with Fuzzy	03
7.	Information, Fuzzy Classification and Pattern Recognition, Fuzzy	0.5
	Control System, Fuzzy Optimization. Fuzzy-neural applications	
	examples.	
	*	45 11
	Total	45 Hours
	Books:	
	imothy Ross, Fuzzy Logic with Engineering Application, Wiley, 3rd edition,	,
	011.	
	ntroduction to Artificial Intelligence and Expert System. DAN. W. Patterson, 002, PHI/Pearson.	
	Artificial Intelligence, Fifth Edition -George.F.Luger 2008. Pearson Education,	
	Asia.	
	ntroduction to Artificial Neural networks by Jacek M. Zurada 1992.	
	ence Books:	
	ntroduction to Artificial Neural networks by Simon Haykin, Neural Networ	ks. PHL
	Brd edition, 2010.	,
	D. Driankov, H. Helendoorn, M. Reinfrank, An Introduction to Fuzzy Contro	ol,
	Narosa, 1st edition, 2001.	
	5. Rajasekaran, G. A. Vijaylakshmi Pai, Neural Network, Fuzzy Logic & Gen	etic
	Algorithms Synthesis & Application, PHI, 1st edition, 2009.	
	Work:	
1.	Minimum two assignments.	
2.	Minimum ten tutorials based on the whole syllabus duly recorded and gra	ded.
3.	Two term test papers.	

Signature (Prepared by Concerned Faculty/HOD)